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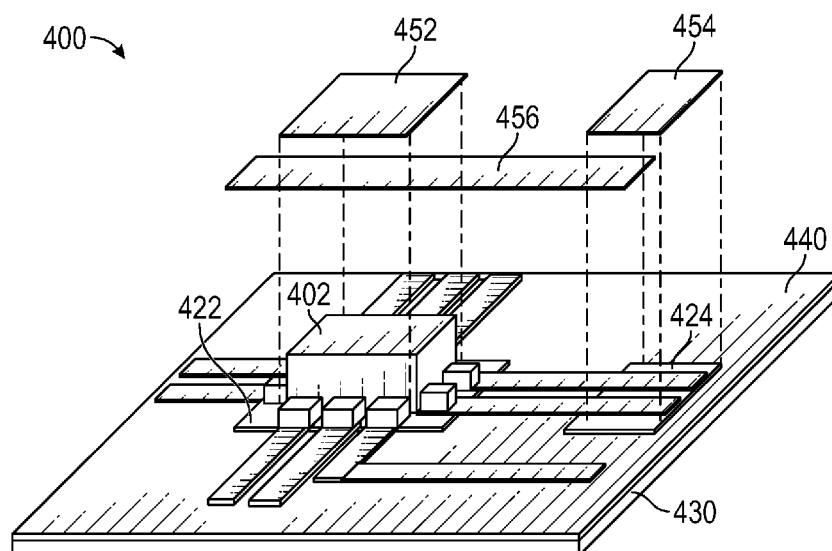


FIG. 4C

(57) Abstract: Systems and methods for component stress relief are disclosed. In some embodiments, a wound dressing includes a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side. The wound facing side or the non-wound facing side of the wound contact layer can support a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components. The wound facing side or the non-wound facing side of the wound contact layer can include a region of substantially non-stretchable material that supports at least one electronic component from the plurality of electronic components. The at least one electronic component can be attached to the wound contact layer with adhesive material. Such arrangement can securely position the at least one electronic component and limit the mechanical strain on the at least one electronic component supported by the region.

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## COMPONENT POSITIONING AND STRESS RELIEF FOR SENSOR ENABLED WOUND DRESSINGS

### CROSS-REFERENCE TO RELATED APPLICATIONS

**[0001]** This application claims priority to U.S. Patent Application Nos. 62/484316, filed on April 11, 2017, 62/484321, filed on April 11, 2017, and 62/524564, filed on June 25, 2017 and UK Patent Application No. 1800057.0, filed on January 3, 2018, the entire disclosure of each of which is incorporated herein.

### BACKGROUND

#### Field

**[0002]** Embodiments of the present disclosure relate to apparatuses, systems, and methods for the treatment of wounds, for example using dressings in combination with negative pressure wound therapy, or non-negative pressure wound therapy.

#### Description of the Related Art

**[0003]** Many different types of wound dressings are known for aiding in the healing process of a human or animal. These different types of wound dressings include many different types of materials and layers, for example, gauze, pads, foam pads or multi-layer wound dressings. Topical negative pressure (TNP) therapy, sometimes referred to as vacuum assisted closure, negative pressure wound therapy (NPWT), or reduced pressure wound therapy, is widely recognized as a beneficial mechanism for improving the healing rate of a wound. Such therapy is applicable to a broad range of wounds such as incisional wounds, open wounds and abdominal wounds or the like.

**[0004]** However, prior art dressings for use in negative pressure wound therapy or other wound therapy provide little visualization or information of the condition of the wound site beneath the dressing. This can require the dressing to be changed prematurely before the desired level of wound healing has occurred or, for absorbent dressings, prior to the full absorbent capacity of the

dressings being reached to allow the clinician to inspect the healing and status of the wound. Some current dressings have limited or unsatisfactory methods or features of providing information of conditions of the wound.

#### BRIEF DESCRIPTION OF THE DRAWINGS

**[0005]** Embodiments of the present disclosure will now be described hereinafter, by way of example only, with reference to the accompanying drawings in which:

**[0006]** FIG. 1A illustrates a negative pressure wound treatment system according to some embodiments;

**[0007]** FIG. 1B illustrates a wound dressing according to some embodiments;

**[0008]** FIG. 2 illustrates a sensor array illustrating the sensor placement incorporated into a wound dressing according to some embodiments;

**[0009]** FIG. 3A illustrates a flexible sensor array including a sensor array portion, a tail portion and a connector pad end portion according to some embodiments;

**[0010]** FIG. 3B illustrates flexible circuit boards with different sensor array geometries according to some embodiments;

**[0011]** FIG. 3C illustrates the sensor array portion 301B of a sensor array shown in FIG. 3B;

**[0012]** FIG. 3D illustrates a flexible sensor array incorporated into a perforated wound contact layer according to some embodiments;

**[0013]** FIG. 3E illustrates a control module according to some embodiments;

**[0014]** FIGS. 4A-4F illustrate a wound dressing with a plurality of electronic components according to some embodiments;

**[0015]** FIGS. 5A-5D illustrate a wound dressing with a plurality of electronic components according to some embodiments;

**[0016]** FIGS. 6A-6B and 7A-7B illustrate processes for making wound dressings with a plurality of electronic components according to some embodiments; and

**[0017]** FIG. 8 illustrates indexing according to some embodiments.

#### SUMMARY

**[0018]** According to one aspect, a wound monitoring and/or therapy apparatus includes a wound dressing having a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, the wound facing side or the non-wound facing side of the wound contact layer supporting a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components, and the wound facing side or the non-wound facing side of the wound contact layer supporting the plurality of electronic components and the plurality of electronic connections including a first region of substantially non-stretchable material that supports at least one electronic component from the plurality of electronic components. The at least one electronic component can be attached to the first region of substantially non-stretchable material with adhesive material.

**[0019]** The apparatus of the preceding paragraph can include one or more of the following features. The wound facing side or the non-wound facing side of the wound contact layer supporting the plurality of electronic components and the plurality of electronic connections can include a second region of substantially non-stretchable material that supports at least one electronic connection from the plurality of electronic connections. The wound contact layer can include a substrate supporting the plurality of electronic components and the plurality of electronic connections and a conformal coating covering at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The substrate can be formed from thermoplastic polyurethane and the conformal coating can be formed from urethane. The wound contact layer can include a plurality of perforations configured to allow fluid to pass through the wound contact layer when negative pressure is applied to the wound. The plurality of

perforations can be further configured to allow substantially unidirectional flow of fluid through the wound contact layer to prevent fluid removed from the wound from flowing back toward the wound.

**[0020]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The wound facing side of the wound contact layer can include a region of additional adhesive material configured to position the at least one electronic component in the wound. The wound facing side or the non-wound facing side of the wound contact layer supporting the plurality of electronic components and the plurality of electronic connections can include a third region of substantially non-stretchable material that encloses the at least one electronic component. The at least one electronic component can be one or more of a sensor, a light emitter, a processor, or a communications controller. Plurality of electronic connections can include a plurality of electrical traces. The apparatus can include a negative pressure source configured to be fluidically connected to the wound dressing. The wound dressing can further include an absorbent layer positioned over the non-wound facing side of the wound contact layer and a backing layer positioned over the absorbent layer. The wound contact layer can be sealed to the backing layer. The backing layer can include a port configured to fluidically connect the wound dressing to a negative pressure source. At least one of the adhesive material or the additional adhesive material can be thermally curable. At least the wound facing side of the wound contact layer can support the plurality of electronic components and the plurality of electronic connections. At least the non-wound facing side of the wound contact layer can support the plurality of electronic components and the plurality of electronic connections.

**[0021]** According to another aspect, a method of manufacturing a wound dressing includes providing a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, positioning a first region of substantially non-stretchable material on the wound facing side or the non-wound facing side of the wound contact layer, positioning adhesive material in at least a portion of

the first region; and positioning a plurality of electronic components and a plurality of electronic connections on the wound facing side or the non-wound facing side of the wound contact layer. The at least one electronic component from the plurality of electronic components can be supported by the first region of substantially non-stretchable material, and the at least one electronic component can be attached to the first region of substantially non-stretchable material with the adhesive material.

**[0022]** The method of the preceding paragraph can include one or more of the following features. The wound contact layer can include a substrate, and the method can further include perforating the substrate around the plurality of electronic components and the plurality of electronic connections and applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate. The method can further include applying a region of additional adhesive material to the wound facing side of the wound contact layer, the additional adhesive material configured to position the at least one electronic component in the wound.

**[0023]** The method of any of the preceding paragraphs can include one or more of the following features. The method can include further identifying a location of the at least one electronic component prior to applying the region of additional adhesive material. The wound contact layer can include a substrate, and the method can further include applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the



plurality of electronic components and the plurality of electronic connections. The method can further include applying a region of adhesive material to the wound facing side of the wound contact layer, the adhesive material configured to position the at least one electronic component in the wound, and perforating the substrate around the plurality of electronic components and the plurality of electronic connections.

**[0024]** The method of any of the preceding paragraphs can include one or more of the following features. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. The method can further include identifying a location of the at least one electronic component prior to applying the region of adhesive material. Identifying the plurality of locations can include identifying one or more of a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate. The method can further include positioning a second region of substantially non-stretchable material on the wound facing side or the non-wound facing side of the wound contact layer and supporting at least one electronic connection from the plurality of electronic connections on the second region.

**[0025]** The method of any of the preceding paragraphs can include one or more of the following features. The method can further include enclosing the at least one electronic component by a third region of substantially non-stretchable material positioned on the wound facing side or the non-wound facing side of the wound contact layer supporting the plurality of electronic components and the plurality of electronic connections. The method can further include cutting the wound contact layer along at least one cutting line to separate a region of the wound contact layer including the plurality of electronic components and the plurality of electronic connections and attaching the region of the wound contact layer to one or more of an absorbent layer or a backing layer to form a wound dressing. The substrate can be formed from thermoplastic polyurethane and the conformal coating can be formed from urethane. The method can further

include curing at least one of the adhesive material or the additional adhesive material. The method can further include thermally curing the adhesive material during soldering of the at least one electronic component to at least one electronic connection of the one or more electronic connections. The plurality of electronic components and the plurality of electronic connections can be positioned at least on the wound facing side of the wound contact layer. The plurality of electronic components and the plurality of electronic connections can be positioned at least on the non-wound facing side of the wound contact layer.

**[0025a]** In a first aspect, the invention provides a wound monitoring and/or therapy apparatus comprising:

a wound dressing comprising a substantially stretchable substrate including a wound facing side and a non-wound facing side opposite the wound facing side,

the wound facing side of the substrate supporting a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components,

a conformal coating covering at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections, and

a portion of the wound facing side of the substrate comprising a layer of material forming a first region that is substantially non-stretchable material and that encloses an entire perimeter of at least one electronic component from the plurality of electronic components, wherein the first region is protected from strain applied to the substrate.

**[0025b]** In a second aspect, the invention provides a method of manufacturing a wound dressing, the method comprising:

providing a substantially stretchable substrate including a wound facing side and a non-wound facing side opposite the wound facing side;

positioning a plurality of electronic components and a plurality of electronic connections on the wound facing side or the non-wound facing side of the substrate;

covering at least the plurality of electronic components and the plurality of electronic connections with a conformal coating, to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections; and

enclosing an entire perimeter of at least one electronic component from the plurality of electronic components by a first region that is substantially non-stretchable material positioned on a portion of the wound facing side of the substrate supporting the plurality of electronic components and the plurality of electronic connections, wherein the first region is protected from strain applied to the substrate.

**[0026]** In some implementations, a wound therapy apparatus includes a wound dressing including a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, the non-wound facing side of the wound contact layer supporting a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components, the non-wound facing side of the wound contact layer including a first region of substantially non-stretchable material that supports at least one electronic component from the plurality of electronic components.

**[0027]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The non-wound facing side of the wound contact layer can include a second region of substantially non-stretchable material that supports at least one electronic connection from the plurality of electronic connections. The wound contact layer can include a substrate supporting the plurality of electronic components and the plurality of electronic connections and a conformal coating covering at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic

components and the plurality of electronic connections. The substrate can be formed from thermoplastic polyurethane and the conformal coating can be formed from urethane. The wound contact layer can include a plurality of perforations configured to allow fluid to pass through the wound contact layer when negative pressure is applied to the wound. The plurality of perforations can be further configured to allow substantially unidirectional flow of fluid through the wound contact layer to prevent fluid removed from the wound from flowing back toward the wound. The wound facing side of the wound contact layer can include a region of adhesive material configured to position the at least one electronic component in the wound. The non-wound facing side of the wound contact layer can include a third region of substantially non-stretchable material that encloses the at least one electronic component.

**[0028]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The at least one electronic component can include one or more of a sensor, a light emitter, a processor, or a communications controller. The plurality of electronic connections can include a plurality of electrical traces. The apparatus can include a negative pressure source configured to be fluidically connected to the wound dressing. The wound dressing can further include an absorbent layer positioned over the non-wound facing side of the wound contact layer and a backing layer positioned over the absorbent layer. The wound contact layer can be sealed to the backing layer. The apparatus can further include a port on the backing layer, the port configured to fluidically connect the wound dressing to a negative pressure source.

**[0029]** In some embodiments, a method of manufacturing a wound dressing includes providing a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, positioning a first region of substantially non-stretchable material on the non-wound facing side of the wound contact layer, and positioning a plurality of electronic components and a plurality of electronic connections on the non-wound facing side of the wound contact layer, wherein at

least one electronic component from the plurality of electronic components is supported by the first region of substantially non-stretchable material.

**[0030]** The method of any of the preceding paragraphs can include one or more of the following features. The wound contact layer can include a substrate, and the method can further include perforating the substrate around the plurality of electronic components and the plurality of electronic connections and applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate. The method can further include applying a region of adhesive material to the wound facing side of the wound contact layer, the adhesive material configured to position the at least one electronic component in the wound. The method can further include identifying a location of the at least one electronic component prior to applying the region of adhesive material.

**[0031]** The method of any of the preceding paragraphs can include one or more of the following features. The wound contact layer can include a substrate, and wherein the method can further include applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can further include applying a region of adhesive material to the wound facing side of the wound contact layer, the adhesive material configured to position the at least one electronic component in the wound and perforating the substrate around the plurality of electronic

components and the plurality of electronic connections. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. The method can further include identifying a location of the at least one electronic component prior to applying the region of adhesive material.

**[0032]** The method of any of the preceding paragraphs can include one or more of the following features. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate. The method can further include positioning a second region of substantially non-stretchable material on the non-wound facing side of the wound contact layer and supporting at least one electronic connection from the plurality of electronic connections on the second region. The method can further include enclosing the at least one electronic component by a third region of substantially non-stretchable material positioned on the non-wound facing side of the wound contact layer. The method can further include cutting the wound contact layer along at least one cutting line to separate a region of the wound contact layer including the plurality of electronic components and the plurality of electronic connections and attaching the region of the wound contact layer to one or more of an absorbent layer or a backing layer to form a wound dressing. The substrate can be formed thermoplastic polyurethane and the conformal coating can be formed from urethane.

**[0033]** In some implementations, a wound therapy apparatus includes a wound dressing including a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, the wound facing side of the wound contact layer supporting a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components, and the wound facing side of the wound contact layer including a

first region of substantially non-stretchable material that supports at least one electronic component from the plurality of electronic components.

**[0034]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The wound facing side of the wound contact layer can include a second region of substantially non-stretchable material that supports at least one electronic connection from the plurality of electronic connections. The wound contact layer can include a substrate supporting the plurality of electronic components and the plurality of electronic connections and a conformal coating covering at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The substrate can be formed from thermoplastic polyurethane and the conformal coating can be formed from urethane. The wound contact layer can include a plurality of perforations configured to allow fluid to pass through the wound contact layer when negative pressure is applied to the wound. The plurality of perforations can be further configured to allow substantially unidirectional flow of fluid through the wound contact layer to prevent fluid removed from the wound from flowing back toward the wound.

**[0035]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The wound facing side of the wound contact layer can include a region of adhesive material configured to position the at least one electronic component in the wound. The wound facing side of the wound contact layer can include a third region of substantially non-stretchable material that encloses the at least one electronic component. The at least one electronic component can include one or more of a sensor, a light emitter, a processor, or a communications controller. Plurality of electronic connections can include a plurality of electrical traces. The apparatus can further include a negative pressure source configured to be fluidically connected to the wound dressing. The wound dressing can include an absorbent layer positioned over the non-wound facing side of the wound contact layer and a backing layer positioned over the absorbent layer. The wound contact layer can be sealed to

the backing layer. The apparatus can further include a port on the backing layer, the port configured to fluidically connect the wound dressing to a negative pressure source.

**[0036]** In some embodiments, a method of manufacturing a wound dressing includes providing a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, positioning a first region of substantially non-stretchable material on the wound facing side of the wound contact layer, and positioning a plurality of electronic components and a plurality of electronic connections on the wound facing side of the wound contact layer, wherein at least one electronic component from the plurality of electronic components is supported by the first region of substantially non-stretchable material.

**[0037]** The method of any of the preceding paragraphs can include one or more of the following features. The wound contact layer can include a substrate, and the method can further include perforating the substrate around the plurality of electronic components and the plurality of electronic connections and applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate. The method can include applying a region of adhesive material to the wound facing side of the wound contact layer, the adhesive material configured to position the at least one electronic component in the wound. The method can include identifying a location



of the at least one electronic component prior to applying the region of adhesive material.

**[0038]** The method of any of the preceding paragraphs can include one or more of the following features. The wound contact layer can include a substrate, and the method can further include applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can include applying a region of adhesive material to the wound facing side of the wound contact layer, the adhesive material configured to position the at least one electronic component in the wound, and perforating the substrate around the plurality of electronic components and the plurality of electronic connections. The method can include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. The method can include identifying a location of the at least one electronic component prior to applying the region of adhesive material. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate

**[0039]** The method of any of the preceding paragraphs can include one or more of the following features. The method can include positioning a second region of substantially non-stretchable material on the wound facing side of the wound contact layer and supporting at least one electronic connection from the plurality of electronic connections on the second region. The method can include enclosing the at least one electronic component by a third region of substantially non-stretchable material positioned on the wound facing side of the wound contact layer. The method can include cutting the wound contact layer along at least one cutting line to separate a region of the wound contact layer including the plurality of electronic components and the plurality of electronic connections and attaching the region of the wound contact layer to one or more of an

absorbent layer or a backing layer to form a wound dressing. The substrate can be formed thermoplastic polyurethane and the conformal coating can be formed from urethane.

**[0040]** In some implementations, a wound therapy apparatus includes a wound dressing including a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, the wound facing side of the wound contact layer supporting a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components, and the wound facing side of the wound contact layer including a first region of substantially non-stretchable material that supports at least one electronic component from the plurality of electronic components, wherein the at least one electronic component is attached to the first region of substantially non-stretchable material with adhesive material.

**[0041]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The wound facing side of the wound contact layer can include a second region of substantially non-stretchable material that supports at least one electronic connection from the plurality of electronic connections. The wound contact layer can include a substrate supporting the plurality of electronic components and the plurality of electronic connections and a conformal coating covering at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The substrate can be formed from thermoplastic polyurethane and the conformal coating can be formed from urethane. The wound contact layer can include a plurality of perforations configured to allow fluid to pass through the wound contact layer when negative pressure is applied to the wound. The plurality of perforations can be further configured to allow substantially unidirectional flow of fluid through the wound contact layer to prevent fluid removed from the wound from flowing back toward the wound.

**[0042]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The wound facing side of the wound contact layer can include a region of additional adhesive material configured to position the at least one electronic component in the wound. The wound facing side of the wound contact layer can include a third region of substantially non-stretchable material that encloses the at least one electronic component. The at least one electronic component can include one or more of a sensor, a light emitter, a processor, or a communications controller. Plurality of electronic connections can include a plurality of electrical traces. The apparatus can further include a negative pressure source configured to be fluidically connected to the wound dressing. The wound dressing can include an absorbent layer positioned over the non-wound facing side of the wound contact layer and a backing layer positioned over the absorbent layer. The wound contact layer can be sealed to the backing layer. The apparatus can further include a port on the backing layer, the port configured to fluidically connect the wound dressing to a negative pressure source. Adhesive material can be thermally curable.

**[0043]** In some implementations, a method of manufacturing a wound dressing includes providing a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, positioning a first region of substantially non-stretchable material on the wound facing side of the wound contact layer, and positioning a plurality of electronic components and a plurality of electronic connections on the wound facing side of the wound contact layer, wherein at least one electronic component from the plurality of electronic components is supported by the first region of substantially non-stretchable material, and wherein at least one electronic component is attached to the first region of substantially non-stretchable material with adhesive material.

**[0044]** The method of any of the preceding paragraphs can include one or more of the following features. The wound contact layer can include a substrate, and wherein the method can further include perforating the substrate around the plurality of electronic components and the plurality of electronic

connections and applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate.

**[0045]** The method of any of the preceding paragraphs can include one or more of the following features. The method can further include applying a region of additional adhesive material to the wound facing side of the wound contact layer, the additional adhesive material configured to position the at least one electronic component in the wound. The method can further include identifying a location of the at least one electronic component prior to applying the region of additional adhesive material. The wound contact layer can include a substrate, and the method can further include applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can further include applying a region of adhesive material to the wound facing side of the wound contact layer, the adhesive material configured to position the at least one electronic component in the wound and perforating the substrate around the plurality of electronic components and the plurality of electronic connections.

**[0046]** The method of any of the preceding paragraphs can include one or more of the following features. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections.

The method can further include identifying a location of the at least one electronic component prior to applying the region of adhesive material. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate.

**[0047]** The method of any of the preceding paragraphs can include one or more of the following features. The method can further include positioning a second region of substantially non-stretchable material on the wound facing side of the wound contact layer and supporting at least one electronic connection from the plurality of electronic connections on the second region. The method can further include enclosing the at least one electronic component by a third region of substantially non-stretchable material positioned on the wound facing side of the wound contact layer. The method can further include cutting the wound contact layer along at least one cutting line to separate a region of the wound contact layer including the plurality of electronic components and the plurality of electronic connections and attaching the region of the wound contact layer to one or more of an absorbent layer or a backing layer to form a wound dressing. The substrate can be formed thermoplastic polyurethane and the conformal coating can be formed from urethane. The adhesive material can be thermally curable.

**[0048]** In some implementations, a wound monitoring and/or therapy apparatus includes a wound dressing having a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, at least the wound facing side of the wound contact layer supporting a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components, and the wound facing side of the wound contact layer including a first region of substantially non-stretchable material that supports at least one electronic component from the plurality of electronic components. The at least one electronic component can be attached to the first region of substantially non-stretchable material with adhesive material.

**[0049]** The apparatus of the preceding paragraph can include one or more of the following features. The wound facing side of the wound contact layer can include a second region of substantially non-stretchable material that supports at least one electronic connection from the plurality of electronic connections. The wound contact layer can include a substrate supporting the plurality of electronic components and the plurality of electronic connections and a conformal coating covering at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The substrate can be formed from thermoplastic polyurethane and the conformal coating is formed from urethane. The wound contact layer can include a plurality of perforations configured to allow fluid to pass through the wound contact layer when negative pressure is applied to the wound. The plurality of perforations can be further configured to allow substantially unidirectional flow of fluid through the wound contact layer to prevent fluid removed from the wound from flowing back toward the wound.

**[0050]** The apparatus of any of the preceding paragraphs can include one or more of the following features. The wound facing side of the wound contact layer can include a region of additional adhesive material configured to position the at least one electronic component in the wound. The wound facing side of the wound contact layer can include a third region of substantially non-stretchable material that encloses the at least one electronic component. The at least one electronic component can be one or more of a sensor, a light emitter, a processor, or a communications controller. Plurality of electronic connections can include a plurality of electrical traces. The apparatus can include a negative pressure source configured to be fluidically connected to the wound dressing. The wound dressing can further include an absorbent layer positioned over the non-wound facing side of the wound contact layer and a backing layer positioned over the absorbent layer. The wound contact layer can be sealed to the backing layer. The backing layer can include a port configured to fluidically connect the wound dressing to a negative pressure source. At least one of the adhesive material or the additional adhesive material can be thermally curable.

**[0051]** In some implementations, a method of manufacturing a wound dressing includes providing a substantially stretchable wound contact layer including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the wound contact layer configured to be positioned in contact with a wound, positioning a first region of substantially non-stretchable material on the wound facing side of the wound contact layer, positioning adhesive material in at least a portion of the first region; and positioning a plurality of electronic components and a plurality of electronic connections at least on the wound facing side of the wound contact layer. The at least one electronic component from the plurality of electronic components can be supported by the first region of substantially non-stretchable material, and the at least one electronic component can be attached to the first region of substantially non-stretchable material with the adhesive material.

**[0052]** The method of the preceding paragraph can include one or more of the following features. The wound contact layer can include a substrate, and the method can further include perforating the substrate around the plurality of electronic components and the plurality of electronic connections and applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. Identifying the plurality of locations can include identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate. The method can further include applying a region of additional adhesive material to the wound facing side of the wound contact layer, the additional adhesive material configured to position the at least one electronic component in the wound.

**[0053]** The method of any of the preceding paragraphs can include one or more of the following features. The method can include further identifying a location of the at least one electronic component prior to applying the region of additional adhesive material. The wound contact layer can include a substrate, and the method can further include applying conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections. The method can further include applying a region of adhesive material to the wound facing side of the wound contact layer, the adhesive material configured to position the at least one electronic component in the wound, and perforating the substrate around the plurality of electronic components and the plurality of electronic connections.

**[0054]** The method of any of the preceding paragraphs can include one or more of the following features. The method can further include identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections. The method can further include identifying a location of the at least one electronic component prior to applying the region of adhesive material. Identifying the plurality of locations can include identifying one or more of a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate. The method can further include positioning a second region of substantially non-stretchable material on the wound facing side of the wound contact layer and supporting at least one electronic connection from the plurality of electronic connections on the second region.

**[0055]** The method of any of the preceding paragraphs can include one or more of the following features. The method can further include enclosing the at least one electronic component by a third region of substantially non-stretchable material positioned on the wound facing side of the wound contact layer. The method can further include cutting the wound contact layer along at



least one cutting line to separate a region of the wound contact layer including the plurality of electronic components and the plurality of electronic connections and attaching the region of the wound contact layer to one or more of an absorbent layer or a backing layer to form a wound dressing. The substrate can be formed from thermoplastic polyurethane and the conformal coating is formed from urethane. The method can further include curing at least one of the adhesive material or the additional adhesive material. The method can further include thermally curing the adhesive material during soldering of the at least one electronic component to at least one electronic connection of the one or more electronic connections.

**[0056]** Any of the features, components, or details of any of the arrangements or embodiments disclosed in this application, including without limitation any of the monitoring and/or therapy system embodiments and/or wound dressing embodiments disclosed below, are interchangeably combinable with any other features, components, or details of any of the arrangements or embodiments disclosed herein to form new arrangements and embodiments.

#### DETAILED DESCRIPTION

**[0057]** Embodiments disclosed herein relate to apparatuses and methods of treating a wound with or without reduced pressure, including for example a source of negative pressure and wound dressing components and apparatuses. The apparatuses and components comprising the wound overlay and packing materials or internal layers, if any, are sometimes collectively referred to herein as dressings. In some embodiments, the wound dressing can be provided to be utilized without reduced pressure.

**[0058]** Some embodiments disclosed herein relate to wound therapy for a human or animal body. Therefore, any reference to a wound herein can refer to a wound on a human or animal body, and any reference to a body herein can refer to a human or animal body. The disclosed technology embodiments may relate to preventing or minimizing damage to physiological tissue or living tissue, or to the treatment of damaged tissue (for example, a wound as described herein).

**[0059]** As used herein the expression “wound” may include an injury to living tissue may be caused by a cut, blow, or other impact, typically one in which the skin is cut or broken. A wound may be a chronic or acute injury. Acute wounds occur as a result of surgery or trauma. They move through the stages of healing within a predicted timeframe. Chronic wounds typically begin as acute wounds. The acute wound can become a chronic wound when it does not follow the healing stages resulting in a lengthened recovery. It is believed that the transition from acute to chronic wound can be due to a patient being immuno-compromised.

**[0060]** Chronic wounds may include for example: venous ulcers (such as those that occur in the legs), which account for the majority of chronic wounds and mostly affect the elderly, diabetic ulcers (for example, foot or ankle ulcers), peripheral arterial disease, pressure ulcers, or epidermolysis bullosa (EB).

**[0061]** Examples of other wounds include, but are not limited to, abdominal wounds or other large or incisional wounds, either as a result of surgery, trauma, sterniotomies, fasciotomies, or other conditions, dehisced wounds, acute wounds, chronic wounds, subacute and dehisced wounds, traumatic wounds, flaps and skin grafts, lacerations, abrasions, contusions, burns, diabetic ulcers, pressure ulcers, stoma, surgical wounds, trauma and venous ulcers or the like.

**[0062]** Wounds may also include a deep tissue injury. Deep tissue injury is a term proposed by the National Pressure Ulcer Advisory Panel (NPUAP) to describe a unique form of pressure ulcers. These ulcers have been described by clinicians for many years with terms such as purple pressure ulcers, ulcers that are likely to deteriorate and bruises on bony prominences.

**[0063]** Wound may also include tissue at risk of becoming a wound as discussed herein. For example, tissue at risk may include tissue over a bony protuberance (at risk of deep tissue injury/insult) or pre-surgical tissue (for example, knee tissue) that may have the potential to be cut (for example, for joint replacement/surgical alteration/reconstruction).

**[0064]** Some embodiments relate to methods of treating a wound with the technology disclosed herein in conjunction with one or more of the following:

advanced footwear, turning a patient, offloading (such as, offloading diabetic foot ulcers), treatment of infection, systemix, antimicrobial, antibiotics, surgery, removal of tissue, affecting blood flow, physiotherapy, exercise, bathing, nutrition, hydration, nerve stimulation, ultrasound, electrostimulation, oxygen therapy, microwave therapy, active agents ozone, antibiotics, antimicrobials, or the like.

**[0065]** Alternatively or additionally, a wound may be treated using topical negative pressure and/or traditional advanced wound care, which is not aided by the using of applied negative pressure (may also be referred to as non-negative pressure therapy).

**[0066]** Advanced wound care may include use of an absorbent dressing, an occlusive dressing, use of an antimicrobial and/or debriding agents in a wound dressing or adjunct, a pad (for example, a cushioning or compressive therapy, such as stockings or bandages), or the like.

**[0067]** In some embodiments, treatment of such wounds can be performed using traditional wound care, wherein a dressing can be applied to the wound to facilitate and promote healing of the wound.

**[0068]** Some embodiments relate to methods of manufacturing a wound dressing comprising providing a wound dressing as disclosed herein.

**[0069]** The wound dressings that may be utilized in conjunction with the disclosed technology include any known dressing in the art. The technology is applicable to negative pressure therapy treatment as well as non-negative pressure therapy treatment.

**[0070]** In some embodiments, a wound dressing comprises one or more absorbent layer(s). The absorbent layer may be a foam or a superabsorbent.

**[0071]** In some embodiments, wound dressings may comprise a dressing layer including a polysaccharide or modified polysaccharide, a polyvinylpyrrolidone, a polyvinyl alcohol, a polyvinyl ether, a polyurethane, a polyacrylate, a polyacrylamide, collagen, or gelatin or mixtures thereof. Dressing layers comprising the polymers listed are known in the art as being useful for forming a wound dressing layer for either negative pressure therapy or non-negative pressure therapy.

**[0072]** In some embodiments, the polymer matrix may be a polysaccharide or modified polysaccharide.

**[0073]** In some embodiments, the polymer matrix may be a cellulose. Cellulose material may include hydrophilically modified cellulose such as methyl cellulose, carboxymethyl cellulose (CMC), carboxymethyl cellulose (CEC), ethyl cellulose, propyl cellulose, hydroxyethyl cellulose, hydroxypropyl cellulose, hydroxypropylmethyl cellulose, carboxyethyl sulphonate cellulose, cellulose alkyl sulphonate, or mixtures thereof.

**[0074]** In certain embodiments, cellulose material may be cellulose alkyl sulphonate. The alkyl moiety of the alkyl sulphonate substituent group may have an alkyl group having 1 to 6 carbon atoms, such as methyl, ethyl, propyl, or butyl. The alkyl moiety may be branched or unbranched, and hence suitable propyl sulphonate substituents may be 1- or 2-methyl-ethylsulphonate. Butyl sulphonate substituents may be 2-ethyl-ethylsulphonate, 2,2-dimethyl-ethylsulphonate, or 1,2-dimethyl-ethylsulphonate. The alkyl sulphonate substituent group may be ethyl sulphonate. The cellulose alkyl sulphonate is described in WO10061225, US2016/114074, US2006/0142560, or US 5,703,225, the disclosures of which are hereby incorporated by reference in their entirety.

**[0075]** Cellulose alkyl sulfonates may have varying degrees of substitution, the chain length of the cellulose backbone structure, and the structure of the alkyl sulfonate substituent. Solubility and absorbency are largely dependent on the degree of substitution: as the degree of substitution is increased, the cellulose alkyl sulfonate becomes increasingly soluble. It follows that, as solubility increases, absorbency increases.

**[0076]** In some embodiments, a wound dressing also comprises a top or cover layer.

**[0077]** The thickness of the wound dressing disclosed herein may be between 1 to 20, or 2 to 10, or 3 to 7 mm.

#### Non-Negative Pressure Wound Dressing

**[0078]** In some embodiments, the disclosed technology may be used in conjunction with a non-negative pressure dressing. A non-negative pressure wound dressing suitable for providing protection at a wound site may comprise:

**[0079]** an absorbent layer for absorbing wound exudate and

**[0080]** an obscuring element for at least partially obscuring a view of wound exudate absorbed by the absorbent layer in use.

**[0081]** The obscuring element may be partially translucent.

**[0082]** The obscuring element may be a masking layer.

**[0083]** The non-negative pressure wound dressing may further comprise a region in or adjacent the obscuring element for allowing viewing of the absorbent layer. For example, the obscuring element layer may be provided over a central region of the absorbent layer and not over a border region of the absorbent layer. In some embodiments, the obscuring element is of hydrophilic material or is coated with a hydrophilic material.

**[0084]** The obscuring element may comprise a three-dimensional knitted spacer fabric. The spacer fabric is known in the art and may include a knitted spacer fabric layer.

**[0085]** The obscuring element may further comprise an indicator for indicating the need to change the dressing.

**[0086]** In some embodiments, the obscuring element is provided as a layer at least partially over the absorbent layer, further from a wound site than the absorbent layer in use.

**[0087]** The non-negative pressure wound dressing may further comprise a plurality of openings in the obscuring element for allowing fluid to move therethrough. The obscuring element may comprise, or may be coated with, a material having size-exclusion properties for selectively permitting or preventing passage of molecules of a predetermined size or weight.

**[0088]** The obscuring element may be configured to at least partially mask light radiation having wavelength of 600 nm and less.

**[0089]** The obscuring element may be configured to reduce light absorption by 50% or more.

**[0090]** The obscuring element may be configured to yield a CIE L\* value of 50 or more, and optionally 70 or more. In some embodiments, the obscuring element may be configured to yield a CIE L\* value of 70 or more.

**[0091]** In some embodiments, the non-negative pressure wound dressing may further comprise at least one of a wound contact layer, a foam layer, an odor control element, a pressure-resistant layer and a cover layer.

**[0092]** In some embodiments, the cover layer is present, and the cover layer is a translucent film. Typically, the translucent film has a moisture vapour permeability of 500g/m<sup>2</sup>/24hours or more.

**[0093]** The translucent film may be a bacterial barrier.

**[0094]** In some embodiments, the non-negative pressure wound dressing as disclosed herein comprises the wound contact layer and the absorbent layer overlies the wound contact layer. The wound contact layer carries an adhesive portion for forming a substantially fluid tight seal over the wound site.

**[0095]** The non-negative pressure wound dressing as disclosed herein may comprise the obscuring element and the absorbent layer being provided as a single layer.

**[0096]** In some embodiments, the non-negative pressure wound dressing disclosed herein comprises the foam layer, and the obscuring element is of a material comprising components that may be displaced or broken by movement of the obscuring element.

**[0097]** In some embodiments, the non-negative pressure wound dressing comprises an odor control element, and in another embodiment the dressing does not include an odor control element. When present, the odor control element may be dispersed within or adjacent the absorbent layer or the obscuring element. Alternatively, when present the odor control element may be provided as a layer sandwiched between the foam layer and the absorbent layer.

**[0098]** In some embodiments, the disclosed technology for a non-negative pressure wound dressing comprises a method of manufacturing a wound dressing, comprising: providing an absorbent layer for absorbing wound

exudate; and providing an obscuring element for at least partially obscuring a view of wound exudate absorbed by the absorbent layer in use.

**[0099]** In some embodiments, the non-negative pressure wound dressing is may be suitable for providing protection at a wound site, comprising: an absorbent layer for absorbing wound exudate; and a shielding layer provided over the absorbent layer, and further from a wound-facing side of the wound dressing than the absorbent layer. The shielding layer may be provided directly over the absorbent layer. In some embodiments, the shielding layer comprises a three-dimensional spacer fabric layer.

**[0100]** The shielding layer increases the area over which a pressure applied to the dressing is transferred by 25% or more or the initial area of application. For example the shielding layer increases the area over which a pressure applied to the dressing is transferred by 50% or more, and optionally by 100% or more, and optionally by 200% or more.

**[0101]** The shielding layer may comprise 2 or more sub-layers, wherein a first sub-layer comprises through holes and a further sub-layer comprises through holes and the through holes of the first sub-layer are offset from the through holes of the further sub-layer.

**[0102]** The non-negative pressure wound dressing as disclosed herein may further comprise a permeable cover layer for allowing the transmission of gas and vapour therethrough, the cover layer provided over the shielding layer, wherein through holes of the cover layer are offset from through holes of the shielding layer.

**[0103]** The non-negative pressure wound dressing may be suitable for treatment of pressure ulcers.

**[0104]** A more detailed description of the non-negative pressure dressing disclosed hereinabove is provided in WO2013007973, the entirety of which is hereby incorporated by reference.

**[0105]** In some embodiments, the non-negative pressure wound dressing may be a multi-layered wound dressing comprising: a fibrous absorbent layer for absorbing exudate from a wound site; and a support layer configured to reduce shrinkage of at least a portion of the wound dressing.

**[0106]** In some embodiments, the multi-layered wound dressing disclosed herein, further comprises a liquid impermeable film layer, wherein the support layer is located between the absorbent layer and the film layer.

**[0107]** The support layer disclosed herein may comprise a net. The net may comprise a geometric structure having a plurality of substantially geometric apertures extending therethrough. The geometric structure may for example comprise a plurality of bosses substantially evenly spaced and joined by polymer strands to form the substantially geometric apertures between the polymer strands.

**[0108]** The net may be formed from high density polyethylene.

**[0109]** The apertures may have an area from 0.005 to 0.32 mm<sup>2</sup>.

**[0110]** The support layer may have a tensile strength from 0.05 to 0.06 Nm.

**[0111]** The support layer may have a thickness of from 50 to 150 µm.

**[0112]** In some embodiments, the support layer is located directly adjacent the absorbent layer. Typically, the support layer is bonded to fibers in a top surface of the absorbent layer. The support layer may further comprise a bonding layer, wherein the support layer is heat laminated to the fibers in the absorbent layer via the bonding layer. The bonding layer may comprise a low melting point adhesive such as ethylene-vinyl acetate adhesive.

**[0113]** In some embodiments, the multi-layered wound dressing disclosed herein further comprises an adhesive layer attaching the film layer to the support layer.

**[0114]** In some embodiments, the multi-layered wound dressing disclosed herein further comprises a wound contact layer located adjacent the absorbent layer for positioning adjacent a wound. The multi-layered wound dressing may further comprise a fluid transport layer between the wound contact layer and the absorbent layer for transporting exudate away from a wound into the absorbent layer.

**[0115]** A more detailed description of the multi-layered wound dressing disclosed hereinabove is provided in GB patent application filed on 28 October



2016 with application number GB1618298.2, the entirety of which is hereby incorporated by reference.

**[0116]** In some embodiments, the disclosed technology may be incorporated in a wound dressing comprising a vertically lapped material comprising: a first layer of an absorbing layer of material, and a second layer of material, wherein the first layer being constructed from at least one layer of non-woven textile fibers, the non-woven textile fibers being folded into a plurality of folds to form a pleated structure. In some embodiments, the wound dressing further comprises a second layer of material that is temporarily or permanently connected to the first layer of material.

**[0117]** Typically the vertically lapped material has been slitted.

**[0118]** In some embodiments, the first layer has a pleated structure having a depth determined by the depth of pleats or by the slitting width. The first layer of material may be a moldable, lightweight, fiber-based material, blend of material or composition layer.

**[0119]** The first layer of material may comprise one or more of manufactured fibers from synthetic, natural or inorganic polymers, natural fibers of a cellulosic, proteinaceous or mineral source.

**[0120]** The wound dressing may comprise two or more layers of the absorbing layer of material vertically lapped material stacked one on top of the other, wherein the two or more layers have the same or different densities or composition.

**[0121]** The wound dressing may in some embodiments comprise only one layer of the absorbing layer of material vertically lapped material.

**[0122]** The absorbing layer of material is a blend of natural or synthetic, organic or inorganic fibers, and binder fibers, or bicomponent fibers typically PET with a low melt temperature PET coating to soften at specified temperatures and to act as a bonding agent in the overall blend.

**[0123]** In some embodiments, the absorbing layer of material may be a blend of 5 to 95 % thermoplastic polymer, and 5 to 95 wt % of a cellulose or derivative thereof.

**[0124]** In some embodiments, the wound dressing disclosed herein has a second layer comprises a foam or a dressing fixative.

**[0125]** The foam may be a polyurethane foam. The polyurethane foam may have an open or closed pore structure.

**[0126]** The dressing fixative may include bandages, tape, gauze, or backing layer.

**[0127]** In some embodiments, the wound dressing as disclosed herein comprises the absorbing layer of material connected directly to a second layer by lamination or by an adhesive, and the second layer is connected to a dressing fixative layer. The adhesive may be an acrylic adhesive, or a silicone adhesive.

**[0128]** In some embodiments, the wound dressing as disclosed herein further comprises layer of a superabsorbent fiber, or a viscose fiber or a polyester fiber.

**[0129]** In some embodiments, the wound dressing as disclosed herein further comprises a backing layer. The backing layer may be a transparent or opaque film. Typically the backing layer comprises a polyurethane film (typically a transparent polyurethane film).

**[0130]** A more detailed description of the multi-layered wound dressing disclosed hereinabove is provided in GB patent applications filed on 12 December 2016 with application number GB1621057.7; and 22 June 2017 with application number GB1709987.0, the entirety of each of which is hereby incorporated by reference.

**[0131]** In some embodiments, the non-negative pressure wound dressing may comprise an absorbent component for a wound dressing, the component comprising a wound contacting layer comprising gel forming fibers bound to a foam layer, wherein the foam layer is bound directly to the wound contact layer by an adhesive, polymer based melt layer, by flame lamination or by ultrasound.

**[0132]** The absorbent component may be in a sheet form.

**[0133]** The wound contacting layer may comprise a layer of woven or non-woven or knitted gel forming fibers.

**[0134]** The foam layer may be an open cell foam, or closed cell foam, typically an open cell foam. The foam layer is a hydrophilic foam.

**[0135]** The wound dressing may comprise the component that forms an island in direct contact with the wound surrounded by periphery of adhesive that adheres the dressing to the wound. The adhesive may be a silicone or acrylic adhesive, typically a silicone adhesive.

**[0136]** The wound dressing may be covered by a film layer on the surface of the dressing furthest from the wound.

**[0137]** A more detailed description of the wound dressing of this type hereinabove is provided in EP2498829, the entirety of which is hereby incorporated by reference.

**[0138]** In some embodiments, the non-negative pressure wound dressing may comprise a multi layered wound dressing for use on wounds producing high levels of exudate, characterized in that the dressing comprising: a transmission layer having an MVTR of at least 300 gm<sup>2</sup>/24 hours, an absorbent core comprising gel forming fibers capable of absorbing and retaining exudate, a wound contacting layer comprising gel forming fibers which transmits exudate to the absorbent core and a keying layer positioned on the absorbent core, the absorbent core and wound contacting layer limiting the lateral spread of exudate in the dressing to the region of the wound.

**[0139]** The wound dressing may be capable of handling at least 6g (or 8g and 15g) of fluid per 10cm<sup>2</sup> of dressing in 24 hours.

**[0140]** The wound dressing may comprise gel forming fibers that are chemically modified cellulosic fibers in the form of a fabric. The fibers may include carboxymethylated cellulose fibers, typically sodium carboxymethylcellulose fiber.

**[0141]** The wound dressing may comprise a wound contact layer with a lateral wicking rate from 5mm per minute to 40mm per minute. The wound contact layer may have a fiber density between 25gm<sup>2</sup> and 55gm<sup>2</sup>, such as 35gm<sup>2</sup>.

**[0142]** The absorbent core may have an absorbency of exudate of at least 10g/g, and typically a rate of lateral wicking of less the 20mm per minute.

**[0143]** The absorbent core may have a blend in the range of up to 25% cellulosic fibers by weight and 75% to 100% gel forming fibers by weight.

**[0144]** Alternatively, the absorbent core may have a blend in the range of up to 50% cellulosic fibers by weight and 50% to 100% gel forming fibers by weight. For example the blend is in the range of 50% cellulosic fibers by weight and 50% gel forming fibers by weight.

**[0145]** The fiber density in the absorbent core may be between 150gm<sup>2</sup> and 250gm<sup>2</sup>, or about 200 gm<sup>2</sup>.

**[0146]** The wound dressing when wet may have shrinkage that is less than 25 % or less than 15 % of its original size/dimension.

**[0147]** The wound dressing may comprise a transmission layer and the layer is a foam. The transmission layer may be a polyurethane foam laminated to a polyurethane film.

**[0148]** The wound dressing may comprise one or more layers selected from the group comprising a soluble medicated film layer; an odor-absorbing layer; a spreading layer and an additional adhesive layer.

**[0149]** The wound dressing may be 2mm and 4mm thick.

**[0150]** The wound dressing may be characterized in that the keying layer bonds the absorbent core to a neighboring layer. In some embodiments, the keying layer may be positioned on either the wound facing side of the absorbent core or the non-wound facing side of the absorbent core. In some embodiments, the keying layer is positioned between the absorbent core and the wound contact layer. The keying layer is a polyamide web.

**[0151]** A more detailed description of the wound dressing of this type hereinabove is provided in EP1718257, the entirety of which is hereby incorporated by reference.

**[0152]** In some embodiments, the non-negative pressure wound dressing may be a compression bandage. Compression bandages are known for use in the treatment of oedema and other venous and lymphatic disorders, e.g., of the lower limbs.

**[0153]** A compression bandage systems typically employ multiple layers including a padding layer between the skin and the compression layer or

layers. The compression bandage may be useful for wounds such as handling venous leg ulcers.

**[0154]** The compression bandage in some embodiments may comprise a bandage system comprising an inner skin facing layer and an elastic outer layer, the inner layer comprising a first ply of foam and a second ply of an absorbent nonwoven web, the inner layer and outer layer being sufficiently elongated so as to be capable of being wound about a patient's limb. A compression bandage of this type is disclosed in WO99/58090, the entirety of which is hereby incorporated by reference.

**[0155]** In some embodiments, the compression bandage system comprises: a) an inner skin facing, elongated, elastic bandage comprising: (i) an elongated, elastic substrate, and

**[0156]** (ii) an elongated layer of foam, said foam layer being affixed to a face of said substrate and extending 33% or more across said face of substrate in transverse direction and 67% or more across said face of substrate in longitudinal direction; and b) an outer, elongated, self-adhering elastic bandage; said bandage having a compressive force when extended; wherein, in use, said foam layer of the inner bandage faces the skin and the outer bandage overlies the inner bandage. A compression bandage of this type is disclosed in WO2006/110527, the entirety of which is hereby incorporated by reference.

**[0157]** In some embodiments other compression bandage systems such as those disclosed in US 6,759,566 and US 2002/0099318, the entirety of each of which is hereby incorporated by reference.

#### Negative Pressure Wound Dressing

**[0158]** In some embodiments, treatment of such wounds can be performed using negative pressure wound therapy, wherein a reduced or negative pressure can be applied to the wound to facilitate and promote healing of the wound. It will also be appreciated that the wound dressing and methods as disclosed herein may be applied to other parts of the body, and are not necessarily limited to treatment of wounds.

**[0159]** It will be understood that embodiments of the present disclosure are generally applicable to use in topical negative pressure ("TNP") therapy systems. Briefly, negative pressure wound therapy assists in the closure and healing of many forms of "hard to heal" wounds by reducing tissue oedema; encouraging blood flow and granular tissue formation; removing excess exudate and may reduce bacterial load (and thus infection risk). In addition, the therapy allows for less disturbance of a wound leading to more rapid healing. TNP therapy systems may also assist on the healing of surgically closed wounds by removing fluid and by helping to stabilize the tissue in the apposed position of closure. A further beneficial use of TNP therapy can be found in grafts and flaps where removal of excess fluid is important and close proximity of the graft to tissue is required in order to ensure tissue viability.

**[0160]** Negative pressure therapy can be used for the treatment of open or chronic wounds that are too large to spontaneously close or otherwise fail to heal by means of applying negative pressure to the site of the wound. Topical negative pressure (TNP) therapy or negative pressure wound therapy (NPWT) involves placing a cover that is impermeable or semi-permeable to fluids over the wound, using various means to seal the cover to the tissue of the patient surrounding the wound, and connecting a source of negative pressure (such as a vacuum pump) to the cover in a manner so that negative pressure is created and maintained under the cover. It is believed that such negative pressures promote wound healing by facilitating the formation of granulation tissue at the wound site and assisting the body's normal inflammatory process while simultaneously removing excess fluid, which may contain adverse cytokines or bacteria.

**[0161]** Some of the dressings used in NPWT can include many different types of materials and layers, for example, gauze, pads, foam pads or multi-layer wound dressings. One example of a multi-layer wound dressing is the PICO dressing, available from Smith & Nephew, includes a wound contact layer and a superabsorbent layer beneath a backing layer to provide a canister-less system for treating a wound with NPWT. The wound dressing may be sealed to a suction port providing connection to a length of tubing, which may be used to pump fluid out of the dressing or to transmit negative pressure from a pump to

the wound dressing. Additionally, RENASYS-F, RENASYS-G, RENASYS-AB, and RENASYS-F/AB, available from Smith & Nephew, are additional examples of NPWT wound dressings and systems. Another example of a multi-layer wound dressing is the ALLEVYN Life dressing, available from Smith & Nephew, which includes a moist wound environment dressing that is used to treat the wound without the use of negative pressure.

**[0162]** As is used herein, reduced or negative pressure levels, such as -X mmHg, represent pressure levels relative to normal ambient atmospheric pressure, which can correspond to 760 mmHg (or 1 atm, 29.93 inHg, 101.325 kPa, 14.696 psi, etc.). Accordingly, a negative pressure value of -X mmHg reflects absolute pressure that is X mmHg below 760 mmHg or, in other words, an absolute pressure of (760-X) mmHg. In addition, negative pressure that is "less" or "smaller" than X mmHg corresponds to pressure that is closer to atmospheric pressure (such as, -40 mmHg is less than -60 mmHg). Negative pressure that is "more" or "greater" than -X mmHg corresponds to pressure that is further from atmospheric pressure (such as, -80 mmHg is more than -60 mmHg). In some embodiments, local ambient atmospheric pressure is used as a reference point, and such local atmospheric pressure may not necessarily be, for example, 760 mmHg.

**[0163]** The negative pressure range for some embodiments of the present disclosure can be approximately -80 mmHg, or between about -20 mmHg and -200 mmHg. Note that these pressures are relative to normal ambient atmospheric pressure, which can be 760 mmHg. Thus, -200 mmHg would be about 560 mmHg in practical terms. In some embodiments, the pressure range can be between about -40 mmHg and -150 mmHg. Alternatively a pressure range of up to -75 mmHg, up to -80 mmHg or over -80 mmHg can be used. Also in other embodiments a pressure range of below -75 mmHg can be used. Alternatively, a pressure range of over approximately -100 mmHg, or even -150 mmHg, can be supplied by the negative pressure apparatus.

**[0164]** In some embodiments of wound closure devices described herein, increased wound contraction can lead to increased tissue expansion in the surrounding wound tissue. This effect may be increased by varying the force

applied to the tissue, for example by varying the negative pressure applied to the wound over time, possibly in conjunction with increased tensile forces applied to the wound via embodiments of the wound closure devices. In some embodiments, negative pressure may be varied over time for example using a sinusoidal wave, square wave, or in synchronization with one or more patient physiological indices (such as, heartbeat). Examples of such applications where additional disclosure relating to the preceding may be found include U.S. Patent No. 8,235,955, titled "Wound treatment apparatus and method," issued on August 7, 2012; and U.S. Patent No. 7,753,894, titled "Wound cleansing apparatus with stress," issued July 13, 2010. The disclosures of both of these patents are hereby incorporated by reference in their entirety.

**[0165]** Embodiments of the wound dressings, wound dressing components, wound treatment apparatuses and methods described herein may also be used in combination or in addition to those described in International Application No. PCT/IB2013/001469, filed May 22, 2013, published as WO 2013/175306 A2 on November 28, 2013, titled "APPARATUSES AND METHODS FOR NEGATIVE PRESSURE WOUND THERAPY," U.S. Patent Application No. 14/418,908, filed January 30, 2015, published as US 2015/0190286 A1 on July 9, 2015, titled "WOUND DRESSING AND METHOD OF TREATMENT," the disclosures of which are hereby incorporated by reference in their entireties. Embodiments of the wound dressings, wound dressing components, wound treatment apparatuses and methods described herein may also be used in combination or in addition to those described in U.S. Patent Application No. 13/092,042, filed April 21, 2011, published as US2011/0282309, titled "WOUND DRESSING AND METHOD OF USE," and U.S. Patent Application No. 14/715,527, filed May 18, 2015, published as US2016/0339158 A1 on November 24, 2016, titled "FLUIDIC CONNECTOR FOR NEGATIVE PRESSURE WOUND THERAPY," the disclosure of each of which is hereby incorporated by reference in its entirety, including further details relating to embodiments of wound dressings, the wound dressing components and principles, and the materials used for the wound dressings.



**[0166]** Additionally, some embodiments related to TNP wound treatment comprising a wound dressing in combination with a pump or associated electronics described herein may also be used in combination or in addition to those described in International Application PCT/EP2016/059329 filed April 26, 2016, published as WO 2016/174048 on November 3, 2016, entitled “REDUCED PRESSURE APPARATUS AND METHODS,” the disclosure of which is hereby incorporated by reference in its entirety.

#### NPWT System Overview

**[0167]** FIG. 1A illustrates an embodiment of a negative or reduced pressure wound treatment (or TNP) system 100 comprising a wound filler 130 placed inside a wound cavity 110, the wound cavity sealed by a wound cover 120. The wound filler 130 in combination with the wound cover 120 can be referred to as wound dressing. A single or multi lumen tube or conduit 140 is connected the wound cover 120 with a pump assembly 150 configured to supply reduced pressure. The wound cover 120 can be in fluidic communication with the wound cavity 110. In any of the system embodiments disclosed herein, as in the embodiment illustrated in FIG. 1A, the pump assembly can be a canisterless pump assembly (meaning that exudate is collected in the wound dressing or is transferred via tube 140 for collection to another location). However, any of the pump assembly embodiments disclosed herein can be configured to include or support a canister. Additionally, in any of the system embodiments disclosed herein, any of the pump assembly embodiments can be mounted to or supported by the dressing, or adjacent to the dressing.

**[0168]** The wound filler 130 can be any suitable type, such as hydrophilic or hydrophobic foam, gauze, inflatable bag, and so on. The wound filler 130 can be conformable to the wound cavity 110 such that it substantially fills the cavity. The wound cover 120 can provide a substantially fluid impermeable seal over the wound cavity 110. The wound cover 120 can have a top side and a bottom side, and the bottom side adhesively (or in any other suitable manner) seals with wound cavity 110. The conduit 140 or lumen or any

other conduit or lumen disclosed herein can be formed from polyurethane, PVC, nylon, polyethylene, silicone, or any other suitable material.

**[0169]** Some embodiments of the wound cover 120 can have a port (not shown) configured to receive an end of the conduit 140. For example, the port can be Renays Soft Port available from Smith & Nephew. In other embodiments, the conduit 140 can otherwise pass through or under the wound cover 120 to supply reduced pressure to the wound cavity 110 so as to maintain a desired level of reduced pressure in the wound cavity. The conduit 140 can be any suitable article configured to provide at least a substantially sealed fluid flow pathway between the pump assembly 150 and the wound cover 120, so as to supply the reduced pressure provided by the pump assembly 150 to wound cavity 110.

**[0170]** The wound cover 120 and the wound filler 130 can be provided as a single article or an integrated single unit. In some embodiments, no wound filler is provided and the wound cover by itself may be considered the wound dressing. The wound dressing may then be connected, via the conduit 140, to a source of negative pressure, such as the pump assembly 150. The pump assembly 150 can be miniaturized and portable, although larger conventional pumps such can also be used.

**[0171]** The wound cover 120 can be located over a wound site to be treated. The wound cover 120 can form a substantially sealed cavity or enclosure over the wound site. In some embodiments, the wound cover 120 can be configured to have a film having a high water vapour permeability to enable the evaporation of surplus fluid, and can have a superabsorbing material contained therein to safely absorb wound exudate. It will be appreciated that throughout this specification reference is made to a wound. In this sense it is to be understood that the term wound is to be broadly construed and encompasses open and closed wounds in which skin is torn, cut or punctured or where trauma causes a contusion, or any other surficial or other conditions or imperfections on the skin of a patient or otherwise that benefit from reduced pressure treatment. A wound is thus broadly defined as any damaged region of tissue where fluid may or may not be produced. Examples of such wounds include, but are not limited

to, acute wounds, chronic wounds, surgical incisions and other incisions, subacute and dehiscent wounds, traumatic wounds, flaps and skin grafts, lacerations, abrasions, contusions, burns, diabetic ulcers, pressure ulcers, stoma, surgical wounds, trauma and venous ulcers or the like. The components of the TNP system described herein can be particularly suited for incisional wounds that exude a small amount of wound exudate.

**[0172]** Some embodiments of the system are designed to operate without the use of an exudate canister. Some embodiments can be configured to support an exudate canister. In some embodiments, configuring the pump assembly 150 and tubing 140 so that the tubing 140 can be quickly and easily removed from the pump assembly 150 can facilitate or improve the process of dressing or pump changes, if necessary. Any of the pump embodiments disclosed herein can be configured to have any suitable connection between the tubing and the pump.

**[0173]** The pump assembly 150 can be configured to deliver negative pressure of approximately -80 mmHg, or between about -20 mmHg and 200 mmHg in some implementations. Note that these pressures are relative to normal ambient atmospheric pressure thus, -200 mmHg would be about 560 mmHg in practical terms. The pressure range can be between about -40 mmHg and -150 mmHg. Alternatively a pressure range of up to -75 mmHg, up to -80 mmHg or over -80 mmHg can be used. Also a pressure range of below -75 mmHg can be used. Alternatively a pressure range of over approximately -100 mmHg, or even 150 mmHg, can be supplied by the pump assembly 150.

**[0174]** In operation, the wound filler 130 is inserted into the wound cavity 110 and wound cover 120 is placed so as to seal the wound cavity 110. The pump assembly 150 provides a source of a negative pressure to the wound cover 120, which is transmitted to the wound cavity 110 via the wound filler 130. Fluid (such as, wound exudate) is drawn through the conduit 140, and can be stored in a canister. In some embodiments, fluid is absorbed by the wound filler 130 or one or more absorbent layers (not shown).

**[0175]** Wound dressings that may be utilized with the pump assembly and other embodiments of the present application include Renasys-F, Renasys-

G, Renasys AB, and Pico Dressings available from Smith & Nephew. Further description of such wound dressings and other components of a negative pressure wound therapy system that may be used with the pump assembly and other embodiments of the present application are found in U.S. Patent Publication Nos. 2011/0213287, 2011/0282309, 2012/0116334, 2012/0136325, and 2013/0110058, which are incorporated by reference in their entirety. In other embodiments, other suitable wound dressings can be utilized.

#### Wound Dressing Overview

**[0176]** FIG. 1B illustrates a cross-section through a wound dressing 155 according to some embodiments. FIG. 1B also illustrates a fluidic connector 160 according to some embodiments. The wound dressing 155 can be similar to the wound dressing described in International Patent Publication WO2013175306 A2, which is incorporated by reference in its entirety. Alternatively, the wound dressing 155 can be any wound dressing embodiment disclosed herein or any combination of features of any number of wound dressing embodiments disclosed herein, can be located over a wound site to be treated. The wound dressing 155 may be placed as to form a sealed cavity over the wound, such as the wound cavity 110. In some embodiments, the wound dressing 155 includes a top or cover layer, or backing layer 220 attached to an optional wound contact layer 222, both of which are described in greater detail below. These two layers 220, 222 can be joined or sealed together so as to define an interior space or chamber. This interior space or chamber may comprise additional structures that may be adapted to distribute or transmit negative pressure, store wound exudate and other fluids removed from the wound, and other functions which will be explained in greater detail below. Examples of such structures, described below, include a transmission layer 226 and an absorbent layer 221.

**[0177]** As used herein the upper layer, top layer, or layer above refers to a layer furthest from the surface of the skin or wound while the dressing is in use and positioned over the wound. Accordingly, the lower surface, lower layer, bottom layer, or layer below refers to the layer that is closest to the surface of the skin or wound while the dressing is in use and positioned over the wound.

**[0178]** The wound contact layer 222 can be a polyurethane layer or polyethylene layer or other flexible layer which is perforated, for example via a hot pin process, laser ablation process, ultrasound process or in some other way or otherwise made permeable to liquid and gas. The wound contact layer 222 has a lower surface 224 (for example, facing the wound) and an upper surface 223 (for example, facing away from the wound). The perforations 225 can comprise through holes in the wound contact layer 222 which enable fluid to flow through the layer 222. The wound contact layer 222 helps prevent tissue ingrowth into the other material of the wound dressing. In some embodiments, the perforations are small enough to meet this requirement while still allowing fluid to flow therethrough. For example, perforations formed as slits or holes having a size ranging from 0.025 mm to 1.2 mm are considered small enough to help prevent tissue ingrowth into the wound dressing while allowing wound exudate to flow into the dressing. In some configurations, the wound contact layer 222 may help maintain the integrity of the entire dressing 155 while also creating an air tight seal around the absorbent pad in order to maintain negative pressure at the wound. In some embodiments, the wound contact layer is configured to allow unidirectional or substantially one-way or unidirectional flow of fluid through the wound contact layer when negative pressure is applied to the wound. For example, the wound contact layer can permit fluid to flow away from the wound through the wound contact layer, but not allow fluid to flow back toward the wound. In certain case, the perforations in the wound contact layer are configured to permit such one-way or unidirectional flow of fluid through the wound contact layer.

**[0179]** Some embodiments of the wound contact layer 222 may also act as a carrier for an optional lower and upper adhesive layer (not shown). For example, a lower pressure sensitive adhesive may be provided on the lower surface 224 of the wound dressing 155 whilst an upper pressure sensitive adhesive layer may be provided on the upper surface 223 of the wound contact layer. The pressure sensitive adhesive, which may be a silicone, hot melt, hydrocolloid or acrylic based adhesive or other such adhesives, may be formed on both sides or optionally on a selected one or none of the sides of the wound

contact layer. When a lower pressure sensitive adhesive layer is utilized may be helpful to adhere the wound dressing 155 to the skin around a wound site. In some embodiments, the wound contact layer may comprise perforated polyurethane film. The lower surface of the film may be provided with a silicone pressure sensitive adhesive and the upper surface may be provided with an acrylic pressure sensitive adhesive, which may help the dressing maintain its integrity. In some embodiments, a polyurethane film layer may be provided with an adhesive layer on both its upper surface and lower surface, and all three layers may be perforated together.

**[0180]** A layer 226 of porous material can be located above the wound contact layer 222. This porous layer, or transmission layer, 226 allows transmission of fluid including liquid and gas away from a wound site into upper layers of the wound dressing. In particular, the transmission layer 226 can ensure that an open air channel can be maintained to communicate negative pressure over the wound area even when the absorbent layer has absorbed substantial amounts of exudates. The layer 226 can remain open under the typical pressures that will be applied during negative pressure wound therapy as described above, so that the whole wound site sees an equalized negative pressure. The layer 226 may be formed of a material having a three dimensional structure. For example, a knitted or woven spacer fabric (for example Baltex 7970 weft knitted polyester) or a non-woven fabric could be used.

**[0181]** In some embodiments, the transmission layer 226 comprises a 3D polyester spacer fabric layer including a top layer (that is to say, a layer distal from the wound-bed in use) which is a 84/144 textured polyester, and a bottom layer (that is to say, a layer which lies proximate to the wound bed in use) which is a 10 denier flat polyester and a third layer formed sandwiched between these two layers which is a region defined by a knitted polyester viscose, cellulose or the like monofilament fiber. Other materials and other linear mass densities of fiber could of course be used.

**[0182]** Whilst reference is made throughout this disclosure to a monofilament fiber it will be appreciated that a multistrand alternative could of course be utilized. The top spacer fabric thus has more filaments in a yarn used

to form it than the number of filaments making up the yarn used to form the bottom spacer fabric layer.

**[0183]** This differential between filament counts in the spaced apart layers helps control moisture flow across the transmission layer. Particularly, by having a filament count greater in the top layer, that is to say, the top layer is made from a yarn having more filaments than the yarn used in the bottom layer, liquid tends to be wicked along the top layer more than the bottom layer. In use, this differential tends to draw liquid away from the wound bed and into a central region of the dressing where the absorbent layer 221 helps lock the liquid away or itself wicks the liquid onwards towards the cover layer where it can be transpired.

**[0184]** In some embodiments, to improve the liquid flow across the transmission layer 226 (that is to say perpendicular to the channel region formed between the top and bottom spacer layers, the 3D fabric may be treated with a dry cleaning agent (such as, but not limited to, Perchloro Ethylene) to help remove any manufacturing products such as mineral oils, fats or waxes used previously which might interfere with the hydrophilic capabilities of the transmission layer. An additional manufacturing step can subsequently be carried in which the 3D spacer fabric is washed in a hydrophilic agent (such as, but not limited to, Feran Ice 30g/l available from the Rudolph Group). This process step helps ensure that the surface tension on the materials is so low that liquid such as water can enter the fabric as soon as it contacts the 3D knit fabric. This also aids in controlling the flow of the liquid insult component of any exudates.

**[0185]** A layer 221 of absorbent material can be provided above the transmission layer 226. The absorbent material, which comprise a foam or non-woven natural or synthetic material, and which may optionally comprise a super-absorbent material, forms a reservoir for fluid, particularly liquid, removed from the wound site. In some embodiments, the layer 221 may also aid in drawing fluids towards the backing layer 220.

**[0186]** The material of the absorbent layer 221 may also prevent liquid collected in the wound dressing 155 from flowing freely within the dressing, and

can act so as to contain any liquid collected within the dressing. The absorbent layer 221 also helps distribute fluid throughout the layer via a wicking action so that fluid is drawn from the wound site and stored throughout the absorbent layer. This helps prevent agglomeration in areas of the absorbent layer. The capacity of the absorbent material must be sufficient to manage the exudates flow rate of a wound when negative pressure is applied. Since in use the absorbent layer experiences negative pressures the material of the absorbent layer is chosen to absorb liquid under such circumstances. A number of materials exist that are able to absorb liquid when under negative pressure, for example superabsorber material. The absorbent layer 221 may typically be manufactured from ALLEVYN™ foam, Freudenberg 114-224-4 or Chem-Posite™ 11C-450. In some embodiments, the absorbent layer 221 may comprise a composite comprising superabsorbent powder, fibrous material such as cellulose, and bonding fibers. In some embodiments, the composite is an airlaid, thermally-bonded composite.

**[0187]** In some embodiments, the absorbent layer 221 is a layer of non-woven cellulose fibers having super-absorbent material in the form of dry particles dispersed throughout. Use of the cellulose fibers introduces fast wicking elements which help quickly and evenly distribute liquid taken up by the dressing. The juxtaposition of multiple strand-like fibers leads to strong capillary action in the fibrous pad which helps distribute liquid. In this way, the super-absorbent material is efficiently supplied with liquid. The wicking action also assists in bringing liquid into contact with the upper cover layer to aid increase transpiration rates of the dressing.

**[0188]** An aperture, hole, or orifice 227 can be provided in the backing layer 220 to allow a negative pressure to be applied to the dressing 155. In some embodiments, the fluidic connector 160 is attached or sealed to the top of the backing layer 220 over the orifice 227 made into the dressing 155, and communicates negative pressure through the orifice 227. A length of tubing may be coupled at a first end to the fluidic connector 160 and at a second end to a pump unit (not shown) to allow fluids to be pumped out of the dressing. Where the fluidic connector is adhered to the top layer of the wound dressing, a length of



tubing may be coupled at a first end of the fluidic connector such that the tubing, or conduit, extends away from the fluidic connector parallel or substantially to the top surface of the dressing. The fluidic connector 160 may be adhered and sealed to the backing layer 220 using an adhesive such as an acrylic, cyanoacrylate, epoxy, UV curable or hot melt adhesive. The fluidic connector 160 may be formed from a soft polymer, for example a polyethylene, a polyvinyl chloride, a silicone or polyurethane having a hardness of 30 to 90 on the Shore A scale. In some embodiments, the fluidic connector 160 may be made from a soft or conformable material.

**[0189]** In some embodiments, the absorbent layer 221 includes at least one through hole 228 located so as to underlie the fluidic connector 160. The through hole 228 may in some embodiments be the same size as the opening 227 in the backing layer, or may be bigger or smaller. As illustrated in FIG. 1B a single through hole can be used to produce an opening underlying the fluidic connector 160. It will be appreciated that multiple openings could alternatively be utilized. Additionally should more than one port be utilized according to certain embodiments of the present disclosure one or multiple openings may be made in the absorbent layer and the obscuring layer in registration with each respective fluidic connector. Although not essential to certain embodiments of the present disclosure the use of through holes in the super-absorbent layer may provide a fluid flow pathway which remains unblocked in particular when the absorbent layer is near saturation.

**[0190]** The aperture or through-hole 228 can be provided in the absorbent layer 221 beneath the orifice 227 such that the orifice is connected directly to the transmission layer 226 as illustrated in FIG. 1B. This allows the negative pressure applied to the fluidic connector 160 to be communicated to the transmission layer 226 without passing through the absorbent layer 221. This ensures that the negative pressure applied to the wound site is not inhibited by the absorbent layer as it absorbs wound exudates. In other embodiments, no aperture may be provided in the absorbent layer 221, or alternatively a plurality of apertures underlying the orifice 227 may be provided. In further alternative embodiments, additional layers such as another transmission layer or an

obscuring layer such as described in International Patent Publication WO2014020440, the entirety of which is hereby incorporated by reference, may be provided over the absorbent layer 221 and beneath the backing layer 220.

**[0191]** The backing layer 220 is can be gas impermeable, but moisture vapor permeable, and can extend across the width of the wound dressing 155. The backing layer 220, which may for example be a polyurethane film (for example, Elastollan SP9109) having a pressure sensitive adhesive on one side, is impermeable to gas and this layer thus operates to cover the wound and to seal a wound cavity over which the wound dressing is placed. In this way an effective chamber is made between the backing layer 220 and a wound site where a negative pressure can be established. The backing layer 220 can be sealed to the wound contact layer 222 in a border region around the circumference of the dressing, ensuring that no air is drawn in through the border area, for example via adhesive or welding techniques. The backing layer 220 protects the wound from external bacterial contamination (bacterial barrier) and allows liquid from wound exudates to be transferred through the layer and evaporated from the film outer surface. The backing layer 220 can include two layers; a polyurethane film and an adhesive pattern spread onto the film. The polyurethane film can be moisture vapor permeable and may be manufactured from a material that has an increased water transmission rate when wet. In some embodiments the moisture vapor permeability of the backing layer increases when the backing layer becomes wet. The moisture vapor permeability of the wet backing layer may be up to about ten times more than the moisture vapor permeability of the dry backing layer.

**[0192]** The absorbent layer 221 may be of a greater area than the transmission layer 226, such that the absorbent layer overlaps the edges of the transmission layer 226, thereby ensuring that the transmission layer does not contact the backing layer 220. This provides an outer channel of the absorbent layer 221 that is in direct contact with the wound contact layer 222, which aids more rapid absorption of exudates to the absorbent layer. Furthermore, this outer channel ensures that no liquid is able to pool around the circumference of the wound cavity, which may otherwise seep through the seal around the

perimeter of the dressing leading to the formation of leaks. As illustrated in FIG. 1B, the absorbent layer 221 may define a smaller perimeter than that of the backing layer 220, such that a boundary or border region is defined between the edge of the absorbent layer 221 and the edge of the backing layer 220.

**[0193]** As shown in FIG. 1B, one embodiment of the wound dressing 155 comprises an aperture 228 in the absorbent layer 221 situated underneath the fluidic connector 160. In use, for example when negative pressure is applied to the dressing 155, a wound facing portion of the fluidic connector may thus come into contact with the transmission layer 226, which can thus aid in transmitting negative pressure to the wound site even when the absorbent layer 221 is filled with wound fluids. Some embodiments may have the backing layer 220 be at least partly adhered to the transmission layer 226. In some embodiments, the aperture 228 is at least 1-2 mm larger than the diameter of the wound facing portion of the fluidic connector 11, or the orifice 227.

**[0194]** For example, in embodiments with a single fluidic connector 160 and through hole, it may be preferable for the fluidic connector 160 and through hole to be located in an off-center position. Such a location may permit the dressing 155 to be positioned onto a patient such that the fluidic connector 160 is raised in relation to the remainder of the dressing 155. So positioned, the fluidic connector 160 and the filter 214 may be less likely to come into contact with wound fluids that could prematurely occlude the filter 214 so as to impair the transmission of negative pressure to the wound site.

**[0195]** Turning now to the fluidic connector 160, some embodiments include a sealing surface 216, a bridge 211 with a proximal end (closer to the negative pressure source) and a distal end 140, and a filter 214. The sealing surface 216 can form the applicator that is sealed to the top surface of the wound dressing. In some embodiments a bottom layer of the fluidic connector 160 may comprise the sealing surface 216. The fluidic connector 160 may further comprise an upper surface vertically spaced from the sealing surface 216, which in some embodiments is defined by a separate upper layer of the fluidic connector. In other embodiments the upper surface and the lower surface may be formed from the same piece of material. In some embodiments the sealing

surface 216 may comprise at least one aperture 229 therein to communicate with the wound dressing. In some embodiments the filter 214 may be positioned across the opening 229 in the sealing surface, and may span the entire opening 229. The sealing surface 216 may be configured for sealing the fluidic connector to the cover layer of the wound dressing, and may comprise an adhesive or weld. In some embodiments, the sealing surface 216 may be placed over an orifice in the cover layer with optional spacer elements 215 configured to create a gap between the filter 214 and the transmission layer 226. In other embodiments, the sealing surface 216 may be positioned over an orifice in the cover layer and an aperture in the absorbent layer 220, permitting the fluidic connector 160 to provide air flow through the transmission layer 226. In some embodiments, the bridge 211 may comprise a first fluid passage 212 in communication with a source of negative pressure, the first fluid passage 212 comprising a porous material, such as a 3D knitted material, which may be the same or different than the porous layer 226 described previously. The bridge 211 can be encapsulated by at least one flexible film layer 208, 210 having a proximal and distal end and configured to surround the first fluid passage 212, the distal end of the flexible film being connected the sealing surface 216. The filter 214 is configured to substantially prevent wound exudate from entering the bridge, and spacer elements 215 are configured to prevent the fluidic connector from contacting the transmission layer 226. These elements will be described in greater detail below.

**[0196]** Some embodiments may further comprise an optional second fluid passage positioned above the first fluid passage 212. For example, some embodiments may provide for an air leak may be disposed at the proximal end of the top layer that is configured to provide an air path into the first fluid passage 212 and dressing 155 similar to the suction adapter as described in U.S. Patent No 8,801,685, which is incorporated by reference herein in its entirety.

**[0197]** In some embodiment, the fluid passage 212 is constructed from a compliant material that is flexible and that also permits fluid to pass through it if the spacer is kinked or folded over. Suitable materials for the fluid passage 212 include without limitation foams, including open-cell foams such as polyethylene or polyurethane foam, meshes, 3D knitted fabrics, non-woven materials, and fluid

channels. In some embodiments, the fluid passage 212 may be constructed from materials similar to those described above in relation to the transmission layer 226. Advantageously, such materials used in the fluid passage 212 not only permit greater patient comfort, but may also provide greater kink resistance, such that the fluid passage 212 is still able to transfer fluid from the wound toward the source of negative pressure while being kinked or bent.

**[0198]** In some embodiments, the fluid passage 212 may be comprised of a wicking fabric, for example a knitted or woven spacer fabric (such as a knitted polyester 3D fabric, Baltex 7970®, or Gehring 879®) or a nonwoven fabric. These materials selected can be suited to channeling wound exudate away from the wound and for transmitting negative pressure or vented air to the wound site, and may also confer a degree of kinking or occlusion resistance to the fluid passage 212. In some embodiments, the wicking fabric may have a three-dimensional structure, which in some cases may aid in wicking fluid or transmitting negative pressure. In certain embodiments, including wicking fabrics, these materials remain open and capable of communicating negative pressure to a wound area under the typical pressures used in negative pressure therapy, for example between -40 to -150 mmHg. In some embodiments, the wicking fabric may comprise several layers of material stacked or layered over each other, which may in some cases be useful in preventing the fluid passage 212 from collapsing under the application of negative pressure. In other embodiments, the wicking fabric used in the fluid passage 212 may be between 1.5 mm and 6 mm; more preferably, the wicking fabric may be between 3 mm and 6 mm thick, and may be comprised of either one or several individual layers of wicking fabric. In other embodiments, the fluid passage 212 may be between 1.2-3 mm thick, and preferably thicker than 1.5 mm. Some embodiments, for example a suction adapter used with a dressing which retains liquid such as wound exudate, may employ hydrophobic layers in the fluid passage 212, and only gases may travel through the fluid passage 212. Additionally, and as described previously, the materials used in the system can be conformable and soft, which may help to avoid pressure ulcers and other complications which may result from a wound treatment system being pressed against the skin of a patient.

**[0199]** In some embodiments, the filter element 214 is impermeable to liquids, but permeable to gases, and is provided to act as a liquid barrier and to ensure that no liquids are able to escape from the wound dressing 155. The filter element 214 may also function as a bacterial barrier. Typically the pore size is 0.2µm. Suitable materials for the filter material of the filter element 214 include 0.2 micron Gore™ expanded PTFE from the MMT range, PALL Versapore™ 200R, and Donaldson™ TX6628. Larger pore sizes can also be used but these may require a secondary filter layer to ensure full bioburden containment. As wound fluid contains lipids it is preferable, though not essential, to use an oleophobic filter membrane for example 1.0 micron MMT-332 prior to 0.2 micron MMT-323. This prevents the lipids from blocking the hydrophobic filter. The filter element can be attached or sealed to the port or the cover film over the orifice. For example, the filter element 214 may be molded into the fluidic connector 160, or may be adhered to one or both of the top of the cover layer and bottom of the suction adapter 160 using an adhesive such as, but not limited to, a UV cured adhesive.

**[0200]** It will be understood that other types of material could be used for the filter element 214. More generally a microporous membrane can be used which is a thin, flat sheet of polymeric material, this contains billions of microscopic pores. Depending upon the membrane chosen these pores can range in size from 0.01 to more than 10 micrometers. Microporous membranes are available in both hydrophilic (water filtering) and hydrophobic (water repellent) forms. In some embodiments, filter element 214 comprises a support layer and an acrylic co-polymer membrane formed on the support layer. In some embodiments, the wound dressing 155 according to certain embodiments uses microporous hydrophobic membranes (MHMs). Numerous polymers may be employed to form MHMs. For example, the MHMs may be formed from one or more of PTFE, polypropylene, PVDF and acrylic copolymer. All of these optional polymers can be treated in order to obtain specific surface characteristics that can be both hydrophobic and oleophobic. As such these will repel liquids with low surface tensions such as multi-vitamin infusions, lipids, surfactants, oils and organic solvents.

**[0201]** MHMs block liquids whilst allowing air to flow through the membranes. They are also highly efficient air filters eliminating potentially infectious aerosols and particles. A single piece of MHM is well known as an option to replace mechanical valves or vents. Incorporation of MHMs can thus reduce product assembly costs improving profits and costs/benefit ratio to a patient.

**[0202]** The filter element 214 may also include an odor absorbent material, for example activated charcoal, carbon fiber cloth or Vitec Carbotec-RT Q2003073 foam, or the like. For example, an odor absorbent material may form a layer of the filter element 214 or may be sandwiched between microporous hydrophobic membranes within the filter element. The filter element 214 thus enables gas to be exhausted through the orifice. Liquid, particulates and pathogens however are contained in the dressing.

**[0203]** The wound dressing 155 may comprise spacer elements 215 in conjunction with the fluidic connector 160 and the filter 214. With the addition of such spacer elements 215 the fluidic connector 160 and filter 214 may be supported out of direct contact with the absorbent layer 220 or the transmission layer 226. The absorbent layer 220 may also act as an additional spacer element to keep the filter 214 from contacting the transmission layer 226. Accordingly, with such a configuration contact of the filter 214 with the transmission layer 226 and wound fluids during use may thus be minimized.

**[0204]** Similar to the embodiments of wound dressings described above, some wound dressings comprise a perforated wound contact layer with silicone adhesive on the skin-contact face and acrylic adhesive on the reverse. Above this bordered layer sits a transmission layer or a 3D spacer fabric pad. Above the transmission layer, sits an absorbent layer. The absorbent layer can include a superabsorbent non-woven (NW) pad. The absorbent layer can over-border the transmission layer by approximately 5mm at the perimeter. The absorbent layer can have an aperture or through-hole toward one end. The aperture can be about 10 mm in diameter. Over the transmission layer and absorbent layer lies a backing layer. The backing layer can be a high moisture vapor transmission rate (MVTR) film, pattern coated with acrylic adhesive. The

high MVTR film and wound contact layer encapsulate the transmission layer and absorbent layer, creating a perimeter border of approximately 20 mm. The backing layer can have a 10 mm aperture that overlies the aperture in the absorbent layer. Above the hole can be bonded a fluidic connector that comprises a liquid-impermeable, gas-permeable semi-permeable membrane (SPM) or filter that overlies the aforementioned apertures.

#### Wound Dressing with Sensors

**[0205]** A wound dressing that incorporates a number of sensors can be utilized in order to monitor characteristics of a wound as it heals. Collecting data from the wounds that heal well, and from those that do not, can provide useful insights towards identifying measurands to indicate whether a wound is on a healing trajectory.

**[0206]** In some implementations, a number of sensor technologies can be used in wound dressings or one or more components forming part of an overall wound dressing apparatus. For example, as illustrated in FIGS. 2 and 3D, which depict wound dressings 250 and 320 with sensor arrays according to some embodiments, one or more sensors can be incorporated onto or into a wound contact layer, which may be a perforated wound contact layer as shown in FIG. 3D. The wound contact layer in FIGS. 2 and 3D is illustrated as having a square shape, but it will be appreciated that the wound contact layer may have other shapes such as rectangular, circular, oval, etc. In some embodiments, the sensor integrated wound contact layer can be provided as an individual material layer that is placed over the wound area and then covered by a wound dressing apparatus or components of a wound dressing apparatus, such as gauze, foam or other wound packing material, a superabsorbent layer, a drape, a fully integrated dressing like the Pico or Allevyn Life dressing, etc. In other embodiments, the sensor integrated wound contact layer may be part of a single unit dressing such as described herein.

**[0207]** The sensor-integrated wound contact layer can be placed in contact with the wound and will allow fluid to pass through the contact layer while causing little to no damage to the tissue in the wound. The sensor-integrated



wound contact layer can be made of a flexible material such as silicone and can incorporate antimicrobials or other therapeutic agents known in the art. In some embodiments, the sensor-integrated wound contact layer can incorporate adhesives that adhere to wet or dry tissue. In some embodiments, the sensors or sensor array can be incorporated into or encapsulated within other components of the wound dressing such as the absorbent layer or spacer layer described above.

**[0208]** As shown in FIGS. 2 and 3D, five sensors can be used, including, for instance, sensors for temperature (such as, 25 thermistor sensors, in a 5 x 5 array, ~20mm pitch), oxygen saturation or SpO<sub>2</sub> (such as, 4 or 5 SpO<sub>2</sub> sensors, in a single line from the center of the wound contact layer to the edge thereof, 10mm pitch), tissue color (such as, 10 optical sensors, in 2 x 5 array, ~20mm pitch; not all 5 sensors in each row of the array need be aligned), pH (such as, by measuring colour of a pH sensitive pad, optionally using the same optical sensors as for tissue colour), and conductivity (such as, 9 conductivity contacts, in a 3 x 3 array, ~40mm pitch). As shown in FIG. 3A, the SpO<sub>2</sub> sensors can be arranged in a single line from the center of or near the center of the wound contact layer to the edge of the wound contact layer. The line of SpO<sub>2</sub> sensors can allow the sensor to take measurements in the middle of the wound, at the edge of the wound, or on intact skin to measure changes between the various regions. In some embodiments, the wound contact layer or sensor array can be larger than the size of the wound to cover the entire surface area of the wound as well as the surrounding intact skin. The larger size of the wound contact layer and/or sensor array and the multiple sensors can provide more information about the wound area than if the sensor was only placed in the center of the wound or in only one area at a time.

**[0209]** The sensors can be incorporated onto flexible circuit boards formed of flexible polymers including polyamide, polyimide (PI), polyester, polyethylene naphthalate (PEN), polyetherimide (PEI), along with various fluropolymers (FEP) and copolymers, or any material known in the art. The sensor array can be incorporated into a two-layer flexible circuit. In some embodiments, the circuit board can be a multi-layer flexible circuit board. In

some embodiments, these flexible circuits can be incorporated into any layer of the wound dressing. In some embodiments, a flexible circuit can be incorporated into a wound contact layer. For example, the flexible circuit can be incorporated into a wound contact layer similar to the wound contact layer described with reference to FIG. 1B. The wound contact layer can have cutouts or slits that allow for one or more sensors to protrude out of the lower surface of the wound contact layer and contact the wound area directly.

**[0210]** In some embodiments, the sensor-integrated wound contact layer can include a first and second wound contact layer with the flexible circuit board sandwiched between the two layers of wound contact layer material. The first wound contact layer has a lower surface intended to be in contact with the wound and an upper surface intended to be in contact with flexible circuit board. The second wound contact layer has a lower surface intended to be in contact with the flexible circuit board and an upper surface intended to be in contact with a wound dressings or one or more components forming part of an overall wound dressing apparatus. The upper surface of the first wound contact layer and the lower surface of the second wound contact layer can be adhered together with the flexible circuit board sandwiched between the two layers.

**[0211]** In some embodiments, the one or more sensors of the flexible circuit board can be fully encapsulated or covered by the wound contact layers to prevent contact with moisture or fluid in the wound. In some embodiments, the first wound contact layer can have cutouts or slits that allow for one or more sensors to protrude out of the lower surface and contact the wound area directly. For example, the one or more SpO<sub>2</sub> sensors as shown in FIG. 3D are shown protruding out the bottom surface of the wound contact layer. In some embodiments, the SpO<sub>2</sub> sensors can be mounted directly on a lower surface of the first wound contact layer. Some or all of the sensors and electrical or electronic components may be potted or encapsulated (for example, rendered waterproof or liquid-proof) with a polymer, for example, silicon or epoxy based polymers. The encapsulation with a polymer can prevent ingress of fluid and leaching of chemicals from the components. In some embodiments, the wound

contact layer material can seal the components from water ingress and leaching of chemicals.

**[0212]** In some embodiments, gathering and processing information related to the wound can utilize three components, including a sensor array, a control or processing module, and software. These components are described in more detail herein.

**[0213]** FIG. 3A illustrates a flexible sensor array circuit board 300 that includes a sensor array portion 301, a tail portion 302, and a connector pad end portion 303 according to some embodiments. The sensor array portion 301 can include the sensors and associated circuitry. The sensor array circuit board 300 can include a long tail portion 302 extending from the sensor array portion 301. The connector pad end portion 303 can be enabled to connect to a control module or other processing unit to receive the data from the sensor array circuit. The long tail portion 302 can allow the control module to be placed distant from the wound, such as for example in a more convenient location away from the wound.

**[0214]** FIG. 3B illustrates embodiments of the flexible circuit boards with four different sensor array geometries 301A, 301B, 301C, and 301D according to some embodiments. The illustrated embodiments include tail portions 302A, 302B, 302C, and 302D. In some embodiments, four different sensor array geometries shown can be implemented in flexible circuits. While FIG. 3B show four different sensor array formats and configurations, the design 301B and 302B also includes the connector pads end portion 303 configured to provide electrical or electronic connection between the sensor array 301B and a control module. One or more of the designs in 301A, 301C, or 301D can also include a connector pads end portion, such as the portion 303, to allow flexible circuit boards 301A, 301C, or 301D to communicate with a control module or other processing unit. In some embodiments, the sensor array communicates with the control module wirelessly and the tail portion may be omitted.

**[0215]** FIG. 3C shows the sensor array portion 301B of the sensor array design shown of FIG. 3B in more detail. In any one or more of the embodiments of FIGS 2 or 3A-3D, the sensor array portion can include a plurality

of portions that extend either around a perimeter of a wound dressing component such as a wound contact layer, or inward from an outer edge of the wound dressing component. For example, the illustrated embodiments include a plurality of linearly extending portions that may be parallel to edges of a wound dressing component, and in some embodiments, follow the entire perimeter of the wound dressing component. In some embodiments, the sensor array portion may comprise a first plurality of parallel linearly extending portions that are perpendicular to a second plurality of parallel linearly extending portions. These linearly extending portions may also have different lengths and may extend inward to different locations within an interior of a wound dressing component. The sensor array portion preferably does not cover the entire wound dressing component, so that gaps are formed between portions of the sensor array. As shown in FIG. 2, this allows some, and possibly a majority of the wound dressing component to be uncovered by the sensor array. For example, for a perforated wound contact layer as shown in FIG. 2 and 3D, the sensor array portion 301 may not block a majority of the perforations in the wound contact layer. In some embodiments, the sensor array may also be perforated or shaped to match the perforations in the wound contact layer to minimize the blocking of perforations to fluid flow.

**[0216]** FIG. 3D illustrates a flexible sensor array incorporated into a perforated wound contact layer 320 according to some embodiments. As is illustrated, the sensor array can be sandwiched between two films or wound contact layers. The wound contact layers can have perforations formed as slits or holes as described herein that are small enough to help prevent tissue ingrowth into the wound dressing while allowing wound exudate to flow into the dressing. In some embodiments, the wound contact layers can have one or more slits that increase flexibility of the wound contact layer with integrated sensor array. In some embodiments, one of the wound contact layers can have extra cut outs to accommodate the sensors so that they can contact the skin directly.

**[0217]** Connectivity for the sensor array can vary depending on the various sensors and sensor array designs utilized. In some embodiments, for example as shown in FIG. 3B, a total of 79 connections can be used to connect

the components of the sensor array. The sensor arrays can be terminated in two parallel 40-way 0.5mm pitch Flat Flexible Cable (FFC) contact surfaces, with terminals on the top surface, designed to be connected to an FFC connector such as Molex 54104-4031.

**[0218]** In some embodiments, one or more of thermistors, conductivity sensors, SpO2 sensors, or color sensors can be used on the sensor array to provide information relating to conditions of the wound. The sensor array and individual sensors can assist a clinician in monitoring the healing of the wound. The one or more sensors can operate individually or in coordination with each other to provide data relating to the wound and wound healing characteristics.

**[0219]** Temperature sensors can use thermocouples or thermistors to measure temperature. The thermistors can be used to measure or track the temperature of the underlying wound or the thermal environment within the wound dressing. The thermometry sensors can be calibrated and the data obtained from the sensors can be processed to provide information about the wound environment. In some embodiments, an ambient sensor measuring ambient air temperature can also be used to assist in eliminating problems associated with environment temperature shifts.

**[0220]** Optical sensors can be used to measure wound appearance using an RGB sensor with an illumination source. In some embodiments, both the RGB sensor and the illumination source would be pressed up against the skin, such that light would penetrate into the tissue and take on the spectral features of the tissue itself.

**[0221]** Light propagation in tissue can be dominated by two major phenomena, scattering and attenuation. For attenuation, as light passes through tissue, its intensity may be lost due to absorption by various components of the tissue. Blue light tends to be attenuated heavily, whilst light at the red end of the spectrum tends to be attenuated least.

**[0222]** Scattering processes can be more complex, and can have various “regimes” which must be considered. The first aspect of scattering is based on the size of the scattering centre compared with the wavelength of incident light. If the scattering center is much smaller than the wavelength of

light, then Rayleigh scattering can be assumed. If the scattering center is on the order of the wavelength of light, then a more detailed Mie scattering formulation must be considered. Another factor involved in scattering light is the distance between input and output of the scattering media. If the mean free path of the light (the distance between scattering events) is much larger than the distance travelled, then ballistic photon transport is assumed. In the case of tissue, scattering events are approximately 100 microns apart – so a 1mm path distance would effectively randomise the photon direction and the system would enter a diffusive regime.

**[0223]** Ultra bright light emitting diodes (LEDs), an RGB sensor, and polyester optical filters can be used as components of the optical sensors to measure through tissue color differentiation. For example, because surface color can be measured from reflected light, a color can be measured from light which has passed through the tissue first for a given geometry. This can include color sensing from diffuse scattered light, from an LED in contact with the skin. In some embodiments, an LED can be used with an RGB sensor nearby to detect the light which has diffused through the tissue. The optical sensors can image with diffuse internal light or surface reflected light.

**[0224]** Additionally, the optical sensors can be used to measure autofluorescence. Autofluorescence is used because the tissue is absorbing light at one wavelength, and emitting at another. Additionally, dead tissue may not auto-fluoresce and so this could be a very strong indication as to if the tissue is healthy or not. Due to blue light (or even UV light) having such a short penetration depth, it may be very useful for example to have a UV light with a red sensitive photodiode nearby (or some other wavelength shifted band) to act as a binary test for healthy tissue, which would auto-fluoresce at a very particular wavelength.

**[0225]** Conductivity sensors can be used to determine the difference between living and dead tissue or to show a change in impedance due to a wound being opened up in morbid tissue. Conductivity sensors can include Ag/AgCl electrodes and an impedance analyser. The conductivity sensors can be used to measure the change of impedance of a region of wound growth by

measuring the impedance of the surrounding tissue/area. In some embodiments, the sensor array can utilize conductivity sensors to measure the change in conductivity on perimeter electrodes due to a wound size or wound shape change. In some embodiments, the conductivity sensors can be used in the wound bed or on the perimeter of the wound.

**[0226]** In some embodiments, pH changing pads can be used as a pH sensor. A spectrometer and a broadband white light source can be used to measure the spectral response of the pH dye. The illumination and imaging can be provided on the surface of the wound dressing that is in contact with the wound and at the same side as the fluid application, the bottom surface. Alternatively, in some embodiments, the illumination and imaging source can be provided on the surface of the wound dressing opposite the bottom surface and away from fluid application or the top surface of the dressing.

**[0227]** In some embodiments, pulse oximetry SpO<sub>2</sub> sensors can be used. To measure how oxygenated the blood is and the pulsatile blood flow can be observed. Pulse oximetry measurements work by taking a time resolved measurement of light absorption / transmission in tissue at two different optical wavelengths. When hemoglobin becomes oxygenated, its absorption spectrum changes with regards to non-oxygenated blood. By taking a measurement at two different wavelengths, one gains a ratio metric measure of how oxygenated the blood is.

**[0228]** The components in the sensor array can be connected through multiple connections. In some embodiments, the thermistors can be arranged in groups of five. Each thermistor is nominally 10k $\Omega$ , and each group of five has a common ground. There are five groups of thermistors, giving a total of 30 connections. In some embodiments, there can be nine conductivity terminals. Each conductivity terminal requires one connection, giving a total of 9 connections. In some embodiments, there can be five SpO<sub>2</sub> sensors. Each SpO<sub>2</sub> sensor requires three connections, plus power and ground (these are covered separately), giving a total of 15 connections. In some embodiments, there can be 10 color sensors. Each color sensor comprises an RGB LED and an RGB photodiode. Each color sensor requires six connections, however five of

these are common to every sensor, giving a total of 15 connections. Power and ground are considered separately. In some embodiments, there can be 5 pH sensors. The pH sensors can be a color-change discs, and can be sensed using the color sensors described above. Therefore, the pH sensors require no additional connections. There can be three power rails, and seven ground return signals, giving a total of 10 common connections. In some embodiments, the sensor array can include 25 thermistor (Murata NCP15WB473E03RC), 9 conductivity terminal, 5 SpO2 (ADPD144RI), 10 RGB LED (such as KPTF-1616RGBC-13), 10 RGB Color Sensor, 10 FET, a printed circuit board (PCB), and an assembly.

**[0229]** A control module can be used to interface with the sensor array. In some embodiments, the control module can contain a power source, such as batteries, and electronics to drive the sensors. The control module can also log data at appropriate intervals and allow data transfer to an external computing device, such as a personal computer (PC). The control module can be customized to have various features depending on the sensors used in the sensor array and the data collected by the sensors. In some embodiments, the control module can be comfortable enough and small enough to be worn continuously for several weeks. In some embodiments, the control module can be positioned near the wound dressing or on the wound dressing. In some embodiments, the control module can be positioned in a remote location from the wound dressing and accompanying sensor array. The control module can communicate with the sensor array and wound dressing through electrical wires or through wireless communication whether positioned on the dressing, near the dressing, or remote from the wound dressing. In some embodiments, the control module can be adapted to be utilized with different sensor arrays and can enable easy replacement of the sensor array.

**[0230]** In some embodiments, the control module can include various requirements and combination of features including but not limited to the features listed in Table 1 below.

TABLE 1. OPTIONAL FEATURES FOR CONTROL MODULE

7 day operation from a single set of batteries
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28 day local, non-volatile, storage capacity
Easy to charge, or to replace battery
Wireless link to PC / tablet (such as Bluetooth)
Wired link to PC (optional, micro-USB)
Drive electronics for thermistors
Drive electronics for conductivity sensors
Drive electronics for optical sensors
Drive electronics for SpO2 sensors
Power management
Real Time Clock (RTC) to allow accurate data logging, and correlation with other measurands
Ability to change sample rates and intervals (useful for SpO2) for each sensor
Indication of status via LED, such as (Green : Awake; Flashing green : Charging; Blue : Wireless link established; Flashing blue : Wireless data transfer; Yellow : Wired link established; Flashing yellow : Wired data transfer; Red : Battery low; Flashing red : Battery very low

**[0231]** FIG. 3E illustrates a block diagram 330 of a control module according to some embodiments. The block diagram of the control module includes a conductivity driver box 391 displaying features of the conductivity driver. Box 392 shows the features of the thermistor interface and box 393 shows the features of the optical interface. The control module can include a controller or microprocessor with features similar to those shown in box 394. Real time clock (RTC), Status LEDs, USB connector, Serial Flash, and Debug Connector can be included as features of the control module as shown in FIG. 3E.

**[0232]** In some embodiments, the microprocessor can have one or more of the following features: 2.4GHz or another suitable frequency radio (either integrated, or external); Supplied Bluetooth software stack; SPI interface; USB (or UART for external USB driver); I2C; 3 channel PWM; 32 GPIO; or 6-channel ADC. In some embodiments, the device can require at least 48 I/O pins or possibly more due to banking limitations. Bluetooth stack typically requires

~20kB on-board Flash, so a minimum of 32kB can be required. In some embodiment, 64kB can be required if complex data processing is considered. The processor core can be ARM Cortex M4 or a similar processor core. In some embodiments, the parts can include ST's STM32L433LC or STM32F302R8, which would require an external radio, or NXP's Kinetis KW range including integrated radio.

**[0233]** In some embodiment, the control module can include a memory component where the amount of local storage depends on the sample rate and resolution of the sensors. For example, an estimated data requirement of 256Mb (32MB) can be met by using a serial Flash device from a number of manufacturers (Micron, Spansion).

**[0234]** The control module can utilize one or more analogue switches. In some embodiments, analogue switches with good on resistance and reasonable bandwidth can be used. For example, Analog Devices' ADG72 or NXP's NX3L4051HR can be used. Based on the initial system architecture, 8 of these will be required.

**[0235]** The control module can incorporate a power source, such as a battery. For example a 300mWh/day battery can be used. For 7 days this is 2100mWh. This could be provided by: a 10 days, non-rechargeable, ER14250 (14.5mm diameter x 25mm) LiSOCl<sub>2</sub> cell; or a 7 days, rechargeable, Li 14500 (14.5mm diameter x 50mm) Li-Ion.

**[0236]** The control module can incorporate a real time clock (RTC). The RTC can be chosen from any RTC devices with crystal. The control module can also include miscellaneous resistors, capacitors, connectors, charge controllers, and other power supplies.

**[0237]** The PCB of the control module can be a 4-layer board, approximately 50mm x 20mm, or 25mm x 40mm. The type of PCB used can be largely driven by connection requirements to sensor array.

**[0238]** The enclosure of the control module can be a two part moulding, with clip features to allow easy access for changing sensor arrays or batteries.

**[0239]** The data collected through the sensor array can be passed through the control module and processed by host software. The software may

be executed on a processing device. The processing device can be a PC, tablet, smartphone, or other computer capable of running host software. The processing device executing the software can be in communication with the control module through electrical wires or through wireless communication. In some embodiments, the software may be configured to provide access to the data held on the control module, but not to perform big-data analysis. The host software can include an interface to the control module via Bluetooth or USB. In some embodiments, the host software can read the status of control module, download logged data from control module, upload sample rate control to control module, convert data from control module into format suitable for processing by big-data analysis engine, or upload data to cloud for processing by analysis engine.

**[0240]** The software may be developed for PC (Windows / Linux), tablet or smartphone (Android / iOS), or for multiple platforms.

**[0241]** In some embodiments, a source of negative pressure (such as a pump) and some or all other components of the topical negative pressure system, such as power source(s), sensor(s), connector(s), user interface component(s) (such as button(s), switch(es), speaker(s), screen(s), etc.) and the like, can be integral with the wound dressing. In some embodiments, the components can be integrated below, within, on top of, or adjacent to the backing layer. In some embodiments, the wound dressing can include a second cover layer or a second filter layer for positioning over the layers of the wound dressing and any of the integrated components. The second cover layer can be the upper most layer of the dressing or can be a separate envelope that enclosed the integrated components of the topical negative pressure system.

**[0242]** As used herein the upper layer, top layer, or layer above refers to a layer furthest from the surface of the skin or wound while the dressing is in use and positioned over the wound. Accordingly, the lower surface, lower layer, bottom layer, or layer below refers to the layer that is closest to the surface of the skin or wound while the dressing is in use and positioned over the wound.

#### Component Positioning and/or Stress Relief

**[0243]** In some embodiments, electrical or electronic components, such as sensors, connections, or the like, can be placed or positioned on or embedded in one or more wound dressing components, which can be placed in or on the wound, skin, or both the wound and the skin. For example, one or more electronic components can be positioned on a wound contact layer side that faces the wound, such as the lower surface 224 of the wound contact layer 222 in FIG. 1B. As another example, one or more electronic components can be positioned on a wound contact layer side that faces away from the wound, such as the upper surface 223 of the wound contact layer 222 in FIG. 1B. The wound contact layer can be flexible, elastic, or stretchable or substantially flexible, elastic, or stretchable in order to conform to or cover the wound. For example, the wound contact layer can be made from a stretchable or substantially stretchable material, such as one or more of polyurethane, thermoplastic polyurethane (TPU), silicone, polycarbonate, polyethylene, polyimide, polyamide, polyester, polyethelene tetraphthalate (PET), polybutalene tetreaphthalate (PBT), polyethylene naphthalate (PEN), polyetherimide (PEI), along with various fluropolymers (FEP) and copolymers, or another suitable material. In some instances, one or more electronic components can be alternatively or additionally placed or positioned on or embedded in any one or more of a transmission layer, absorbent layer, backing layer, or any other suitable layer of the wound dressing.

**[0244]** In some implementations, while it may be desirable for the wound contact layer to be stretchable to better conform to or cover the wound, at least some of the electronic components may not be stretchable or flexible. In such instances, undesirable or excessive localized strain or stress may be exerted on the one or more electronic components, such as on the supporting area or mountings of an electronic component, when the wound is dressed with the wound dressing and the wound contact layer is positioned in or over the wound. For example, such stress can be due to patient movement, changes in the shape or size of the wound (such as, due to its healing), or the like. Such stress may cause movement, dislodgment, or malfunction of the one or more electronic components (for example, creation of an open circuit from a pin or another connector becoming disconnected). Alternatively or additionally, it may

be desirable to maintain the position of one or more electronic components, such as one or more sensors, in the same or substantially same location or region on the wound contact layer with respect to the wound (such as, in contact with the wound) so that measurements collected by the one or more electronic components accurately capture changes over time in the same or substantially same location or region of the wound. While the surface of the stretchable wound contact layer may move when, for example, the patient moves, it may be desirable to have the one or more electronic components be located in the same location or region with respect to the wound.

**[0245]** As described herein, in some embodiments, one or more stiff, rigid, or non-stretchable or substantially stiff, rigid, or non-stretchable regions, such as one or more regions of non-stretchable or substantially non-stretchable material, can be mounted, positioned, or placed on the wound contact layer (or another suitable wound dressing component) for supporting one or more electronic components. Mounting, positioning, or placing one or more electronic components in the one or more non-stretchable or substantially non-stretchable regions can prevent formation of localized stress or assist with maintenance of the position of the one or more electronic components with respect to the wound. In some instances, one or more electronic components can be alternatively or additionally be flexible, such as mounted or printed on or supported by one or more flexible materials. For example, flexible plastic sheets or substrates, such as polyimide, polyether ether ketone (PEEK), polyester, silicone, or the like, can be used.

**[0246]** FIGS. 4A-4F illustrate a wound dressing 400 with a plurality of electronic components according to some embodiments. As is shown, a sheet or substrate 430 is configured to support one or more electronic components, including an electronic component or module 402 with a plurality of connectors 404 and a plurality of electronic connections 410, and non-stretchable or substantially non-stretchable regions 422 and 424. The substrate 430 can be a stretchable or substantially stretchable wound contact layer as described herein. The electronic module 402 can be any electronic component described herein, such as a sensor, light source (such as an LED, temperature sensor, optical

sensor, etc.), controller or processor (such as a communication processor), or the like. Electronic connections 410 can be tracks printed on the substrate 430, such as using conductive copper, conductive ink (such as silver ink, silver/silver chloride ink, copper ink, graphite ink, carbon ink, dielectric ink, etc.), or the like. At least some of the electronic connections 410 can be flexible or stretchable or substantially flexible or stretchable. One or more connectors 404 can be configured to electronically connect the electronic module 402 to the electronic connections 410 (as illustrated in FIG. 4B), which in turn can be connected to other electronic modules (not shown) positioned on the substrate 430, on or in other components of the wound dressing, or external to the wound dressing. Connectors 404 can be pins, leads, bumps, pads, or the like. Additionally or alternatively a socket can be used to support and electronically connect the electronic module 402.

**[0247]** The electronic module 402 can be held in place on the substrate 430 via the one or more connectors 404. For example, the connectors 404 can be soldered or otherwise electrically connected to the electronic connections 410. Such arrangement can carry the risk of the electronic module 402 becoming dislodged in use when the wound dressing is positioned in the wound. Dislodgment of the electronic module 402 and it falling into the wound (such as the wound cavity) would be detrimental to patient safety particularly because the electronic module 402 may be quite small. In some embodiments, adhesive 406 can be applied to securely affix or attach the electronic module 402 to the substrate 430. As illustrated in FIG. 4A, the adhesive 406 can securely affix or attach the electronic module 402 to a region 422. Adhesive 406 can provide mechanical reinforcement additionally to the reinforcement provided by the one or more connectors 404. Adhesive 406 can be epoxy or any other suitable glue. Adhesive 406 can be thermally curable or curable by any other suitable means.

**[0248]** For example, the substrate 430 can include a flexible circuit board as described herein. Prior to soldering the connectors 404, the electronic module 402 can be affixed to the circuit board using adhesive 406, such as heat curable epoxy. The adhesive 406 can be cured prior or at the same time as the soldering. For instance, if wave soldering is used, the adhesive 406 can be cured

as a result of heat produced by wave soldering. In some cases, the flexible circuit board can be a dual layer circuit board, and additional electronic modules can be similarly affixed to the other side of the circuit board. In some embodiments, conductive adhesive can be used instead of or in addition to the connectors 404.

**[0249]** Additional electronic components can be similarly attached or affixed. In certain embodiments, one or more electronic tracks 410 can also be similarly attached or affixed using adhesive. In some implementations, one or more electronic components or tracks positioned on the side of the wound dressing 400 facing away from the wound can be similarly attached or affixed using adhesive.

**[0250]** In some cases, using adhesive to affix one or more electronic components or connectors as described herein can help to prevent electrostatic discharge (ESD) from damaging the electronics of the wound dressing 400. ESD may be caused by, for example, electric defibrillation and can be manifested as arching between conductive elements of the wound dressing 400. Adhesive may conduct charge away from the electronic components (for example, to a ground plane) to prevent damage to the electronics.

**[0251]** Referring to FIG. 4A, regions 422 and 424 can include non-stretchable or substantially non-stretchable material, such as one or more of suitable adhesive, epoxy, polyester, polyimide, polyamide, PET, PBT, or another type of material with a high Young's modulus. One or more of the regions 422 and 424 can be printed on the substrate 430. As is used herein, printing material on a substrate can include one or more of laminating, adhering, or any other suitable technique. In some implementations, a flexible circuit board can be positioned on the region 422.

**[0252]** FIG. 4B illustrates components (illustrated in FIG. 4A) positioned on the substrate 430. As shown, the electronic module 402 is mounted to or supported by the region 422. A portion or part of the electronic connections 410 is mounted to or supported by the region 424. Also illustrated are slits, holes, or perforations formed in the substrate 430 according to some embodiments. As described herein, the substrate 430 can be perforated using one or more of a

cold pin perforation, hot pin perforation, laser ablation perforation, ultrasonic or ultrasound perforation, or the like to make the wound contact layer permeable to liquid and gas. In some implementations, one or more utilized perforation processes can generate either a flat or substantially substrate around the hole or an uneven surface (such as donut-shaped surface). Having a flat or substantially flat substrate can assist in generating a homogenous layer when conformal coating is applied (such as, via spray, brush, extrusion dye, or the like as described herein). Further, using a perforation process that leaves the surface of the substrate uneven or substantially uneven can introduce a greater risk of dislodging one or more components, such as the electronic connections 410 or the electronic module 402 when perforations are made around the components.

**[0253]** In certain implementations, perforations are made or patterned around one or more components placed on the substrate 430, such as the electronic connections 410, the electronic module 402, or the regions 422 or 424. As explained herein, component indexing can be used to automatically locate position of the one or more components on the substrate 430 so that the one or more components are not damaged by perforations. In some embodiments, the substrate can be perforated before one or more components illustrated in FIG. 4A as placed on the substrate.

**[0254]** FIGS. 4C and 4F illustrate optional application of one or more of coating 440 or one or more adhesive regions 452, 454, 456 according to some embodiments. FIG. 4C illustrates wound dressing 400 with one or more electronic modules positioned on the side of the substrate 430 facing the wound. FIG. 4F illustrates wound dressing 400 with one or more electronic modules positioned on the side of the substrate 430 facing away from the wound. Coating 440 can be conformal coating configured to encapsulate or coat one or more of the substrate 430 or components supported by the substrate, such as the electronic connections 410 or the electronic module 402. Coating 440 can provide biocompatibility, shield or protect the electronics from coming into contact with fluids, or the like. Coating 440 can be one or more of a suitable polymer, adhesive, such as 1165 or 1072-M UV, light, or thermal curable or cured adhesive, Optimax adhesive (such as, NovaChem Optimax 8002-LV), parylene



(such as, Parylene C), silicon, epoxy, urethane, acrylated urethane, or another suitable biocompatible and stretchable material. Coating 440 can be thin, such as about 100 microns thick, less than about 100 microns thick, or more than about 100 microns thick. Coating 440 can be applied and cured using one or more of UV, light, or thermal curing. In some implementations, coating 440 can be applied on the other side of the substrate 430 (or side facing away from the wound) to the components particularly if the substrate is not impermeable to fluid. In certain implementations, coating 440 can be applied on the other side of the substrate 430 (or the wound facing side) particularly if the substrate is not impermeable to fluid. In some embodiments, coating is optional.

**[0255]** One or more adhesive pads, tracks, or regions 452, 454, 456 can be applied to the wound facing side of the substrate 430 or the wound facing side of the coating 440 as illustrated in FIG. 4C and 4F. With reference to FIG. 4C, in some embodiments, first adhesive region 452 can be shaped, sized, or positioned to affix the electronic module 402 in contact with or relative to a first specific or particular part of the wound, such as a first specific or particular area, region, or location in contact with or relative to the wound. Adhesive region 452 can be shaped and sized similarly to the region 422 or the electronic module 402 to affix the module to a particular location in the wound. With reference to FIG. 4F, adhesive region 452 can be shaped and sized similarly to the region 422 or the electronic module 402, but the region 452 can be positioned to overly the region 422 or the electronic module 402 on the opposite, wound facing side of the wound contact layer to affix or position the module to a particular location in the wound. Similarly, second adhesive region 454 can be shaped, sized, or positioned to affix the portion or part of the electronic connections 410 supported by the region 424 relative to a second specific or particular part of the wound, such as a second specific or particular area, region, or location in contact with or relative to the wound. Another (third) region of adhesive 456 is illustrated which can affix another part of the wound contact layer to another (third) specific or particular part of the wound, such as another (third) specific or particular area, region, or location in contact with or relative to the wound. Adhesive material can be one or more of silicone, such as two-part silicone, one-part silicone, gel,

epoxy, acrylic-based material, or another suitable material. Adhesive can be applied and cured using one or more of UV, light, or thermal curing. For example, adhesive can be printed, sprayed, coated, or the like and then cured by UV, light, thermal curing, catalytic, water vapor, or the like. In some embodiments, adhesive is optional.

**[0256]** In some embodiments, one or more adhesive regions can be patterned to position or affix specific components in particular areas, regions, or locations in contact with or relative to the wound even while the substrate 430 is under stress or strain. While the substrate may strain between the adhesive regions, the electronic module 402, such as a sensor, will remain in the same location in contact with or relative to the wound (due to the adhesive region 452), thus maintaining the most repeatable signal, and the portion or the part of the electronic connections 410 will remain in the same location in contact with or relative to the wound such that it will not be dragged across the wound (due to the adhesive region 454) when the substrate 430 undergoes strain. Additionally, the supporting area or mountings of the electronic module 402 will not be put under as much stress because the body (for instance, the skin, which may strain about 20%) will relieve some of the stress (for example, due to the attachment of the wound contact layer to the wound by the one or more adhesive regions) and the substrate will yield around the electronic module. Similar stress relief can be provided to the portion of the electronic connection 410 which is overlaid by the adhesive region 454. This can prevent malfunction of the one or more electronic components.

**[0257]** In certain embodiments, pattern of the adhesive regions can be based on the positioning of the one or more electronic components, which can be determined using indexing as described herein. As explained herein, it may be desirable to pattern the adhesive to equalize the stress or strain on the wound contact layer. Adhesive can be patterned to strengthen or support certain areas or regions, such as regions where one or more electronic components are placed, while weakening (or making less rigid) other regions to distribute the stress or to avoid straining the one or more electrical components. For example, it may be desirable to cover at least 50% or more of the wound facing surface of

the wound contact layer with the adhesive. In certain implementations, adhesive can be applied to cover or substantially cover the entire wound facing side of the wound contact layer.

**[0258]** In some embodiments, adhesive material used to form the one or more adhesive regions can be non-stretchable or substantially non-stretchable. One or more regions of the non-stretchable or substantially non-stretchable material, such as regions 422 and 424, may not be used or may be sized or shaped differently from one or more adhesive regions.

**[0259]** In some implementations, any or all of the one or more adhesive regions can be positioned on the coating 440, between the coating 440 and the substrate 430, between the one or more modules 402 and the substrate 430 (such as to affix the one or more modules to the substrate), or between the one or more modules 402 and the coating 440.

**[0260]** FIGS. 4D-4E illustrate attachment of one or more electronic modules 402 to the substrate 430 according to some embodiments. FIG. 4D illustrates various components before attachment to the substrate 430, and FIG. 4E illustrates various components after attachment to the substrate 430. As shown, one or more regions 470 can be included or formed on the substrate 430. For example, the region 470 can be formed approximately at the center of a region where an electronic module 402 is intended to be positioned on the substrate 430. The electronic module 402 can then be securely mounted on or supported by the region 470. The region 470 can be formed from adhesive material, such one or more of silicone (for example, two-part silicone, one-part silicone, etc.), gel, epoxy, acrylic-based material, or another suitable material. Adhesive can be applied and cured using one or more of UV, light, or thermal curing. For example, adhesive can be printed, sprayed, coated, or the like and then cured by UV, light, thermal curing, catalytic, water vapor, or the like.

**[0261]** In some implementations, the region 470 is formed from epoxy that is thermally curable, and which is cured (for example, in a reflow oven) when solder (illustrated as 480 in FIG. 4E) is melted to connect the connectors 404 of the electronic module to connectors 480 positioned on the substrate 430.

Connectors 480 are configured to provide electrical connection to the one or more electronic connections 410.

**[0262]** In certain implementations, one or more regions 470 provide thermally conductive pathways from the one or more electronic modules 402 to the substrate 430 in order to dissipate heat produced by the one or more electronic modules. The one or more regions 470 can additionally or alternatively function as an electrical isolator. The one or more regions 470 can ensure that the one or more electronic modules 402 are mounted correctly and securely before, as described herein, addition of the coating 440. In some cases, while the coating 440 can be designed to flow under the one or more electronic modules 402 prior to being cured, including the one or more regions 470 on the substrate 430 can reduce the distance that the coating 440 needs to flow and can minimize the chance of air bubbles being left under the one or more electronic modules 402.

**[0263]** In some embodiments, one or more regions 470 can be similarly used to attach or position portions or entireties of one or more electronic connections 410 on the substrate 403. In some cases, one or more regions 470 can function similarly and provide similar advantages as the adhesive region 406 illustrated in FIG. 4A and described herein.

**[0264]** Although a single electronic module 402 and region 470 is illustrated in FIGS. 4A-4E, in certain implementations, a plurality of electronic modules and regions can be used. One or more of the additional electronic modules or one or more electronic connections 410 interconnecting the electronic module 402 and the additional electronic modules can be placed on one or more additional non-stretchable or substantially non-stretchable regions. Additionally or alternatively, adhesive regions can be placed to further affix the one or more electronic modules or electronic connections in contact with or relative to the wound as described herein.

**[0265]** FIG. 5A illustrates a wound dressing 500A with a plurality of components according to some embodiments. As shown, the wound dressing 500A includes the electronic module 402 and electronic connections 410. Instead of or in addition to including the region 422 to support the module 402, a

non-stretchable or substantially non-stretchable region 550 can be formed around the periphery of the module 402 to enclose or substantially enclose the module 402. Region 550 can be formed from the same or different material as regions 422 or 424. Region 550 can absorb or sustain strain rather than exposing the module 402 to the strain. In some implementations, region 550 can be configured to form a shape that tessellates or substantially tessellates (for example, is a single shape without or substantially gaps or overlapping portions). This can aid in distributing the strain on or across the region 550 while reducing the strain on one or more electronic components. For example, for a particular global strain applied to the dressing, local strains will vary above the global strain value (on or across the region 550) and below the global strain value (on or across one or more electronic components).

**[0266]** FIG. 5B illustrates a sectional view of the wound dressing 500A along the line A-A when strain or stress is applied to the dressing. As shown, if region 550 is separated from the module 402 by a distance  $d$ , the substrate 430 may be able to strain and move the module 402 in the  $z$ -plane (for example, downward and away from the wound as illustrated by an arrow 560) to minimize pressure exerted by the module 402 on the wound or the skin. The module 402 can be pushed away from the wound, but may still maintain contact with or touch the wound or the skin. This can prevent or limit patient discomfort from the module 402 digging into the wound when the substrate 430 undergoes strain, while maintaining the desired positioning of the module 402 in the wound.

**[0267]** In some instances, the region 550 may not fully enclose the module 402, such as leave one or more sides of the module not enclosed. In certain cases, distance  $d$  separating the region 550 from the module 402 may vary around the periphery of the module 402. In certain cases, one or more other regions such as the region 550 can be used. For example, another region can be utilized to enclose or substantially enclose the part of the electronic connections 410 that is supported by the region 424. Such another region can be used additionally or instead of the region 424.

**[0268]** In some implementations, rather than using straight line electronic connections 410, the connections in the form of concertina can be

used. This may allow a larger global strain of the substrate for a smaller local strain of an individual connection track with the trade-off that, for example, the track will occupy a greater proportion of the substrate. In some cases, one or more thinner tracks may be used as strain gauges to identify strain between intentionally fixed (for example, by adhesive) hard points.

**[0269]** In certain embodiments, one or more strain gauges (which may be tracks or separate strain gauges) can be used to identify whether the wound dressing has been removed or one or more regions of the adhesive, such as regions 452, 454, or 456 failed (for example, became dislodged). For example, a loss of the expected movement and corresponding strain may identify removal or de-bonding of one or more adhesive regions. Measured strain can be compared to one or more thresholds that respectively correspond to removal of the dressing (for example, indicating little or no strain on the entire dressing), dislodgment of one or more adhesive regions (for example, indicating little or no strain on a particular region which has been dislodged), or the like.

**[0270]** In some embodiments, semi-elastic conductive adhesive, such as epoxy with silver particles, anisotropic adhesive, or another suitable adhesive, can be used to mount one or more electronic components on the substrate 430. This can allow some lateral flexibility to the mounting when stress is applied to the wound dressing. In some cases, such mounting can be used in addition to or instead of a mounting on a non-stretchable or substantially non-stretchable region as described herein.

**[0271]** FIGS. 5C-5D illustrate a wound dressing 500B that is similar to the dressing illustrated in FIGS. 5A-5B, but that includes one or more electronic components on the side of the substrate 430 facing away from a wound. As is illustrated in FIG. 5D, if region 550 is separated from the module 402 by a distance  $d$ , the substrate 430 may be able to strain and move the module 402 in the  $z$ -plane (for example, upward and away from the wound as illustrated by an arrow 560) to minimize pressure exerted by the module 402 on the wound or the skin. The module 402 can be pushed away from the wound

**[0272]** FIG. 6A illustrates a process 600A for manufacturing or making wound dressing, such as the wound dressing 400 or 500A, according to some

embodiments. Although a single region of wound contact layer associated with a single dressing is shown, the process 600A can be used to manufacture a plurality of wound contact layers for a plurality of dressings in parallel or substantially in parallel (see FIG. 8). Process 600A can be performed by an assembly or manufacturing machine.

**[0273]** Process 600A can begin in step or block 602, in which a substrate is provided. The substrate can be made out of elastomer (for example, TPU). In block 604, one or more non-stretchable or substantially non-stretchable regions can be placed or positioned on the substrate. Such one or more regions can be printed on the substrate to provide stress or strain relief for one or more components. In block 606, one or more conductive electronic connections can be positioned or placed on the substrate (for example, one or more tracks can be printed with conductive ink). In block 608, one or more electronic components can be mounted or positioned on the substrate. The one or more electronic components or connections can be securely affixed to the substrate using adhesive as described herein. As illustrated, an electronic module can be mounted or positioned on a non-stretchable or substantially non-stretchable region.

**[0274]** In block 610, perforations can be made in the substrate, which can be performed using indexing as described herein. In block 612, coating can optionally be applied to the one or more electronic components (such as modules or connections) or other regions of the substrate. The coating can be conformal coating. For example, the coating can be urethane coating that is applied and cured using one or more of UV, light, or thermal curing. In certain implementations, perforating the substrate prior to applying conformal coating allows the conformal coating (which can be about 100 microns thick) to flow through one or more the perforated holes and bond to the substrate inside (for example, during curing of the conformal coating). This can reduce or minimize the possibility of coating or encapsulation failure.

**[0275]** In block 614, one or more regions of adhesive are optionally applied, which can be performed using indexing as described herein. For example, adhesive can be silicone and can be applied and cured using one or

more of UV, light, or thermal curing. In block 616, the wound contact layer for an individual dressing (for example, a system) can be cut or separated from a sheet or web of wound contact layer that includes wound contact layer for a plurality of other dressings. Such cutting can be performed using indexing as described herein.

**[0276]** FIG. 6B illustrates a process 600B for manufacturing or making wound dressing, such as the wound dressing 400 or 500B, according to some embodiments. Process 600B differs from the process 600A in that in block 614 adhesive is applied to wound facing side of the substrate, which is opposite from the side of the substrate that supports the one or more electronic components.

**[0277]** FIG. 7A illustrates a process 700A for manufacturing or making wound dressing, such as the wound dressing 400 or 500A, according to some embodiments. Although a single region of wound contact layer associated with a single dressing is shown, the process 700A can be used to manufacture a plurality of wound contact layers for a plurality of dressings in parallel or substantially in parallel (see FIG. 8). Process 700A can be performed by an assembly or manufacturing machine.

**[0278]** Process 700A can begin in step or block 702, in which a substrate is provided. The substrate can be made out of elastomer (for example, TPU). In block 704, one or more non-stretchable or substantially non-stretchable regions can be placed or positioned on the substrate. Such one or more regions can be printed on the substrate to provide stress or strain relief for one or more components. In block 706, one or more conductive electronic connections can be positioned or placed on the substrate (for example, one or more tracks can be printed with conductive ink). In block 708, one or more electronic components can be mounted or positioned on the substrate. The one or more electronic components or connections can be affixed to the substrate using adhesive as described herein. As illustrated, an electronic module can be mounted or positioned on a non-stretchable or substantially non-stretchable region.

**[0279]** In block 710, coating can optionally be applied to the one or more electronic components (such as modules or connections) or other regions of the substrate. The coating can be conformal coating. For example, the



coating can be urethane coating. In block 712, one or more regions of adhesive are optionally applied, which can be performed using indexing as described herein. For example, adhesive can be silicone. In block 714, curing can be performed to bond, strengthen, or harden one or more of the coating or the adhesive. For example, one or more of UV, light, or thermal curing can be performed.

**[0280]** In block 716, perforations can be made in the substrate, which can be performed using indexing as described herein. Perforations can be made through adhesive where applicable (for example, where the adhesive does not overly one or more electronic components). In some cases, perforating the substrate after applying conformal coating can cause separation or delamination of the coating from the substrate. For example, using hot pin perforation may cause delamination. This can be prevented by making oversized holes (such as, by over-boring during hot pin perforation) to account for the reduction in diameter of one or more holes caused by the conformal coating being in the one or more holes or by using another perforation technique, such as ultrasonic or laser perforation, that does not cause delamination. In such embodiments or in any other embodiments described herein, adhesive coating can be patterned around the individual perforations.

**[0281]** In certain implementations, applying adhesive before perforating can result in the adhesive being coated over the position of the perforations, which can increase the adhesive area and ease the positional requirements of the one or more electronic components in contact with or relative to the wound. In some cases, an intermediate or sacrificial layer may be used above an ultrasonic transducer or sonotrode when ultrasonic perforation is utilized. Such sacrificial layer (which can be PET or another suitable material) could be fused to the removed substrate during the perforation so when peeled off, all the removed substrate would come with the sacrificial layer. First sacrificial layer can be placed between the ultrasonic transducer and the wound contact layer, and second sacrificial layer can be placed between the wound contact layer and an anvil. Additionally or alternatively, the substrate and conformal coating could be

bonded or cauterized together by the ultrasonic or laser pulse when ultrasonic or laser perforation is used.

**[0282]** Also, in block 716, the wound contact layer for an individual dressing (for example, a system) can be cut or separated from a sheet or web of wound contact layer that includes wound contact layer for a plurality of other dressings. Such cutting can be performed using indexing as described herein.

**[0283]** FIG. 7B illustrates a process 700B for manufacturing or making wound dressing, such as the wound dressing 400 or 500B, according to some embodiments. Process 700B differs from the process 700A in that in block 712 adhesive is applied to wound facing side of the substrate, which is opposite from the side of the substrate that supports the one or more electronic components.

**[0284]** In some embodiments, such as in the processes 600A, 600B, 700A, or 700B, handling of the web of wound contact layer can be performed using one or more of a bed, soft rollers, a sacrificial, reciprocal, or recirculating soft layer laid as a release liner over the side of the substrate facing the wound or facing away from the wound, side mount and slide, or rollers with sections removed to line up with the components (for example, one or more electronic connections, but not electronic modules will take roller contact). Alternatively or additionally, a side-handling bar could be used to ensure that the web holding these devices is always run on rollers on the substrate side facing the wound or facing away from the wound while still maintaining tension.

**[0285]** FIG. 8 illustrates indexing according to some embodiments. A plurality of wound dressings 800, such as the dressing 400, 500A, or 500B, are shown on a wound contact layer sheet. Vertical and horizontal cut lines 810 separate individual wound contact layers or platforms associated with individual wound dressings. The sheet can be moved or fed through an assembly or manufacturing machine that manufactures wound dressings in the direction indicated by the arrow 840 (or in the opposite direction). The machine can make cuts along the cut lines 810 to separate the dressings 800 as the sheet is fed through the machine.

**[0286]** In some implementations, identification of the position or one or more electronic components, such as one or more electronic modules or

connections, can be automatically performed using indexing. Indexing can be performed by the manufacturing machine, such as by one or more processors or controllers of the manufacturing machine. For example, a plurality of electronic connections, such as connections 820, can be identified and used to determine the boundary of the wound dressing. The plurality of electronic connections 820 can be used to connect an electronic component external to the wound contact layer or the dressing, such as a controller (for example, via connector pad end portion 303 illustrated in FIG. 3). Alternatively or additionally, one or more RFID indicators 830, such as a chip or antenna, can be embedded in one or more of predetermined, particular, or known locations the sheet, and one or more positions of the one or more indicators can be identified by the machine. Conductive, optical, capacitive, or inductive measurements or methods of identifying the position of the plurality of the electronic connections 820. RFID reader can be used to determine the position of the RFID indicator(s). Using positioning information of the plurality of the electronic connections 820 or RFID indicator(s), locations of the individual wound dressings 800 and one or more electronic components on an individual wound dressing can be determined.

**[0287]** In some embodiments, positioning information can be used to perforate the substrate or apply one or more adhesive regions. For example, using positioning information, locations of one or more electronic components or connections can be determined, and perforations can be made around the one or more electronic components or connections as described herein. Additionally or alternatively, one or more adhesive regions can be applied in a pattern according to the locations of one or more electronic components or connections as described herein.

**[0288]** In certain implementations, patterned adhesive, such as silicone, can be laid down by a programmable patterned drum or robot. Two-part adhesive can be thermally cured. Alternatively or additionally, one-part adhesive can be applied to the entire or substantially entire wound facing side of the wound contact layer and one or more of UV, light, or thermal curing can be applied using a mask so that only locations of interest are cured to form one or more adhesive regions.

Other Variations

**[0289]** While certain embodiments are described from the perspective of one or more electronic modules and/or connections being positioned on the wound facing side of a wound contact layer, the techniques described herein are equally applicable to wound dressings and wound contact layers in which one or more electronic modules and/or connections are alternatively or additionally positioned on the opposite, non-wound facing side.

**[0290]** Any value of a threshold, limit, duration, etc. provided herein is not intended to be absolute and, thereby, can be approximate. In addition, any threshold, limit, duration, etc. provided herein can be fixed or varied either automatically or by a user. Furthermore, as is used herein relative terminology such as exceeds, greater than, less than, etc. in relation to a reference value is intended to also encompass being equal to the reference value. For example, exceeding a reference value that is positive can encompass being equal to or greater than the reference value. In addition, as is used herein relative terminology such as exceeds, greater than, less than, etc. in relation to a reference value is intended to also encompass an inverse of the disclosed relationship, such as below, less than, greater than, etc. in relations to the reference value. Moreover, although blocks of the various processes may be described in terms of determining whether a value meets or does not meet a particular threshold, the blocks can be similarly understood, for example, in terms of a value (i) being below or above a threshold or (ii) satisfying or not satisfying a threshold.

**[0291]** Features, materials, characteristics, or groups described in conjunction with a particular aspect, embodiment, or example are to be understood to be applicable to any other aspect, embodiment or example described herein unless incompatible therewith. All of the features disclosed in this specification (including any accompanying claims, abstract and drawings), or all of the steps of any method or process so disclosed, may be combined in any combination, except combinations where at least some of such features or steps are mutually exclusive. The protection is not restricted to the details of any

foregoing embodiments. The protection extends to any novel one, or any novel combination, of the features disclosed in this specification (including any accompanying claims, abstract and drawings), or to any novel one, or any novel combination, of the steps of any method or process so disclosed.

**[0292]** While certain embodiments have been described, these embodiments have been presented by way of example only, and are not intended to limit the scope of protection. Indeed, the novel methods and systems described herein may be embodied in a variety of other forms. Furthermore, various omissions, substitutions and changes in the form of the methods and systems described herein may be made. Those skilled in the art will appreciate that in some embodiments, the actual steps taken in the processes illustrated or disclosed may differ from those shown in the figures. Depending on the embodiment, certain of the steps described above may be removed, others may be added. For example, the actual steps or order of steps taken in the disclosed processes may differ from those shown in the figure. Depending on the embodiment, certain of the steps described above may be removed, others may be added. For instance, the various components illustrated in the figures may be implemented as software or firmware on a processor, controller, ASIC, FPGA, or dedicated hardware. Hardware components, such as controllers, processors, ASICs, FPGAs, and the like, can include logic circuitry. Furthermore, the features and attributes of the specific embodiments disclosed above may be combined in different ways to form additional embodiments, all of which fall within the scope of the present disclosure.

**[0293]** Although the present disclosure includes certain embodiments, examples and applications, it will be understood by those skilled in the art that the present disclosure extends beyond the specifically disclosed embodiments to other alternative embodiments or uses and obvious modifications and equivalents thereof, including embodiments which do not provide all of the features and advantages set forth herein. Accordingly, the scope of the present disclosure is not intended to be limited by the specific disclosures of preferred embodiments herein, and may be defined by claims as presented herein or as presented in the future.

**[0294]** Conditional language, such as “can,” “could,” “might,” or “may,” unless specifically stated otherwise, or otherwise understood within the context as used, is generally intended to convey that certain embodiments include, while other embodiments do not include, certain features, elements, or steps. Thus, such conditional language is not generally intended to imply that features, elements, or steps are in any way required for one or more embodiments or that one or more embodiments necessarily include logic for deciding, with or without user input or prompting, whether these features, elements, or steps are included or are to be performed in any particular embodiment. The terms “comprising,” “including,” “having,” and the like are synonymous and are used inclusively, in an open-ended fashion, and do not exclude additional elements, features, acts, operations, and so forth. Also, the term “or” is used in its inclusive sense (and not in its exclusive sense) so that when used, for example, to connect a list of elements, the term “or” means one, some, or all of the elements in the list. Further, the term “each,” as used herein, in addition to having its ordinary meaning, can mean any subset of a set of elements to which the term “each” is applied.

**[0295]** Conjunctive language such as the phrase “at least one of X, Y, and Z,” unless specifically stated otherwise, is otherwise understood with the context as used in general to convey that an item, term, etc. may be either X, Y, or Z. Thus, such conjunctive language is not generally intended to imply that certain embodiments require the presence of at least one of X, at least one of Y, and at least one of Z.

**[0296]** Language of degree used herein, such as the terms “approximately,” “about,” “generally,” and “substantially” as used herein represent a value, amount, or characteristic close to the stated value, amount, or characteristic that still performs a desired function or achieves a desired result. For example, the terms “approximately,” “about,” “generally,” and “substantially” may refer to an amount that is within less than 10% of, within less than 5% of, within less than 1% of, within less than 0.1% of, and within less than 0.01% of the stated amount. As another example, in certain embodiments, the terms “generally parallel” and “substantially parallel” refer to a value, amount, or

characteristic that departs from exactly parallel by less than or equal to 15 degrees, 10 degrees, 5 degrees, 3 degrees, 1 degree, or 0.1 degree.

**[0297]** The scope of the present disclosure is not intended to be limited by the specific disclosures of preferred embodiments in this section or elsewhere in this specification, and may be defined by claims as presented in this section or elsewhere in this specification or as presented in the future. The language of the claims is to be interpreted broadly based on the language employed in the claims and not limited to the examples described in the present specification or during the prosecution of the application, which examples are to be construed as non-exclusive.

**[0298]** In the claims which follow and in the preceding description of the invention, except where the context requires otherwise due to express language or necessary implication, the word “comprise” or variations such as “comprises” or “comprising” is used in an inclusive sense, i.e. to specify the presence of the stated features but not to preclude the presence or addition of further features in various embodiments of the invention.

**[0299]** It is to be understood that, if any prior art publication is referred to herein, such reference does not constitute an admission that the publication forms a part of the common general knowledge in the art, in Australia or any other country.

## CLAIMS

The claims defining the invention are as follows:

1. A wound monitoring and/or therapy apparatus comprising:
  - a wound dressing comprising a substantially stretchable substrate including a wound facing side and a non-wound facing side opposite the wound facing side, the wound facing side of the substrate supporting a plurality of electronic components and a plurality of electronic connections that connect at least some of the plurality of the electronic components,
  - a conformal coating covering at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections, and
  - a portion of the wound facing side of the substrate comprising a layer of material forming a first region that is substantially non-stretchable material and that encloses an entire perimeter of at least one electronic component from the plurality of electronic components, wherein the first region is protected from strain applied to the substrate.
2. The apparatus of claim 1, wherein the wound facing side of the substrate comprises a second region of substantially non-stretchable material that supports at least one of the at least one electronic component or at least one electronic connection from the plurality of electronic connections.
3. The apparatus of claim 1 or claim 2, wherein the substrate is formed from thermoplastic polyurethane and the conformal coating is formed from urethane.
4. The apparatus of any one of claims 1 to 3, wherein the substrate includes a plurality of perforations configured to allow fluid to pass through the substrate when negative pressure is applied to the wound.



5. The apparatus of claim 4, wherein the plurality of perforations are further configured to allow substantially unidirectional flow of fluid through the substrate to prevent fluid removed from the wound from flowing back toward the wound.
6. The apparatus of any one of claims 1 to 5, wherein the wound facing side of the substrate a region of adhesive material configured to position the at least one electronic component in the wound.
7. The apparatus of any one of claims 1 to 6, wherein the at least one electronic component comprises one or more of a sensor, a light emitter, a processor, or a communications controller.
8. The apparatus of any one of claims 1 to 7, wherein plurality of electronic connections comprise a plurality of electrical traces.
9. The apparatus of any one of claims 1 to 8, further comprising a negative pressure source configured to be fluidically connected to the wound dressing.
10. The apparatus of any one of claims 1 to 9, wherein the wound dressing further comprises an absorbent layer positioned over the non-wound facing side of the substrate and a backing layer positioned over the absorbent layer.
11. The apparatus of claim 10, wherein the substrate is sealed to the backing layer.
12. The apparatus of claim 11, further comprising a port on the backing layer, the port configured to fluidically connect the wound dressing to a negative pressure source.
13. The apparatus of claim 12, wherein the adhesive material is thermally curable.
14. The apparatus of any one of claims 1 to 13, wherein the conformal coating encapsulates the substrate.

15. The apparatus of any one of claims 1 to 14, wherein the first region of substantially non-stretchable material forms a shape substantially without gaps or overlapping portions.

16. The apparatus of any one of claims 1 to 15, wherein the wound facing side of the substrate supports at least one electronic connector connecting the at least one electronic component to at least one of the electronic connections, wherein the first region of substantially non-stretchable material encloses the at least one electronic connector at the perimeter of the at least one electronic component to protect the at least one electronic connector from strain.

17. The apparatus of any one of claims 1 to 16, wherein the first region of substantially non-stretchable material does not enclose the at least one electronic connection.

18. The apparatus of any one of claims 1 to 17, wherein the at least one electronic connection is stretchable outside the first region.

19. A method of manufacturing a wound dressing, the method comprising:  
providing a substantially stretchable substrate including a wound facing side and a non-wound facing side opposite the wound facing side;

positioning a plurality of electronic components and a plurality of electronic connections on the wound facing side or the non-wound facing side of the substrate;

covering at least the plurality of electronic components and the plurality of electronic connections with a conformal coating, to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections; and

enclosing an entire perimeter of at least one electronic component from the plurality of electronic components by a first region that is substantially non-stretchable material positioned on a portion of the wound facing side of the substrate supporting the plurality of electronic components and the plurality of electronic connections, wherein the first region is protected from strain applied to the substrate.

20. The method of claim 19, wherein the method further comprises:  
    perforating the substrate around the plurality of electronic components and the plurality of electronic connections; and  
    applying the conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections.
21. The method of claim 20, further comprising identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections.
22. The method of claim 21, wherein identifying the plurality of locations comprises identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate.
23. The method of any one of claims 20 to 22, further comprising applying a region of adhesive material to the wound facing side of the substrate, the adhesive material configured to position the at least one electronic component in the wound.
24. The method of claim 23, further identifying a location of the at least one electronic component prior to applying the region of adhesive material.
25. The method of claim 19, wherein the method further comprises:  
    applying the conformal coating over at least the plurality of electronic components and the plurality of electronic connections, the conformal coating configured to prevent fluid from coming into contact with the plurality of electronic components and the plurality of electronic connections.
26. The method of claim 25, further comprising:

applying a region of adhesive material to the wound facing side of the substrate, the adhesive material configured to position the at least one electronic component in the wound; and

perforating the substrate around the plurality of electronic components and the plurality of electronic connections.

27. The method of claim 26, further comprising identifying a plurality of locations of the plurality of electronic components and the plurality of electronic connections on the substrate prior to perforating the substrate around the plurality of electronic components and the plurality of electronic connections.

28. The method of claim 27, further identifying a location of the at least one electronic component prior to applying the region of adhesive material.

29. The method of claim 27 or claim 28, wherein identifying the plurality of locations comprises identifying one or more of: a location of an RFID chip or antenna positioned on the substrate or a location of an electronic connection configured to be connected to an electronic component external to the substrate.

30. The method of any one of claims 19 to 29, further comprising:  
positioning a second region of substantially non-stretchable material on the wound facing side or the non-wound facing side of the substrate; and  
supporting at least one electronic connection from the plurality of electronic connections on the second region.

31. The method of any one of claims 19 to 29, further comprising:  
cutting the substrate along at least one cutting line to separate a region of the substrate including the plurality of electronic components and the plurality of electronic connections; and  
attaching the region of the substrate to one or more of an absorbent layer or a backing layer to form a wound dressing.

32. The method of any one of claims 19 to 31, wherein the substrate is formed from thermoplastic polyurethane and the conformal coating is formed from urethane.
33. The method of any one of claims 23 to 24 or 26 to 29, further comprising thermally curing the adhesive material.
34. The method of claim 33, further comprising thermally curing the adhesive material during soldering of the at least one electronic component to at least one electronic connection of the one or more electronic connections.
35. The method of any one of claims 19 to 34, wherein the plurality of electronic components and the plurality of electronic connections are positioned at least on the wound facing side of the substrate.
36. The method of any one of claims 19 to 34, wherein the plurality of electronic components and the plurality of electronic connections are positioned at least on the non-wound facing side of the substrate.
37. The method of any one of claims 20 to 22 or 25 to 29, wherein the conformal coating encapsulates the substrate.
38. The apparatus of any one of claims 19 to 37, wherein the first region of substantially non-stretchable material forms a shape substantially without gaps or overlapping portions.

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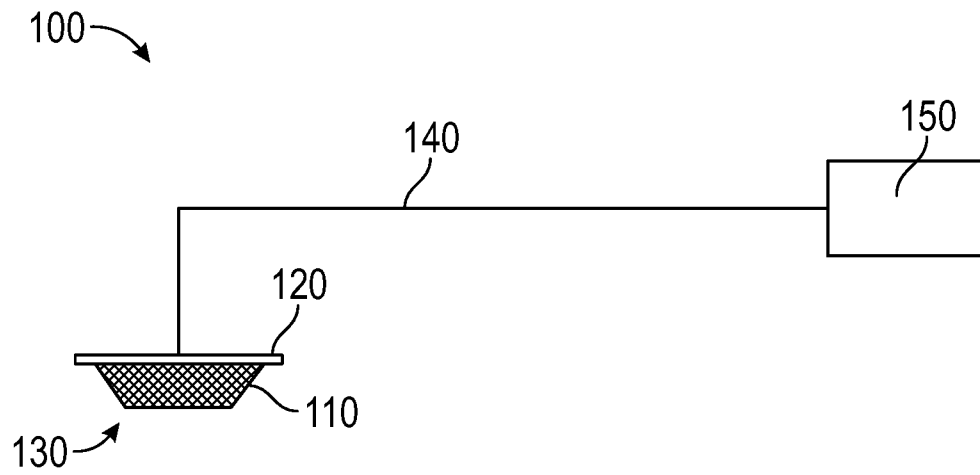


FIG. 1A

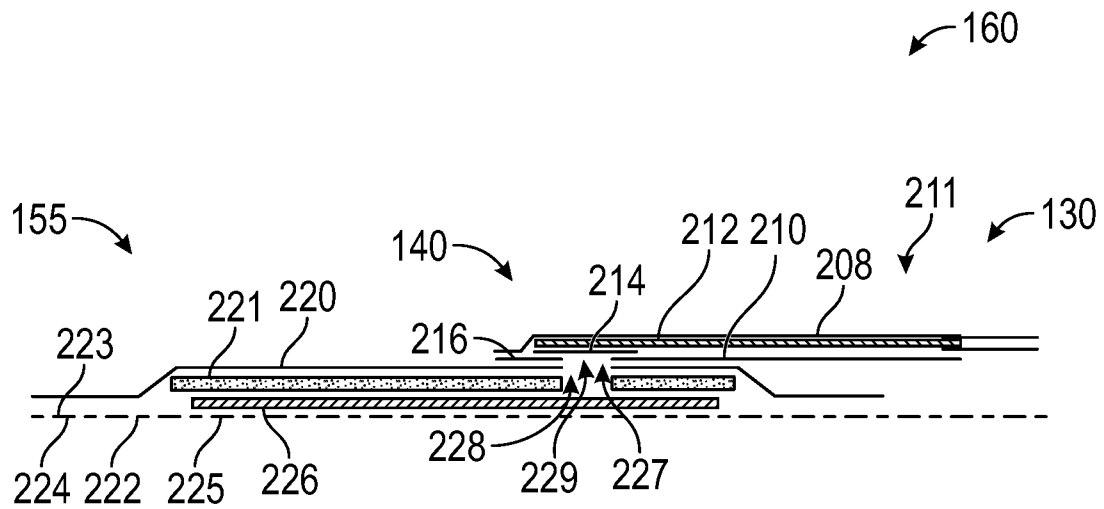


FIG. 1B

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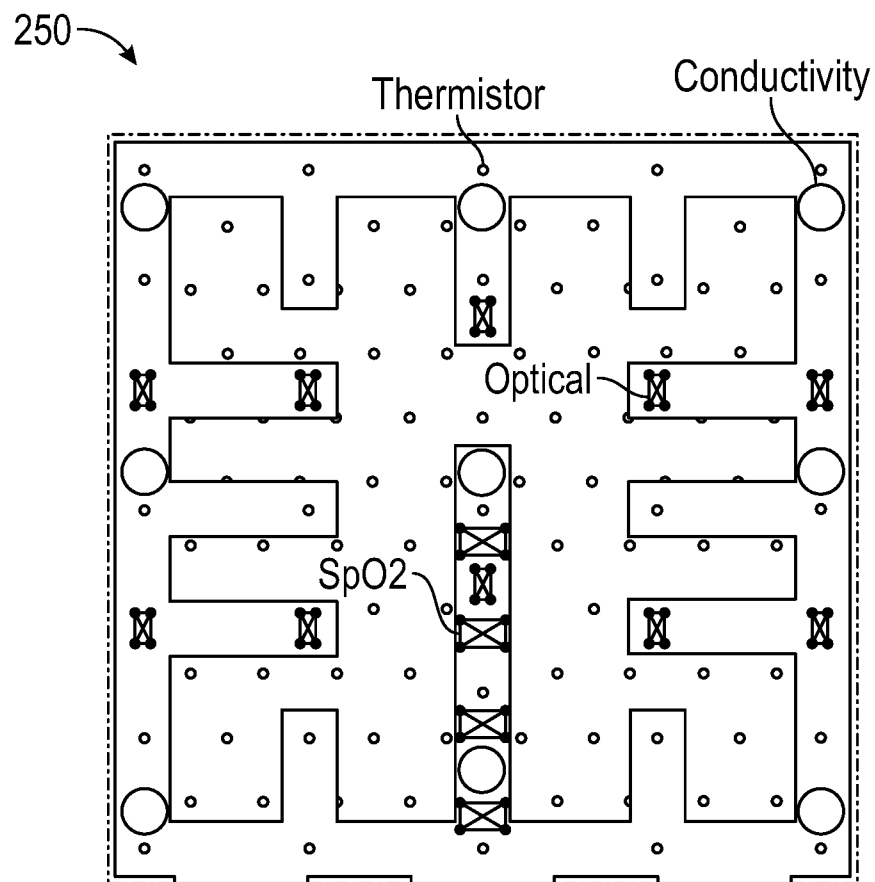


FIG. 2

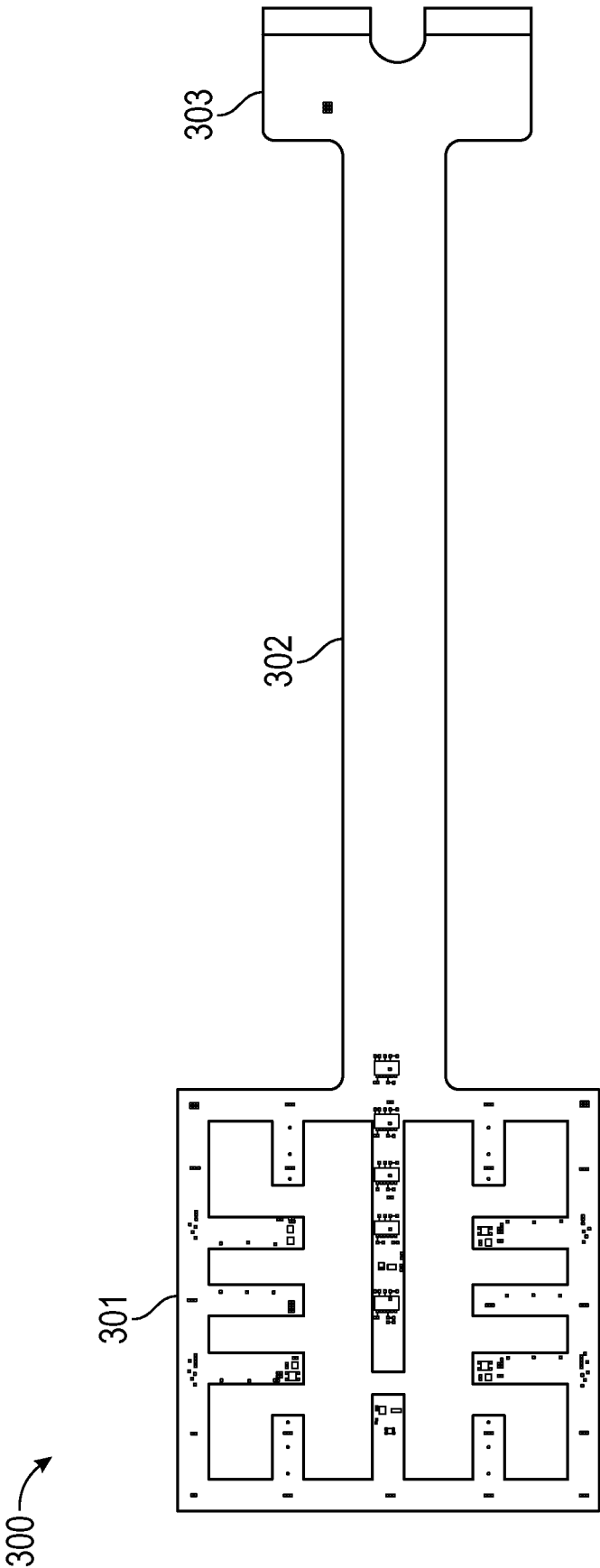


FIG. 3A



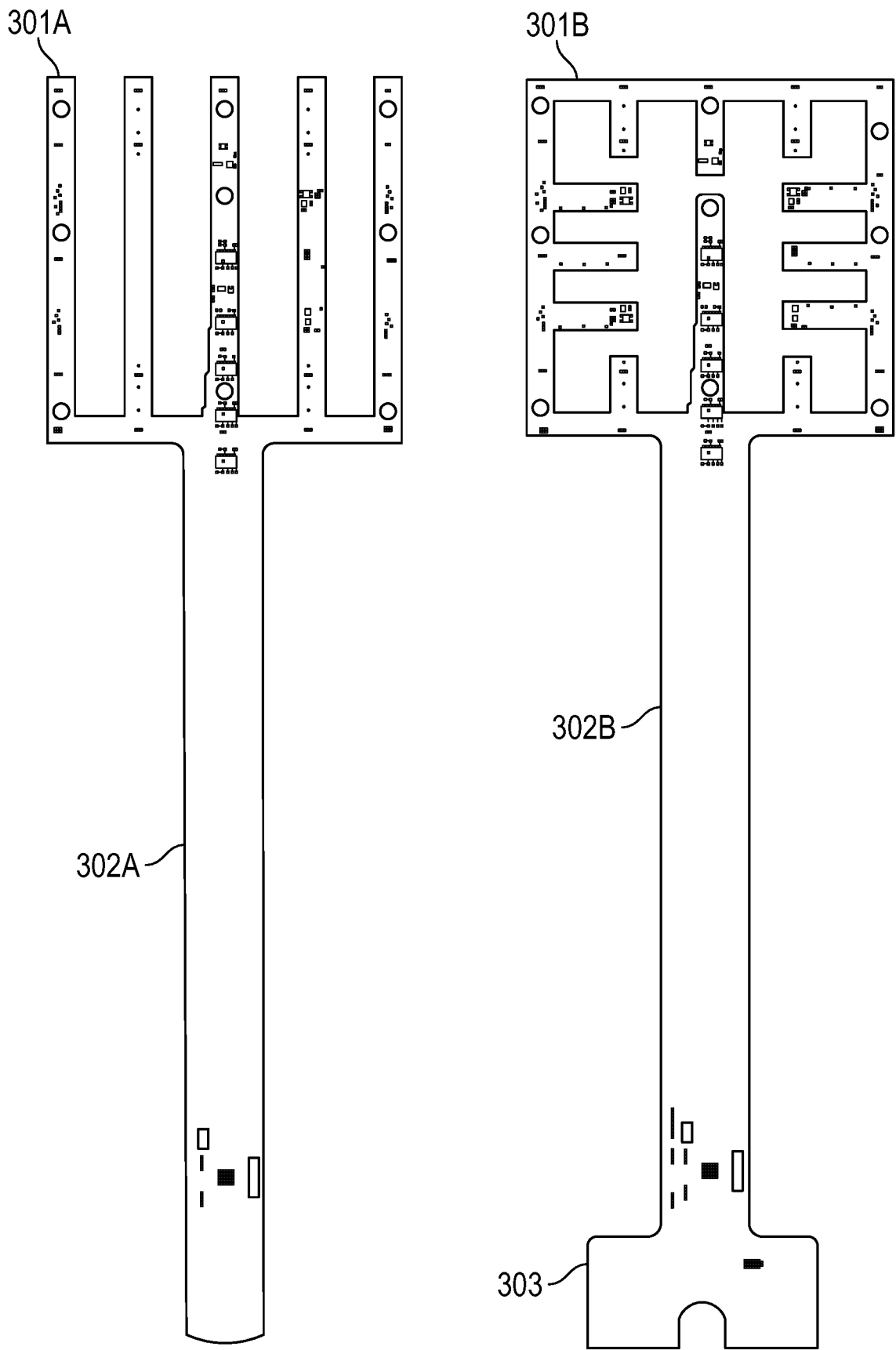


FIG. 3B

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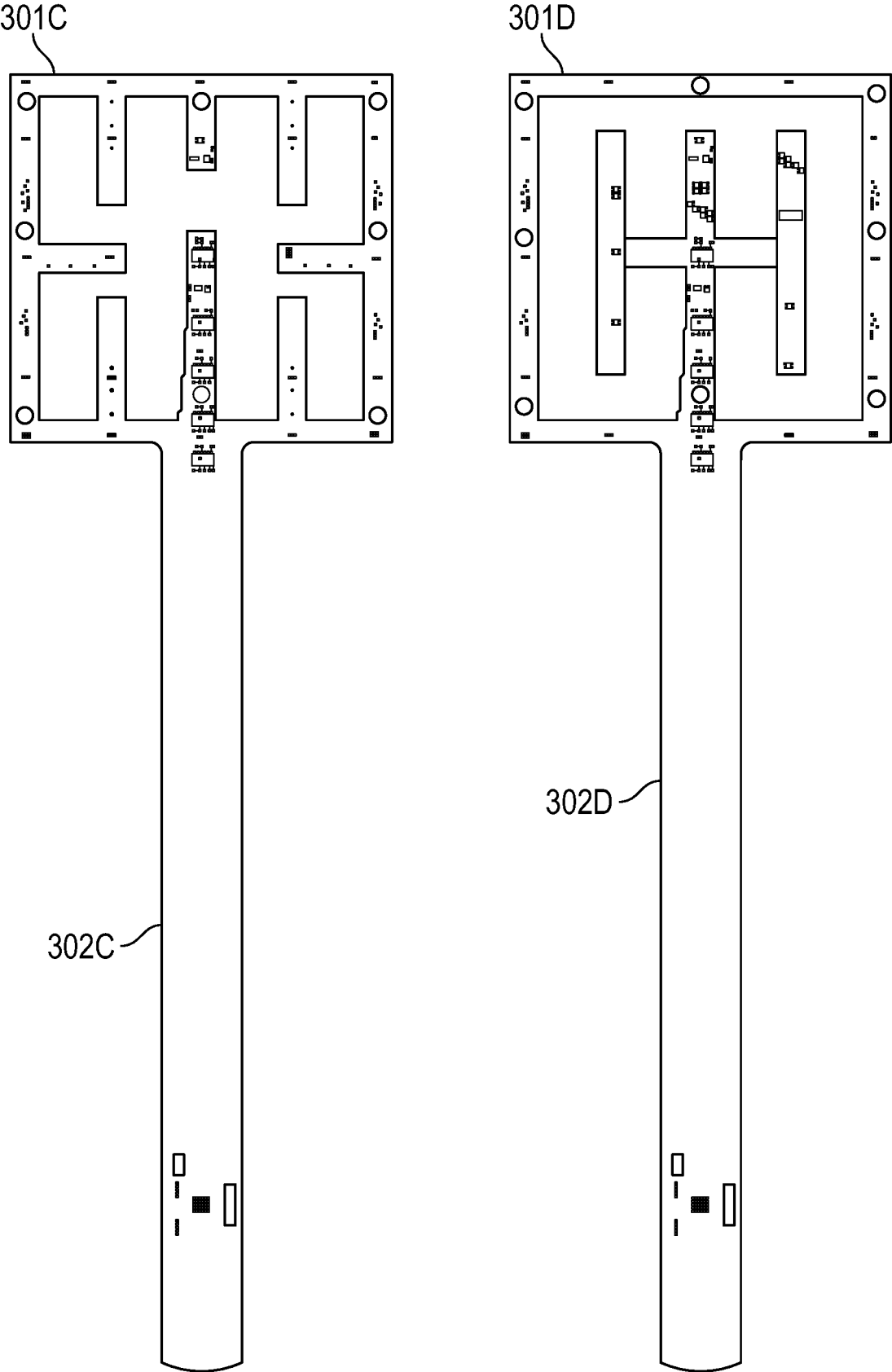


FIG. 3B  
(Continued)

301B

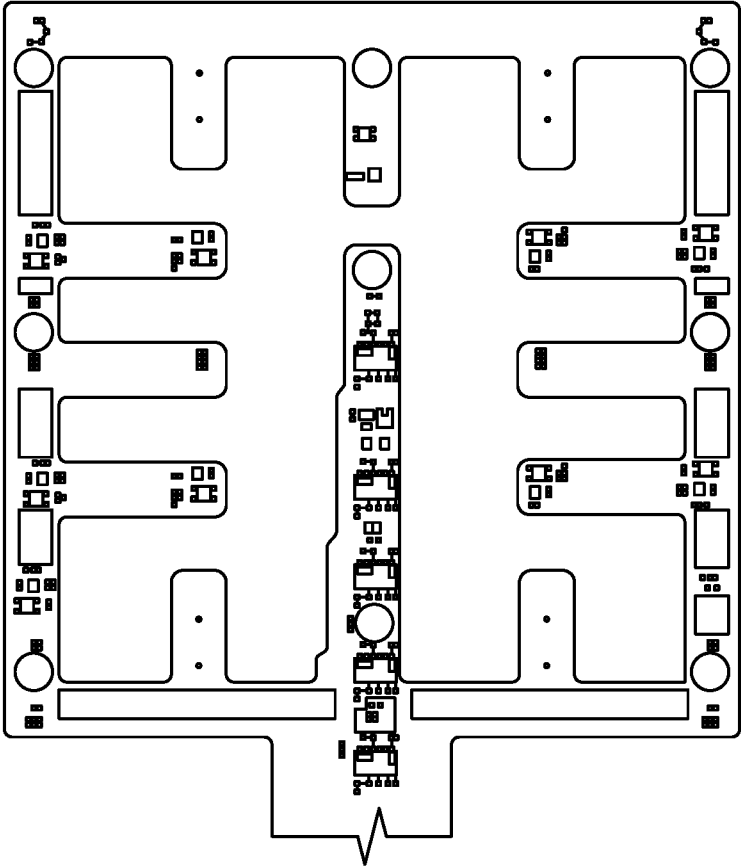


FIG. 3C

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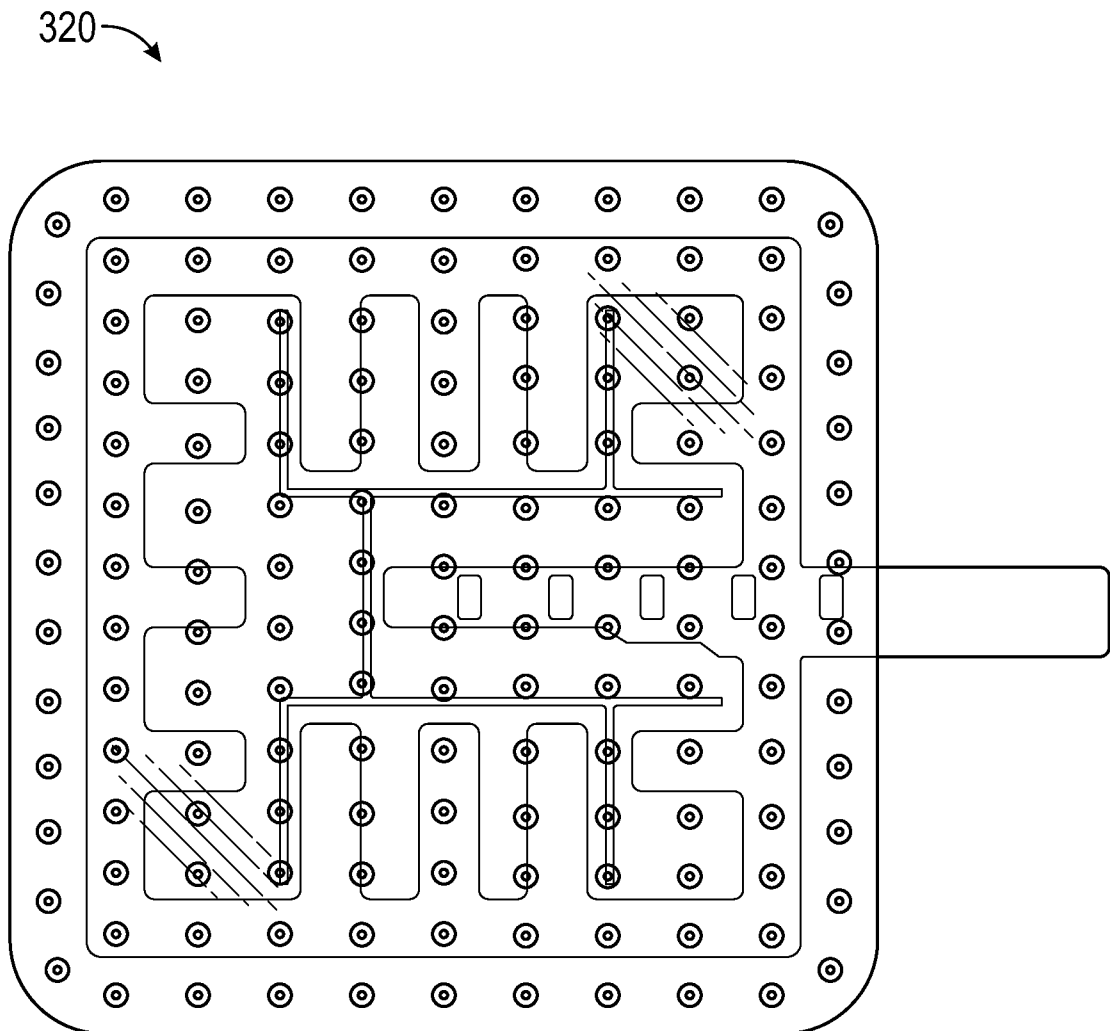


FIG. 3D

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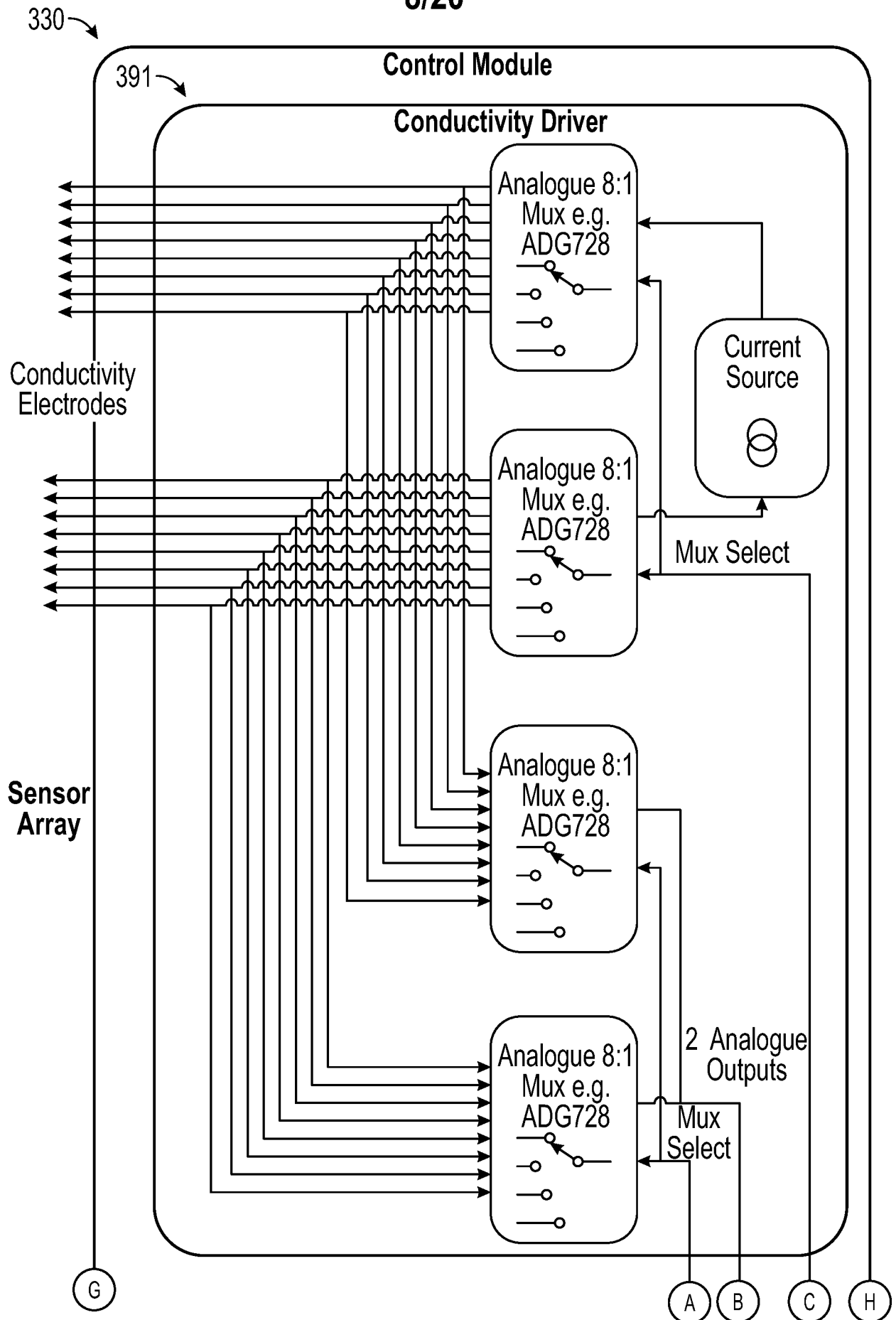
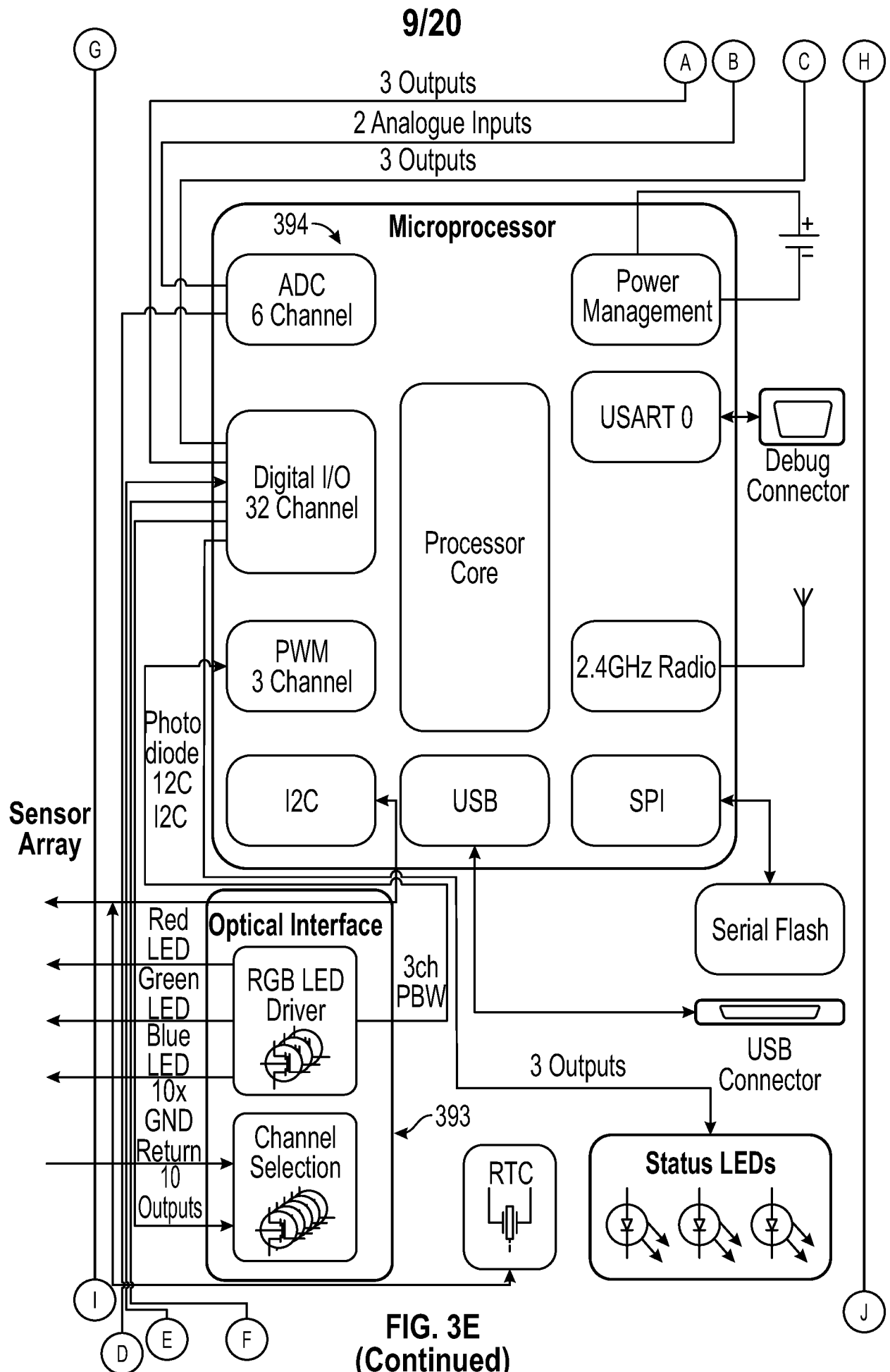
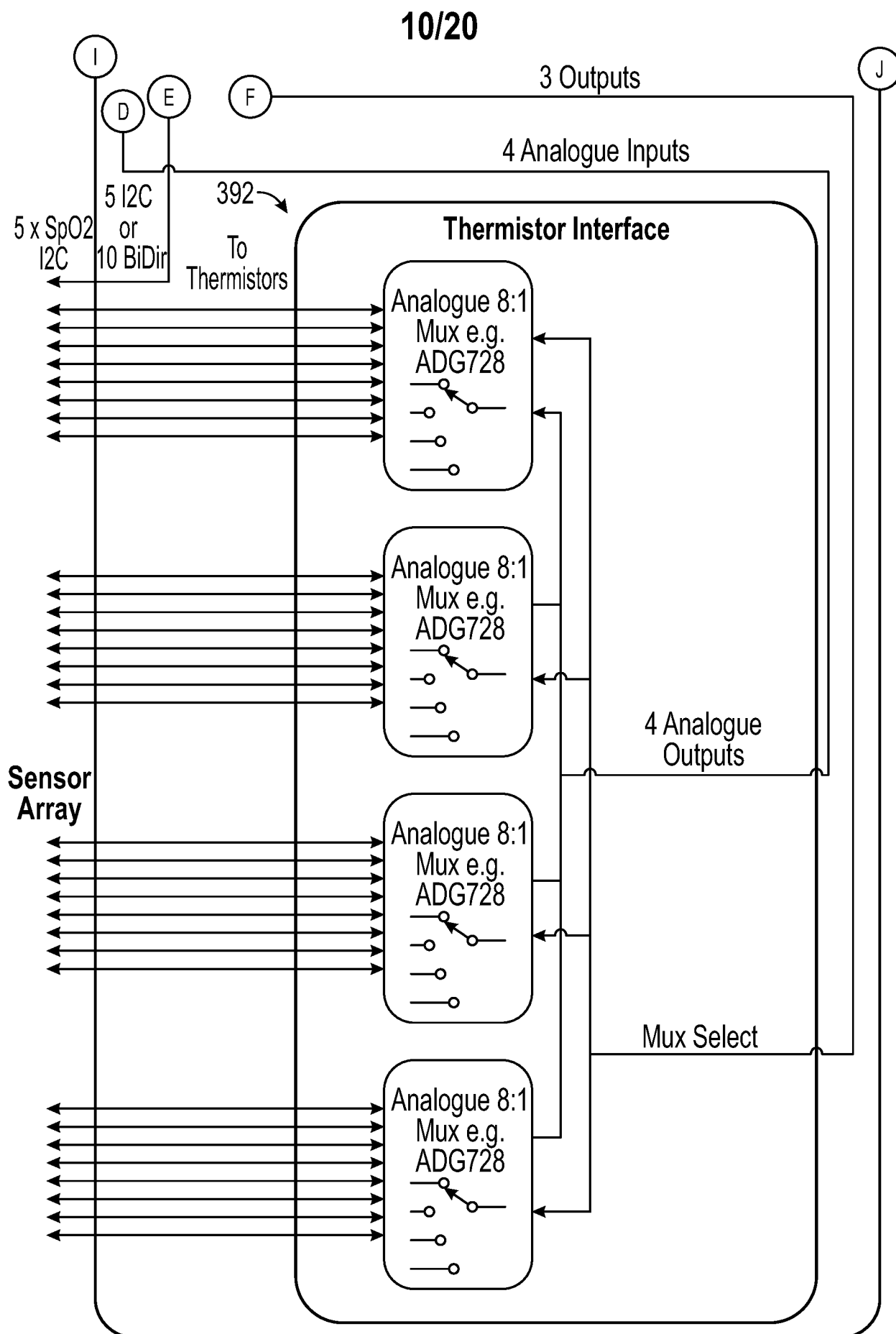


FIG. 3E





**FIG. 3E**  
**(Continued)**

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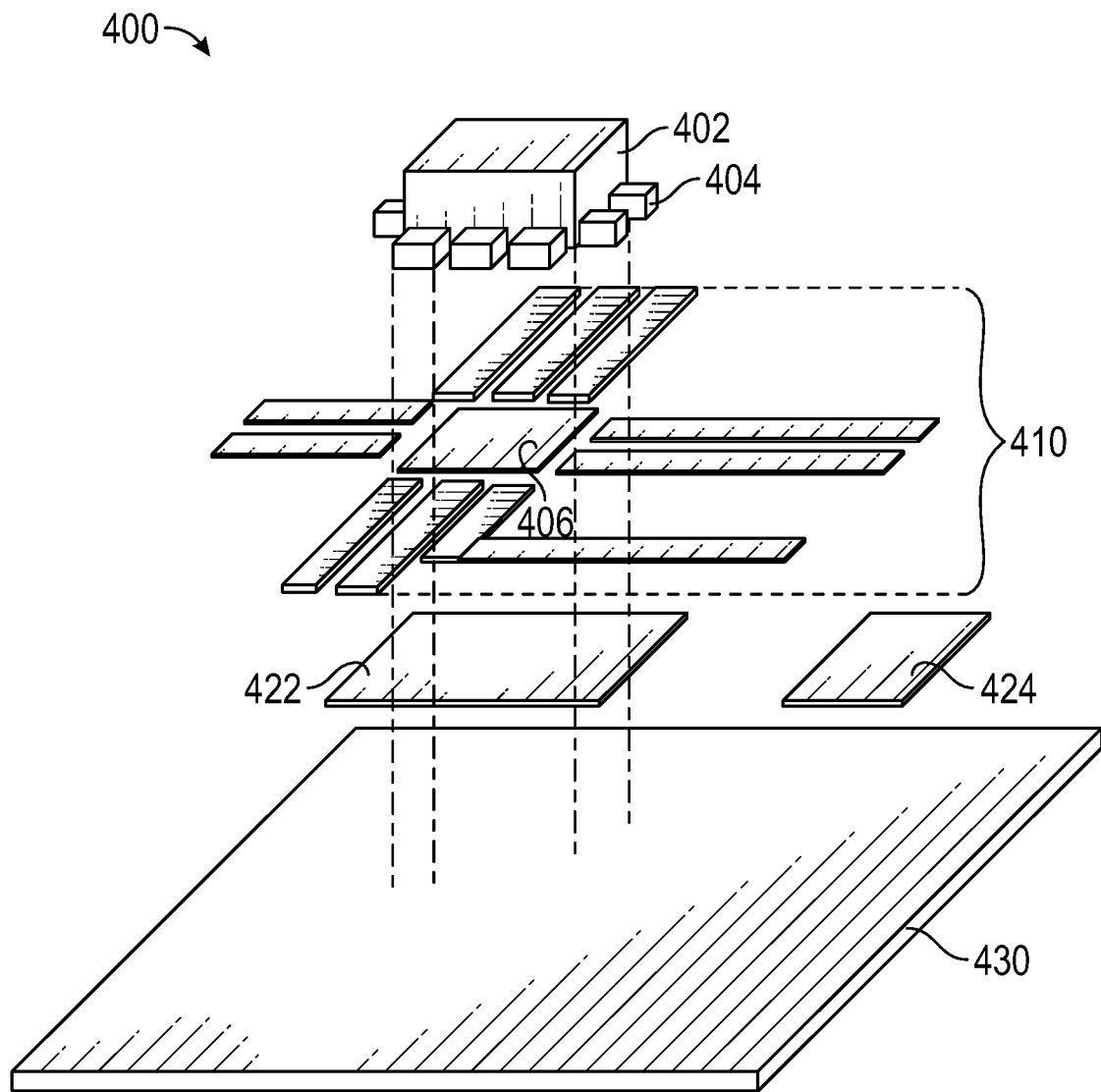


FIG. 4A

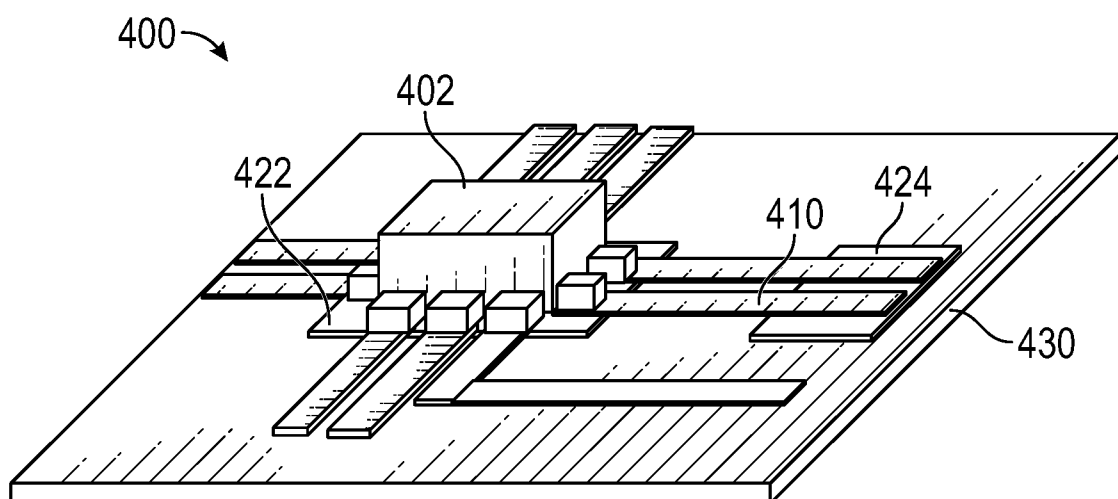
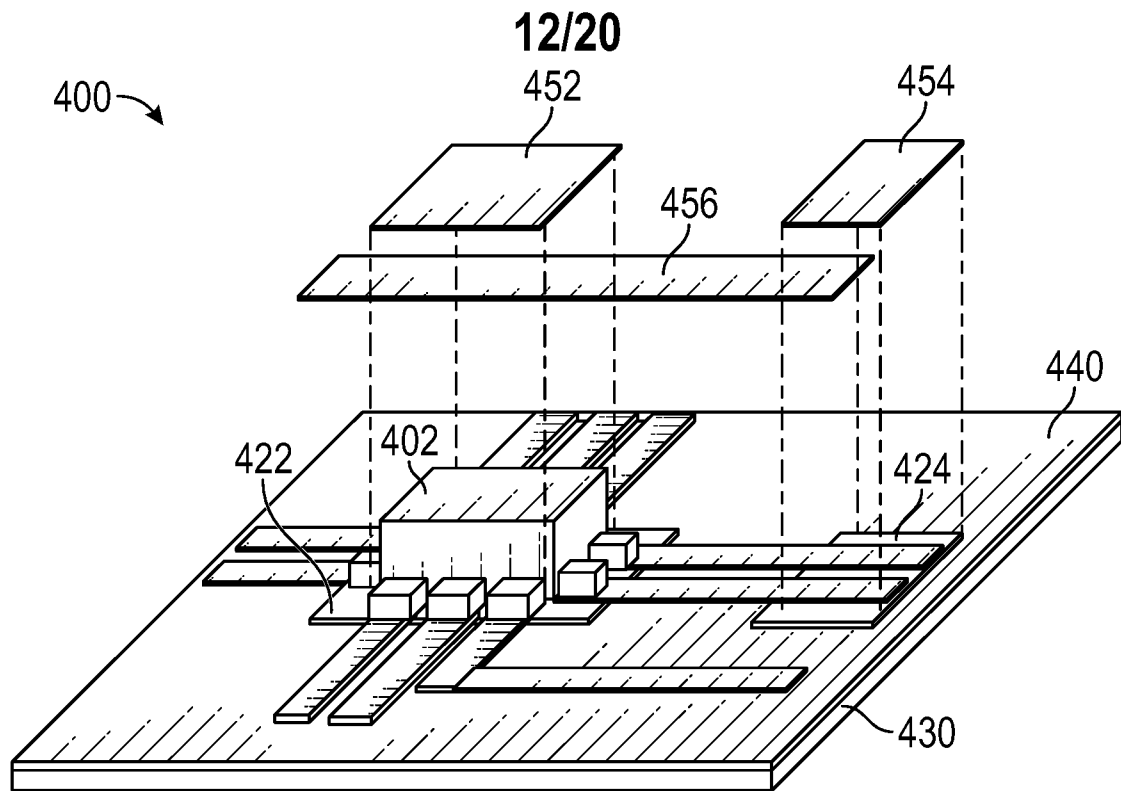
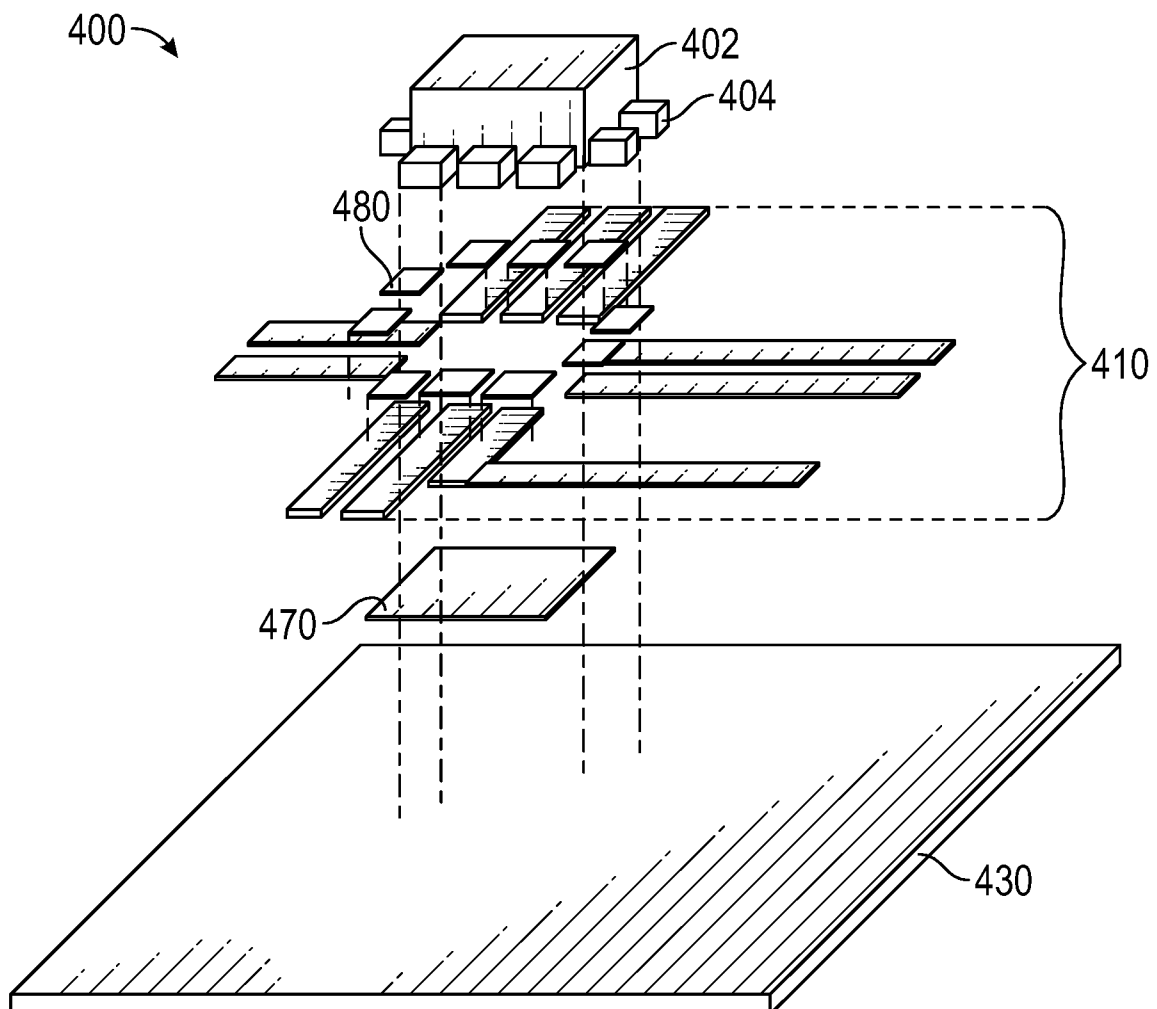


FIG. 4B





**FIG. 4C**



**FIG. 4D**

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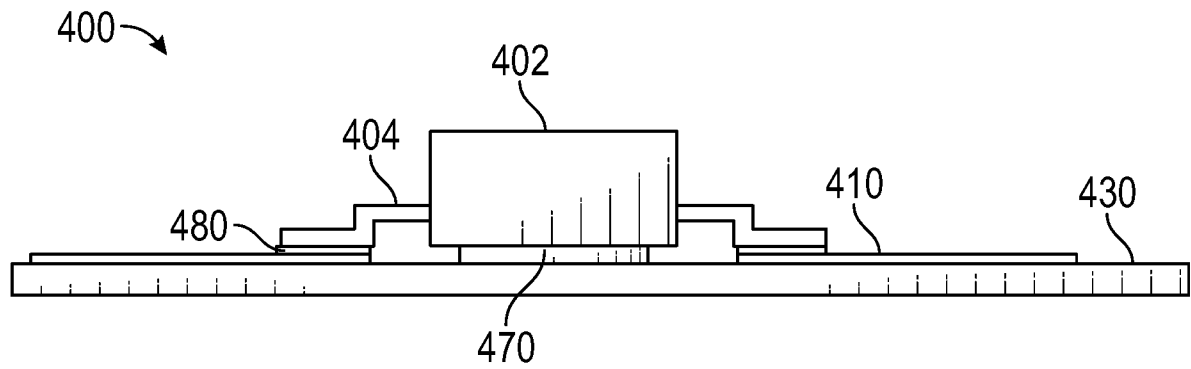


FIG. 4E

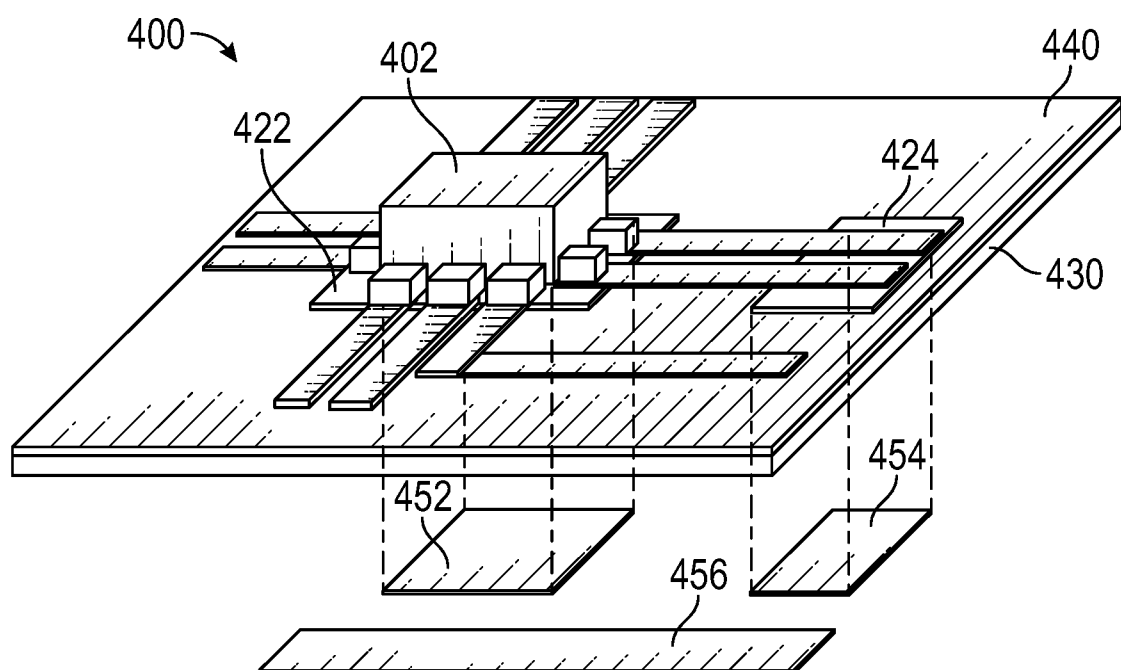


FIG. 4F

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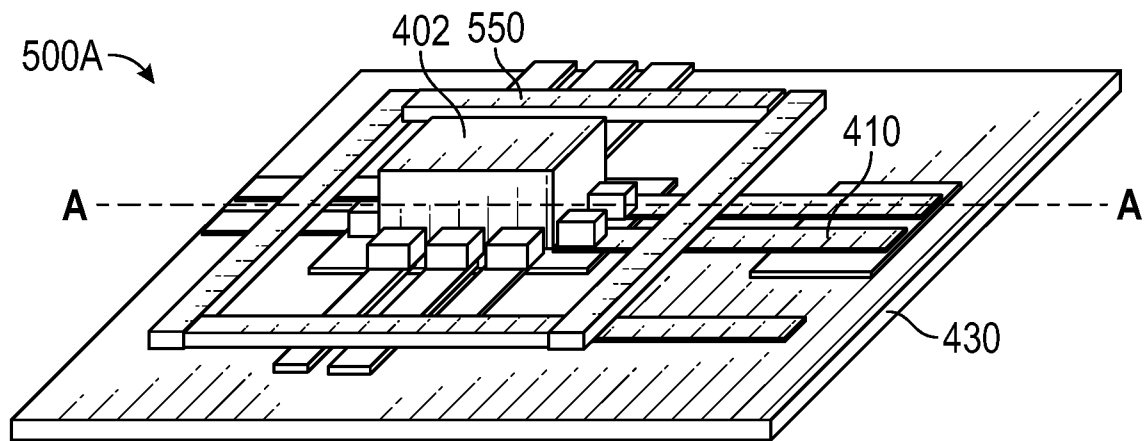


FIG. 5A

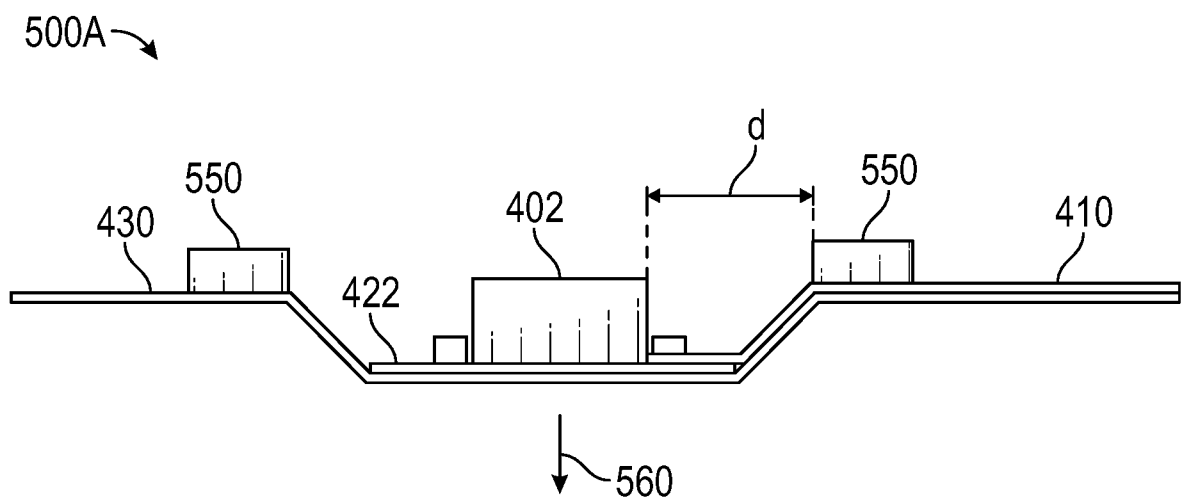


FIG. 5B

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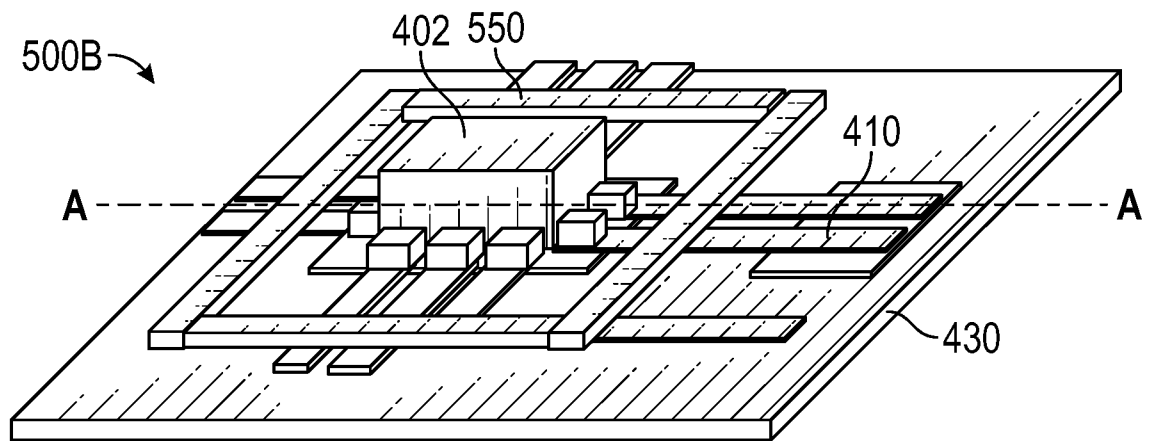


FIG. 5C

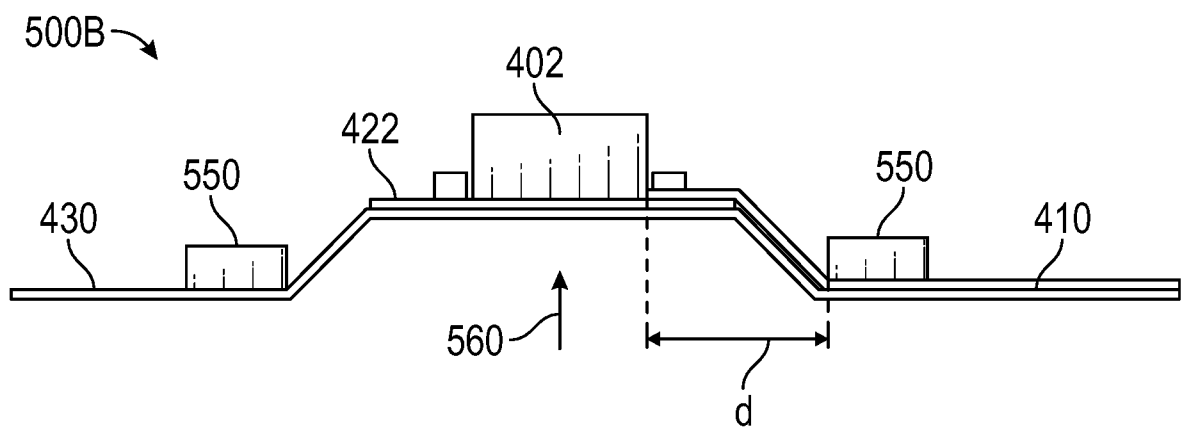


FIG. 5D

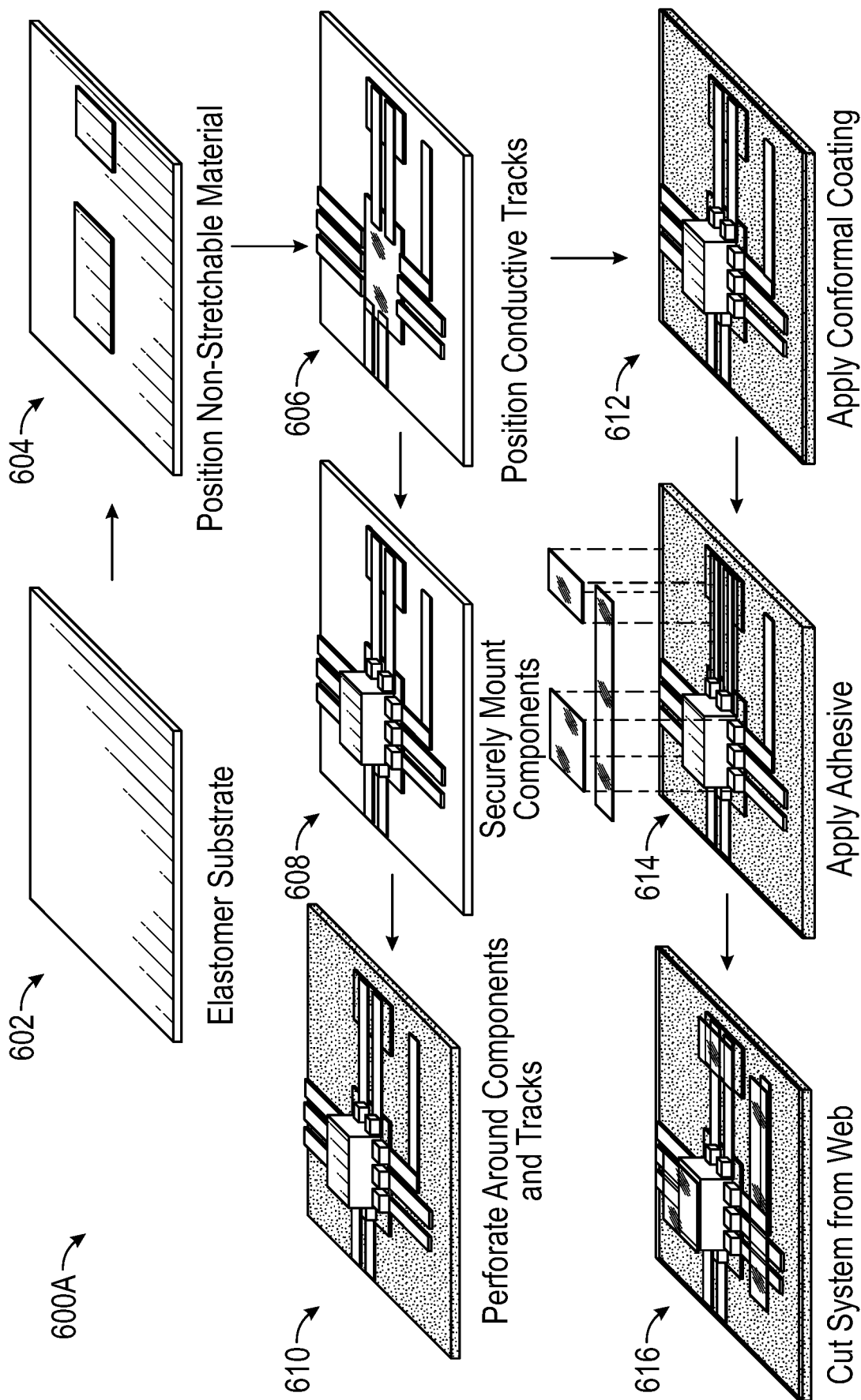


FIG. 6A

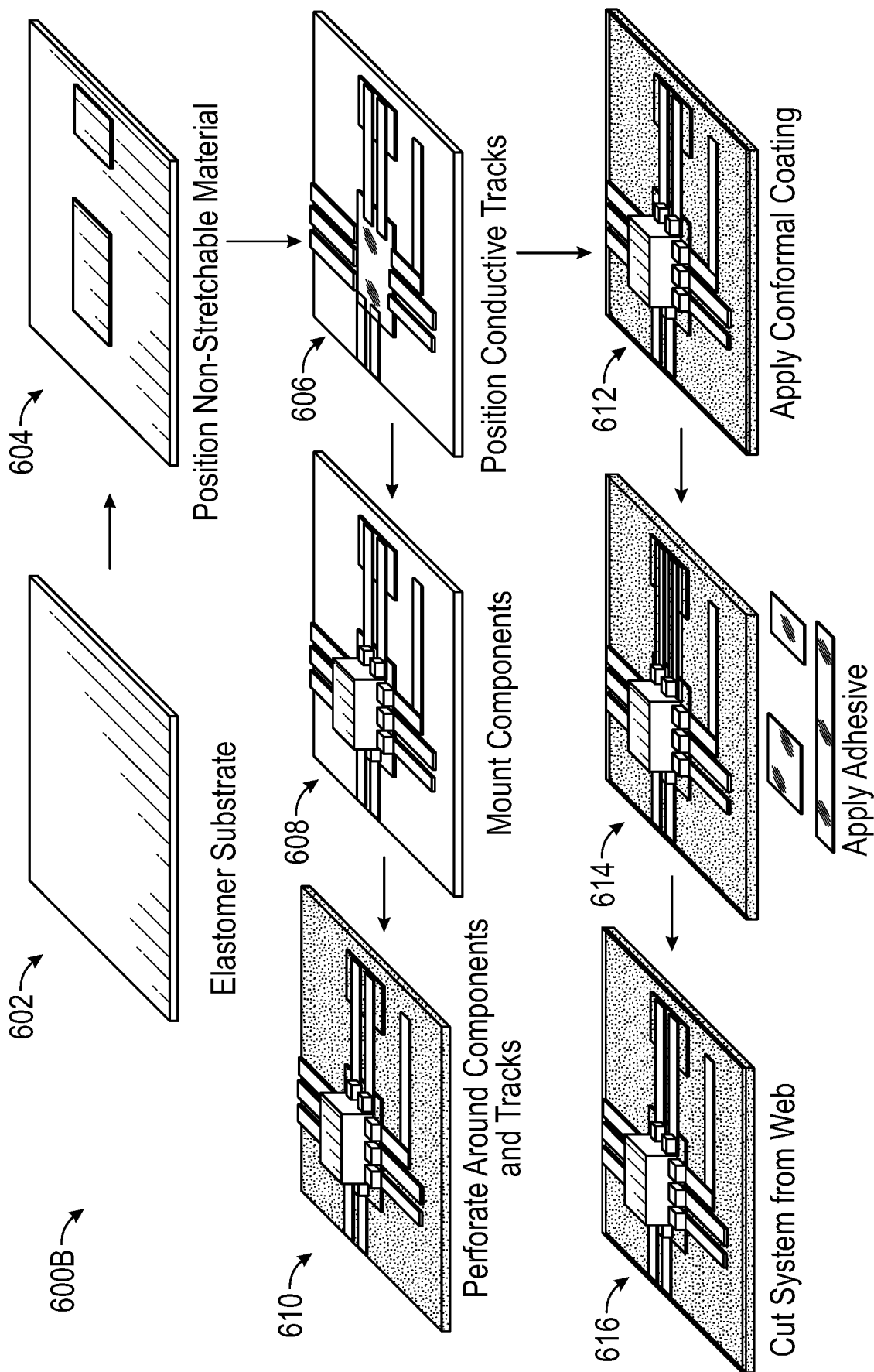


FIG. 6B

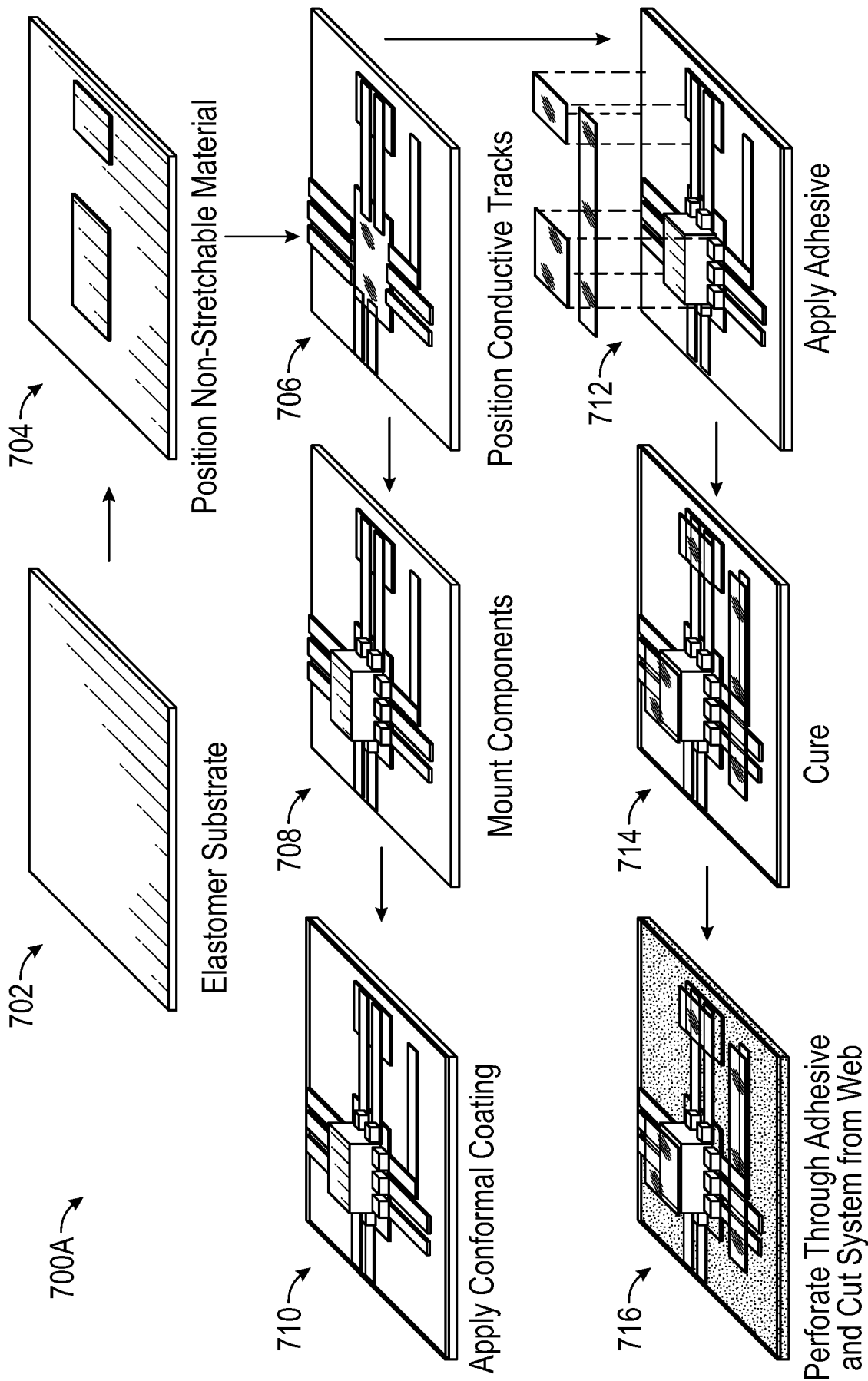


FIG. 7A

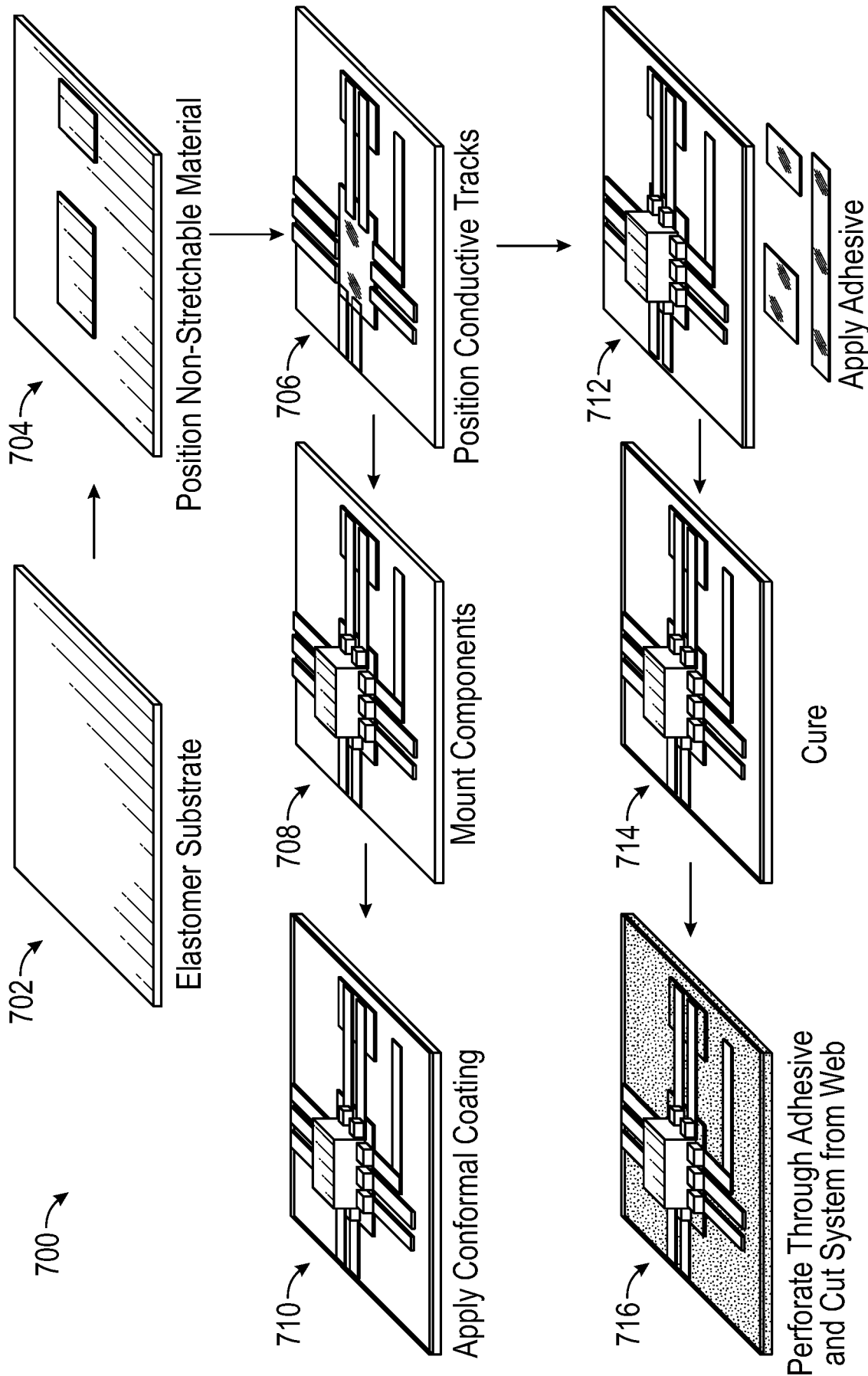


FIG. 7B



